



Specification for D-PHY

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Release History

Date	Version	Description
2014-09-14	V1.2	Board Approved Release.

1 Introduction

1 This specification provides a flexible, low-cost, High-Speed serial interface solution for communication
2 interconnection between components inside a mobile device. Traditionally, these interfaces are CMOS
3 parallel busses at low bit rates with slow edges for EMI reasons. The D-PHY solution enables significant
4 extension of the interface bandwidth for more advanced applications. The D-PHY solution can be realized
5 with very low power consumption.

1.1 Scope

6 The scope of this document is to specify the lowest layers of High-Speed source-synchronous interfaces to
7 be applied by MIPI Alliance application or protocol level specifications. This includes the physical
8 interface, electrical interface, low-level timing and the PHY-level protocol. These functional areas taken
9 together are known as D-PHY.

10 The D-PHY specification shall always be used in combination with a higher layer MIPI specification that
11 references this specification. Initially, this specification will be used for the connection of a host processor
12 to display and camera modules as used in mobile devices. However, this specification can also be
13 referenced by other upcoming MIPI Alliance specifications.

14 The following topics are outside the scope of this document:

- 15 • **Explicit specification of signals of the clock generator unit.** Of course, the D-PHY specification
16 does implicitly require some minimum performance from the clock signals. Intentionally, only the
17 behavior on the interface pins is constrained. Therefore, the clock generation unit is excluded from
18 this specification, and will be a separate functional unit that provides the required clock signals to
19 the D-PHY in order to meet the specification. This allows all kinds of implementation trade-offs as
20 long as these do not violate this specification. More information can be found in Section 5.
- 21 • **Test modes, patterns, and configurations.** Obviously testability is very important, but because
22 the items to test are mostly application specific or implementation related, the specification of tests
23 is deferred to either the higher layer specifications or the product specification. Furthermore MIPI
24 D-PHY compliance testing is not included in this specification.
- 25 • **Procedure to resolve contention situations.** The D-PHY contains several mechanisms to detect
26 Link contention. However, certain contention situations can only be detected at higher levels and
27 are therefore not included in this specification.
- 28 • **Ensure proper operation of a connection between different Lane Module types.** There are
29 several different Lane Module types to optimally support the different functional requirements of
30 several applications. This means that next to some base-functionality there are optional features
31 which can be included or excluded. This specification only ensures correct operation for a
32 connection between matched Lane Modules types, which means: Modules that support the same
33 features and have complementary functionality. In case the two sides of the Lane are not the same
34 type, and these are supposed to work correctly, it shall be ensured by the manufacturer(s) of the
35 Lane Module(s) that the provided additional functionality does not corrupt operation. This can be
36 easiest accomplished if the additional functionality can be disabled by other means independent of
37 the MIPI D-PHY interface, such that the Lane Modules behave as if they were the same type.
- 38 • **ESD protection level of the IO.** The required level will depend on a particular application
39 environment and product type.
- 40 • **Exact Bit-Error-Rate (BER) value.** The actual value of the achieved BER depends on the total
41 system integration and the hostility of the environment. Therefore, it is impossible to specify a
42 BER for individual parts of the Link. This specification allows for implementations with a
43 $BER < 10^{-12}$.
- 44 • **Specification of the PHY-Protocol Interface.** The D-PHY specification includes a PHY-Protocol
45 Interface (PPI) annex that provides one possible solution for this interface. This annex is limited to
46 the essential signals for normal operation in order to clarify the kind of signals needed at this

47 interface. For power reasons this interface will be internal for most applications. Practical
48 implementations may be different without being inconsistent with the D-PHY specification.

49 • **Implementations.** This specification is intended to restrict the implementation as little as possible.
50 Various sections of this specification use block diagrams or example circuits to illustrate the
51 concept and are not in any way claimed to be the preferred or required implementation. Only the
52 behavior on the D-PHY interface pins is normative.

53 Regulatory compliance methods are not within the scope of this document. It is the responsibility of
54 product manufacturers to ensure that their designs comply with all applicable regulatory requirements.

1.2 Purpose

55 The D-PHY specification is used by manufacturers to design products that adhere to MIPI Alliance
56 interface specifications for mobile device such as, but not limited to, camera, display and unified protocol
57 interfaces.

58 Implementing this specification reduces the time-to-market and design cost of mobile devices by
59 standardizing the interface between products from different manufacturers. In addition, richer feature sets
60 requiring high bit rates can be realized by implementing this specification. Finally, adding new features to
61 mobile devices is simplified due to the extensible nature of the MIPI Alliance Specifications.

2 Terminology

2.1 Use of Special Terms

62 The MIPI Alliance has adopted Section 13.1 of the *IEEE Standards Style Manual*, which dictates use of the
63 words “shall”, “should”, “may”, and “can” in the development of documentation, as follows:

64 The word *shall* is used to indicate mandatory requirements strictly to be followed in order
65 to conform to the Specification and from which no deviation is permitted (*shall equals is*
66 *required to*).

67 The use of the word *must* is deprecated and shall not be used when stating mandatory
68 requirements; *must* is used only to describe unavoidable situations.

69 The use of the word *will* is deprecated and shall not be used when stating mandatory
70 requirements; *will* is only used in statements of fact.

71 The word *should* is used to indicate that among several possibilities one is recommended
72 as particularly suitable, without mentioning or excluding others; or that a certain course
73 of action is preferred but not necessarily required; or that (in the negative form) a certain
74 course of action is deprecated but not prohibited (*should equals is recommended that*).

75 The word *may* is used to indicate a course of action permissible within the limits of the
76 Specification (*may equals is permitted to*).

77 The word *can* is used for statements of possibility and capability, whether material,
78 physical, or causal (*can equals is able to*).

79 All sections are normative, unless they are explicitly indicated to be informative.

2.2 Definitions

80 **Bi-directional:** A single Data Lane that supports communication in both the Forward and Reverse
81 directions.

82 **DDR Clock:** Half rate clock used for dual-edged data transmission.

83 **D-PHY:** The source synchronous PHY defined in this document. D-PHYs communicate on the order of
84 500 Mbit/s hence the Roman numeral for 500 or “D.”

85 **Escape Mode:** An optional mode of operation for Data Lanes that allows low bit-rate commands and data
86 to be transferred at very low power.

87 **Forward Direction:** The signal direction is defined relative to the direction of the High-Speed DDR clock.
88 Transmission from the side sending the clock to the side receiving the clock is the Forward direction.

89 **Lane:** Consists of two complementary Lane Modules communicating via two-line, point-to-point Lane
90 Interconnects. Sometimes Lane is also used to denote interconnect only. A Lane can be used for either Data
91 or Clock signal transmission.

92 **Lane Interconnect:** Two-line, point-to-point interconnect used for both differential High-Speed signaling
93 and Low-Power, single-ended signaling.

94 **Lane Module:** Module at each side of the Lane for driving and/or receiving signals on the Lane.

95 **Line:** An interconnect wire used to connect a driver to a receiver. Two Lines are required to create a Lane
96 Interconnect.

97 **Link:** A connection between two devices containing one Clock Lane and at least one Data Lane. A Link
98 consists of at least two PHYs and two Lane Interconnects.

99 **Master:** The Master side of a Link is defined as the side that transmits the High-Speed Clock. The Master
100 side transmits data in the Forward direction.

101 **PHY:** A functional block that implements the features necessary to communicate over the Lane
 102 Interconnect. A PHY consists of one Lane Module configured as a Clock Lane, one or more Lane Modules
 103 configured as Data Lanes and a PHY Adapter Layer.

104 **PHY Adapter:** A protocol layer that converts symbols from an APPI to the signals used by a specific PHY
 105 PPI.

106 **PHY Configuration:** A set of Lanes that represent a possible Link. A PHY configuration consists of a
 107 minimum of two Lanes, one Clock Lane and one or more Data Lanes.

108 **Reverse Direction:** Reverse direction is the opposite of the forward direction. See the description for
 109 Forward Direction.

110 **Slave:** The Slave side of a Link is defined as the side that does not transmit the High-Speed Clock. The
 111 Slave side may transmit data in the Reverse direction.

112 **Turnaround:** Reversing the direction of communication on a Data Lane.

113 **Unidirectional:** A single Lane that supports communication in the Forward direction only.

2.3 Abbreviations

114 e.g. For example (Latin: *exempli gratia*)

115 i.e. That is (Latin: *id est*)

2.4 Acronyms

116 APPI Abstracted PHY-Protocol Interface

117 BER Bit Error Rate

118 CIL Control and Interface Logic

119 DDR Double Data Rate

120 EMI Electro Magnetic Interference

121 EoT End of Transmission

122 HS High-Speed; identifier for operation mode

123 HS-RX High-Speed Receiver (Low-Swing Differential)

124 HS-TX High-Speed Transmitter (Low-Swing Differential)

125 IO Input-Output

126 ISTO Industry Standards and Technology Organization

127 LP Low-Power: identifier for operation mode

128 LP-CD Low-Power Contention Detector

129 LPDT Low-Power Data Transmission

130 LP-RX Low-Power Receiver (Large-Swing Single-Ended)

131 LP-TX Low-Power Transmitter (Large-Swing Single-Ended)

132 LPS Low-Power State(s)

133 LSB Least Significant Bit

134 Mbps Megabits per second

135 MSB Most Significant Bit

136	PHY	Physical Layer
137	PLL	Phase-Locked Loop
138	PPI	PHY-Protocol Interface
139	RF	Radio Frequency
140	RX	Receiver
141	SE	Single-Ended
142	SoT	Start of Transmission
143	TLIS	Transmission-Line Interconnect Structure: physical interconnect realization between Master
144		and Slave
145	TX	Transmitter
146	UI	Unit Interval, equal to the duration of any HS state on the Clock Lane
147	ULPS	Ultra-Low Power State

3 References

148 This specification does not reference any other documents.

4 D-PHY Overview

149 D-PHY describes a source synchronous, high speed, low power, low cost PHY, especially suited for mobile
150 applications. This D-PHY specification has been written primarily for the connection of camera and display
151 applications to a host processor. Nevertheless, it can be applied to many other applications. It is envisioned
152 that the same type of PHY will also be used in a dual-simplex configuration for interconnections in a more
153 generic communication network. Operation and available data-rates for a Link are asymmetrical due to a
154 master-slave relationship between the two sides of the Link. The asymmetrical design significantly reduces
155 the complexity of the Link. Some features like bi-directional, half-duplex operation are optional. Exploiting
156 this feature is attractive for applications that have asymmetrical data traffic requirements and when the cost
157 of separate interconnects for a return channel is too high. While this feature is optional, it avoids mandatory
158 overhead costs for applications that do not have return traffic requirements or want to apply physically
159 distinct return communication channels.

4.1 Summary of PHY Functionality

160 The D-PHY provides a synchronous connection between Master and Slave. A practical PHY Configuration
161 consists of a clock signal and one or more data signals. The clock signal is unidirectional, originating at the
162 Master and terminating at the Slave. The data signals can either be unidirectional or bi-directional
163 depending on the selected options. For half-duplex operation, the reverse direction bandwidth is one-fourth
164 of the forward direction bandwidth. Token passing is used to control the communication direction of the
165 Link.

166 The Link includes a High-Speed signaling mode for fast-data traffic and a Low-Power signaling mode for
167 control purposes. Optionally, a Low-Power Escape mode can be used for low speed asynchronous data
168 communication. High speed data communication appears in bursts with an arbitrary number of payload
169 data bytes.

170 The PHY uses two wires per Data Lane plus two wires for the Clock Lane. This gives four wires for the
171 minimum PHY configuration. In High-Speed mode each Lane is terminated on both sides and driven by a
172 low-swing, differential signal. In Low-Power mode all wires are operated single-ended and non-terminated.
173 For EMI reasons, the drivers for this mode shall be slew-rate controlled and current limited.

174 The actual maximum achievable bit rate in High-Speed mode is determined by the performance of
175 transmitter, receiver and interconnect implementations. Therefore, the maximum bit rate is not specified in
176 this document. However, this specification is primarily intended to define a solution for a bit rate range of
177 80 to 1500 Mbps per Lane without deskew calibration and up to 2500 Mbps with deskew calibration. When
178 the DUT supports a data rate greater than 1500 Mbps, it shall also support deskew capability. Although
179 PHY Configurations are not limited to this range, practical constraints make it the most suitable range for
180 the intended applications. For a fixed clock frequency, the available data capacity of a PHY Configuration
181 can be increased by using more Data Lanes. Effective data throughput can be reduced by employing burst
182 mode communication. The maximum data rate in Low-Power mode is 10 Mbps.

4.2 Mandatory Functionality

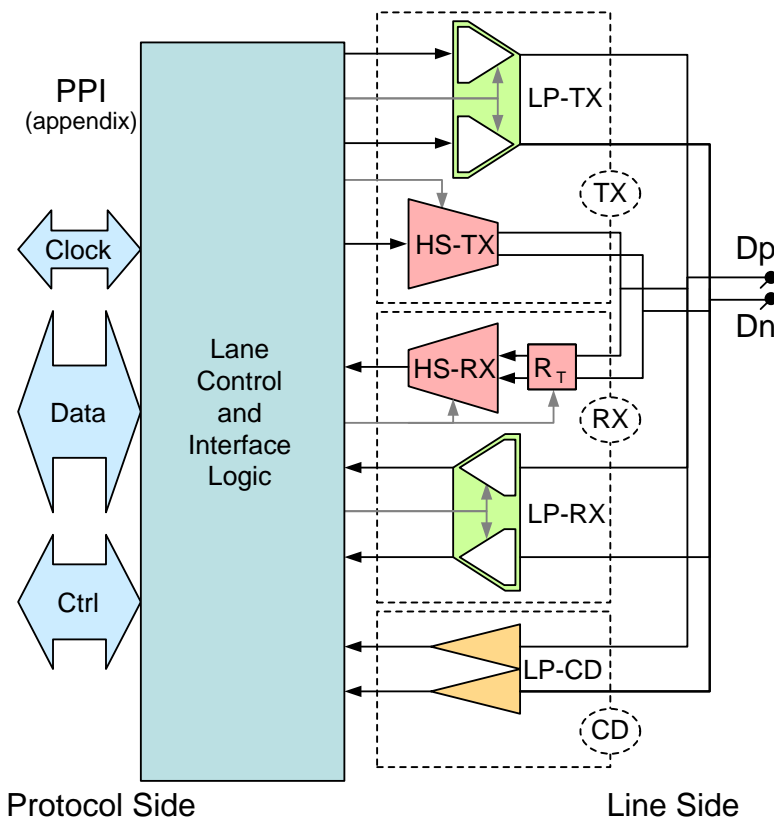
183 All functionality that is specified in this document and which is not explicitly stated in Section 5.5 shall be
184 implemented for all D-PHY configurations.

5 Architecture

185 This section describes the internal structure of the PHY including its functions at the behavioral level.
 186 Furthermore, several possible PHY configurations are given. Each configuration can be considered as a
 187 suitable combination from a set of basic modules.

5.1 Lane Modules

188 A PHY configuration contains a Clock Lane Module and one or more Data Lane Modules. Each of these
 189 PHY Lane Modules communicates via two Lines to a complementary part at the other side of the Lane
 190 Interconnect.



191 **Figure 1 Universal Lane Module Functions**

192 Each Lane Module consists of one or more differential High-Speed functions utilizing both interconnect
 193 wires simultaneously, one or more single-ended Low-Power functions operating on each of the interconnect
 194 wires individually, and control & interface logic. An overview of all functions is shown in Figure 1. High-
 195 Speed signals have a low voltage swing, e.g. 200 mV, while Low-Power signals have a large swing, e.g.
 196 1.2V. High-Speed functions are used for High-Speed Data transmission. The Low-Power functions are
 197 mainly used for Control, but have other, optional, use cases. The I/O functions are controlled by a Lane
 198 Control and Interface Logic block. This block interfaces with the Protocol and determines the global
 199 operation of the Lane Module.

200 High-Speed functions include a differential transmitter (HS-TX) and a differential receiver (HS-RX).

201 A Lane Module may contain a HS-TX, a HS-RX, or both. A HS-TX and a HS-RX within a single Lane
 202 Module are never enabled simultaneously during normal operation. An enabled High-Speed function shall
 203 terminate the Lane on its side of the Lane Interconnect as defined in Section 9.1.1 and Section 9.2.1. If a
 204 High-Speed function in the Lane Module is not enabled then the function shall be put into a high
 205 impedance state.

206 Low-Power functions include single-ended transmitters (LP-TX), receivers (LP-RX) and Low-Power
207 Contention-Detectors (LP-CD). Low-Power functions are always present in pairs as these are single-ended
208 functions operating on each of the two interconnect wires individually.

209 Presence of High-Speed and Low-Power functions is correlated. That is, if a Lane Module contains a HS-
210 TX it shall also contain a LP-TX. A similar constraint holds for HS-RX and LP-RX.

211 If a Lane Module containing a LP-RX is powered, that LP-RX shall always be active and continuously
212 monitor line levels. A LP-TX shall only be enabled when driving Low-Power states. The LP-CD function is
213 only required for bi-directional operation. If present, the LP-CD function is enabled to detect contention
214 situations while the LP-TX is driving Low-Power states. The LP-CD checks for contention before driving a
215 new state on the line except in ULPS.

216 The activities of LP-TX, HS-TX, and HS-RX in a single Lane Module are mutually exclusive, except for
217 some short crossover periods. For detailed specification of the Line side Clock and Data signals, and the
218 HS-TX, HS-RX, LP-TX, LP-RX and LP-CD functions, see Section 9 and Section 10.

219 For proper operation, the set of functions in the Lane Modules on both sides of the Lane Interconnect has to
220 be matched. This means for each HS and LP transmit or receive function on one side of the Lane
221 Interconnect, a complementary HS or LP receive or transmit function must be present on the other side. In
222 addition, a Contention Detector is needed in any Lane Module that combines TX and RX functions.

5.2 Master and Slave

223 Each Link has a Master and a Slave side. The Master provides the High-Speed DDR Clock signal to the
224 Clock Lane and is the main data source. The Slave receives the clock signal at the Clock Lane and is the
225 main data sink. The main direction of data communication, from source to sink, is denoted as the Forward
226 direction. Data communication in the opposite direction is called Reverse transmission. Only bi-directional
227 Data Lanes can transmit in the Reverse direction. In all cases, the Clock Lane remains in the Forward
228 direction, but bi-directional Data Lane(s) can be turned around, sourcing data from the Slave side.

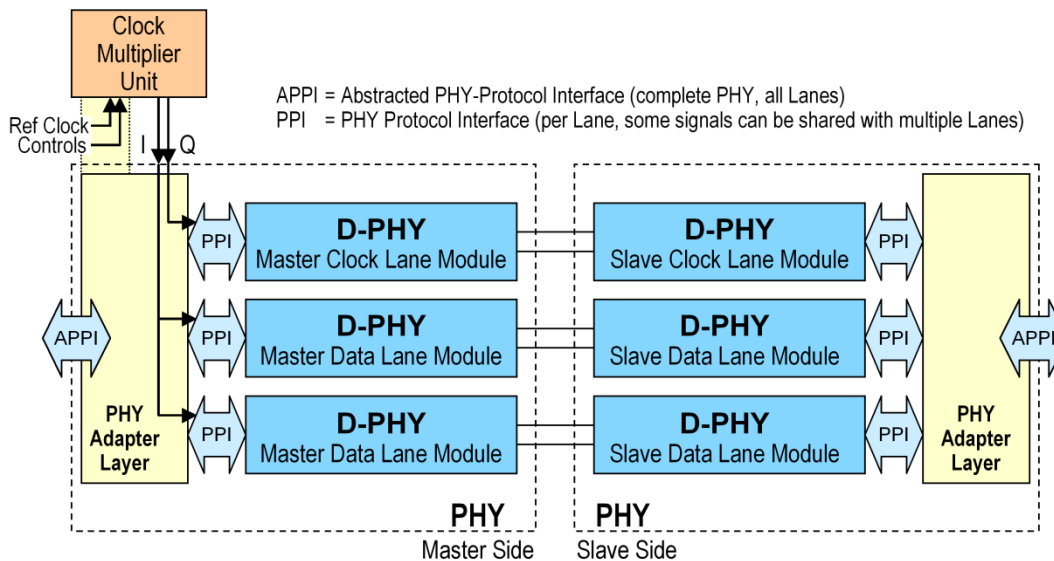
5.3 High Frequency Clock Generation

229 In many cases a PLL Clock Multiplier is needed for the high frequency clock generation at the Master Side.
230 The D-PHY specification uses an architectural model where a separate Clock Multiplier Unit outside the
231 PHY generates the required high frequency clock signals for the PHY. Whether this Clock Multiplier Unit
232 in practice is integrated inside the PHY is left to the implementer.

5.4 Clock Lane, Data Lanes and the PHY-Protocol Interface

233 A complete Link contains, beside Lane Modules, a PHY Adapter Layer that ties all Lanes, the Clock
234 Multiplier Unit, and the PHY Protocol Interface together. Figure 2 shows a PHY configuration example for
235 a Link with two Data Lanes plus a separate Clock Multiplier Unit. The PHY Adapter Layer, though a
236 component of a PHY, is not within the scope of this specification.

237 The logical PHY-Protocol interface (PPI) for each individual Lane includes a set of signals to cover the
238 functionality of that Lane. As shown in Figure 2, Clock signals may be shared for all Lanes. The reference
239 clock and control signals for the Clock Multiplier Unit are not within the scope of this specification.



240

Figure 2 Two Data Lane PHY Configuration

5.5 Selectable Lane Options

241 A PHY configuration consists of one Clock Lane and one or more Data Lanes. All Data Lanes shall support
242 High-Speed transmission and Escape mode in the Forward direction.

243 There are two main types of Data Lanes:

- 244 • Bi-directional (featuring Turnaround and some Reverse communication functionality)
- 245 • Unidirectional (without Turnaround or any kind of Reverse communication functionality)

246 Bi-directional Data Lanes shall include one or both of the following Reverse communication options:

- 247 • High-Speed Reverse data communication
- 248 • Low-Power Reverse Escape mode (including or excluding LPDT)

249 All Lanes shall include Escape mode support for ULPS and Triggers in the Forward direction. Other
250 Escape mode functionality is optional; all possible Escape mode features are described in Section 6.6.
251 Applications shall define what additional Escape mode functionality is required and, for bi-directional
252 Lanes, shall select Escape mode functionality for each direction individually.

253 This results in many options for complete PHY Configurations. The degrees of freedom are:

- 254 • Single or Multiple Data Lanes
- 255 • Bi-directional and/or Unidirectional Data Lane (per Lane)
- 256 • Supported types of Reverse communication (per Lane)
- 257 • Functionality supported by Escape mode (for each direction per Lane)
- 258 • Data transmission can be with 8-bit raw data (default) or using 8b9b encoded symbol (see Annex
259 C)

260 Figure 3 is a flow graph of the option selection process. Practical configuration examples can be found in
261 Section 5.7.

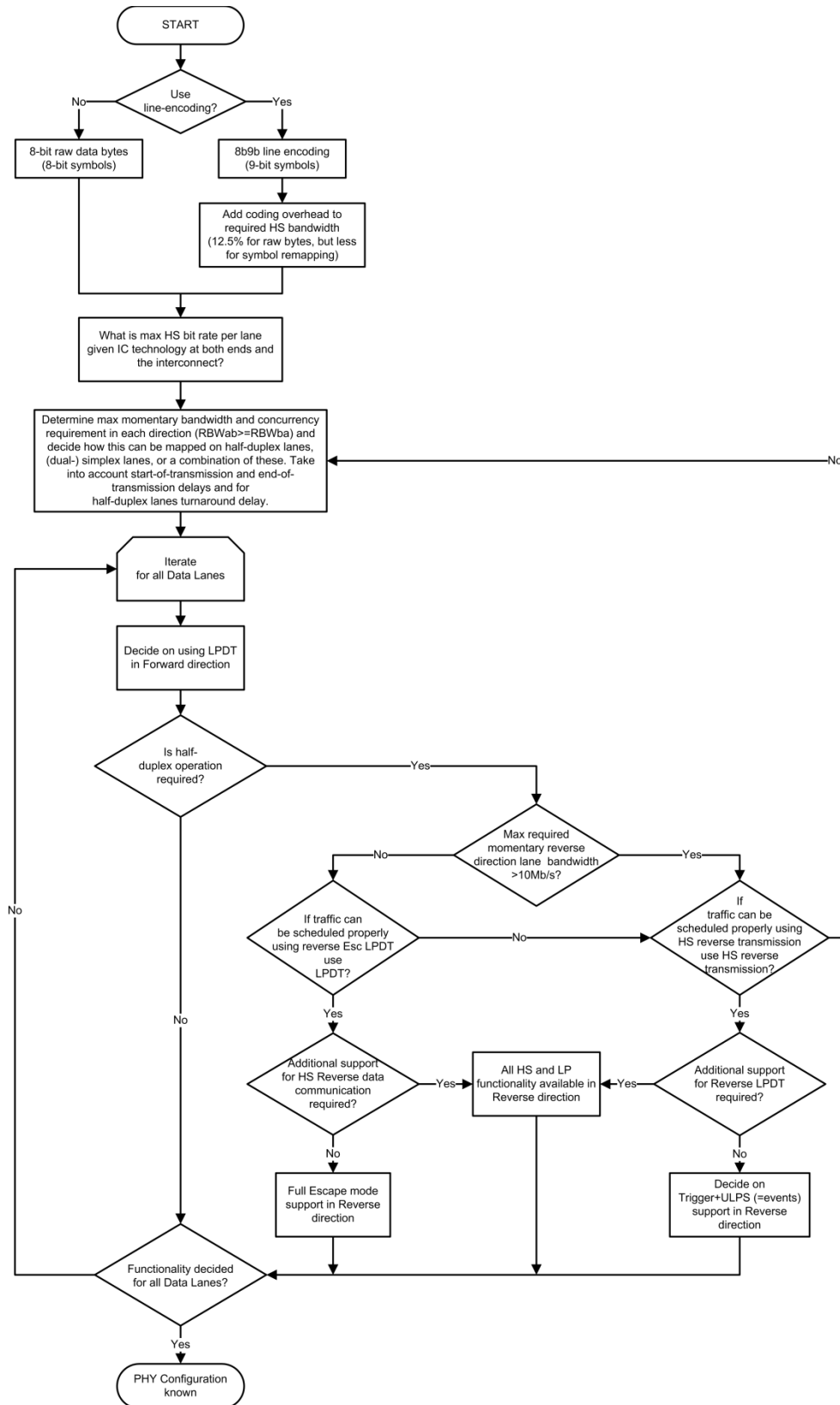
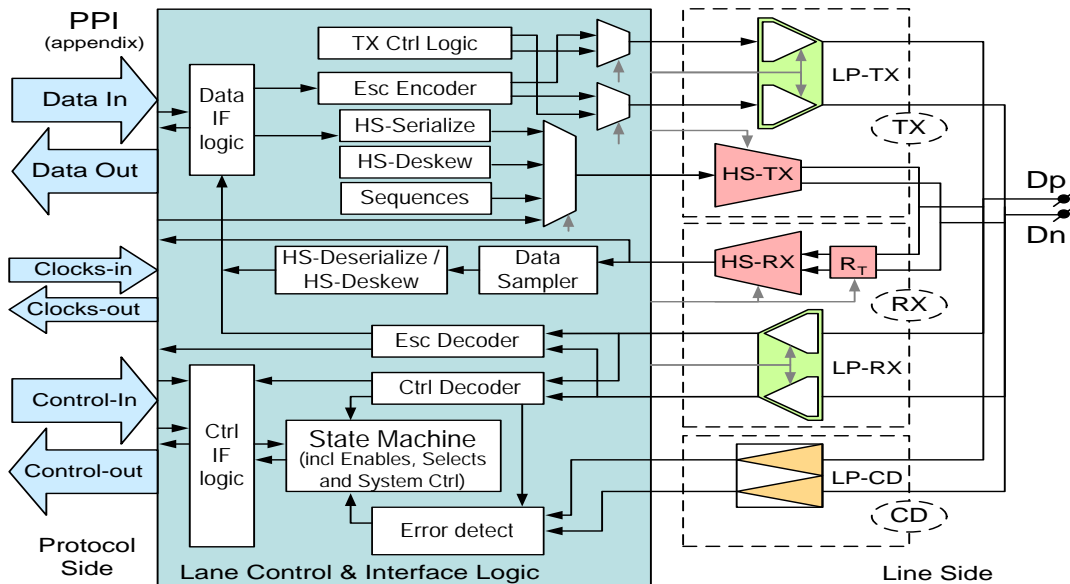


Figure 3 Option Selection Flow Graph

5.6 Lane Module Types

263 The required functions in a Lane Module depend on the Lane type and which side of the Lane Interconnect
 264 the Lane Module is located. There are three main Lane types: Clock Lane, Unidirectional Data Lane and
 265 Bi-directional Data Lane. Several PHY configurations can be constructed with these Lane types. See Figure
 266 3 for more information on selecting Lane options.

267 Figure 4 shows a Universal Lane Module Diagram with a global overview of internal functionality of the
 268 CIL function. This Universal Module can be used for all Lane Types. The requirements for the ‘Control and
 269 Interface Logic’ (CIL) function depend on the Lane type and Lane side. Section 6 and Annex A implicitly
 270 specify the contents of the CIL function. The actual realization is left to the implementer.



271 **Figure 4 Universal Lane Module Architecture**

272 Of course, stripped-down versions of the Universal Lane Module that just support the required functionality
 273 for a particular Lane type are possible. These stripped-down versions are identified by the acronyms in
 274 Table 1. For simplification reasons, any of the four identification characters can be replaced by an X, which
 275 means that this can be any of the available options. For example, a CIL-MFEN is therefore a stripped-down
 276 CIL function for the Master Side of a Unidirectional Lane with Escape mode functionality only in the
 277 Forward direction. A CIL-SRXX is a CIL function for the Slave Side of a Lane with support for Bi-
 278 directional High-Speed communication and any allowed subset of Escape mode.

279 Note that a CIL-XFXN implies a unidirectional Link, while either a CIL-XRXX or CIL-XXXY block
 280 implies a bidirectional Link. Note that Forward ‘Escape’ (ULPS) entry for Clock Lanes is different than
 281 Escape mode entry for Data Lanes.

282

Table 1 Lane Type Descriptors

Prefix	Lane Interconnect Side	High-Speed Capabilities	Forward Direction Escape Mode Features Supported	Reverse Direction Escape Mode Features Supported ¹
CIL-	M – Master S – Slave X – Don't Care	F – Forward Only R – Reverse and Forward X – Don't Care ²	A – All (including LPDT) E – events – Triggers and ULPS Only X – Don't Care	A – All (including LPDT) E – events – Triggers and ULPS Only N – None Y – Any (A, E, or A and E) X – Don't Care
		C – Clock	N – Not Applicable	N – Not Applicable

Note:

1. "Any" is any combination of one or more functions.
2. Only valid for Data Lanes, means "F" or "R".

283 The recommend PHY Protocol Interface contains Data-in and Data-out in byte format, Input and/or output
284 Clock signals and Control signals. Control signals include requests, handshakes, test settings, and
285 initialization. A proposal for a logical internal interface is described in Annex A. Although not a
286 requirement it may be very useful to use the proposed PPI. For external use on IC's an implementation may
287 multiplex many signals on the same pins. However, for power efficiency reasons, the PPI is normally
288 within an IC.

5.6.1 Unidirectional Data Lane

289 For a Unidirectional Data Lane the Master Module shall contain at least a HS-TX, a LP-TX, and a CIL-
290 MFXN function. The Slave side shall contain at least a HS-RX, a LP-RX and a CIL-SFXN.

5.6.2 Bi-directional Data Lanes

291 A bi-directional Data Lane Module includes some form of reverse communication; either High-Speed
292 Reverse Communication, Reverse Escape mode, or both. The functions required depend on what methods
293 of Reverse communication are included in the Lane Module.

5.6.2.1 Bi-directional Data Lane without High-Speed Reverse Communication

294 A bi-directional Data Lane Module without High-Speed Reverse Communication shall include a Reverse
295 Escape mode. The Master-side Lane Module includes a HS-TX, LP-TX, LP-RX, LP-CD, and CIL-MFXY.
296 The Slave-side consists of a HS-RX, LP-RX, LP-TX, LP-CD and a CIL-SFXY.

5.6.2.2 Bi-directional Data Lane with High-Speed Reverse Communication

297 A bi-directional Data Lane Module with High-Speed Reverse Communication shall include a Reverse
298 Escape mode. The Master-side Lane Module includes a HS-TX, HS-RX, LP-TX, LP-RX, LP-CD, and CIL-
299 MRXX. The Slave-side consists of a HS-RX, HS-TX, LP-RX, LP-TX, LP-CD and a CIL-SRXX.

300 This type of Lane Module may seem suitable for both Master and Slave side but because of the asymmetry
301 of the Link one side shall be configured as Master and the other side as Slave.

5.6.3 Clock Lane

302 For the Clock Lane, only a limited set of line states is used. However, for Clock Transmission and Low-
303 Power mode the same TX and RX functions are required as for Unidirectional Data Lanes. A Clock Lane
304 Module for the Master Side therefore contains a HS-TX, LP-TX, and a CIL-MCNN function, while the
305 Slave Side Module includes a HS-RX, a LP-RX and a CIL-SCNN function.

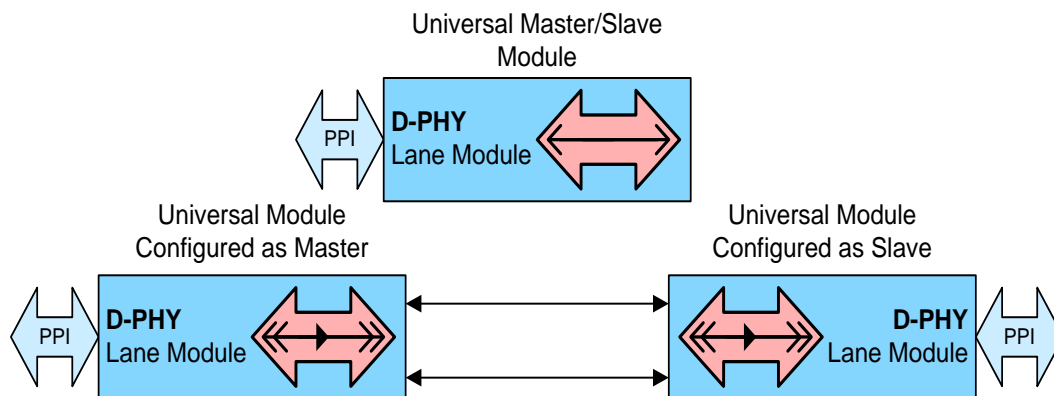
306 Note that the required functionality for a Clock Lane is similar, but not identical, to a Unidirectional Data
307 Lane. The High-Speed DDR clock is transmitted in quadrature phase with Data signals instead of in-phase.
308 In addition, the Clock Lane Escape mode entry is different than that used for Data Lanes. Furthermore,
309 since a Clock Lane only supports ULPS, an Escape mode entry code is not required.

310 The internal clock signals with the appropriate phases are generated outside the PHY and delivered to the
311 individual Lanes. The realization of the Clock generation unit is outside the scope of this specification. The
312 quality of the internal clock signals shall be sufficient to meet the timing requirement for the signals as
313 specified in Section 10.

5.7 Configurations

314 This section outlines several common PHY configurations but should not be considered an exhaustive list
315 of all possible arrangements. Any other configuration that does not violate the requirements of this
316 document is also allowed.

317 In order to create an abstraction level, the Lane Modules are represented in this section by Lane Module
318 Symbols. Figure 5 shows the syntax and meaning of symbols.



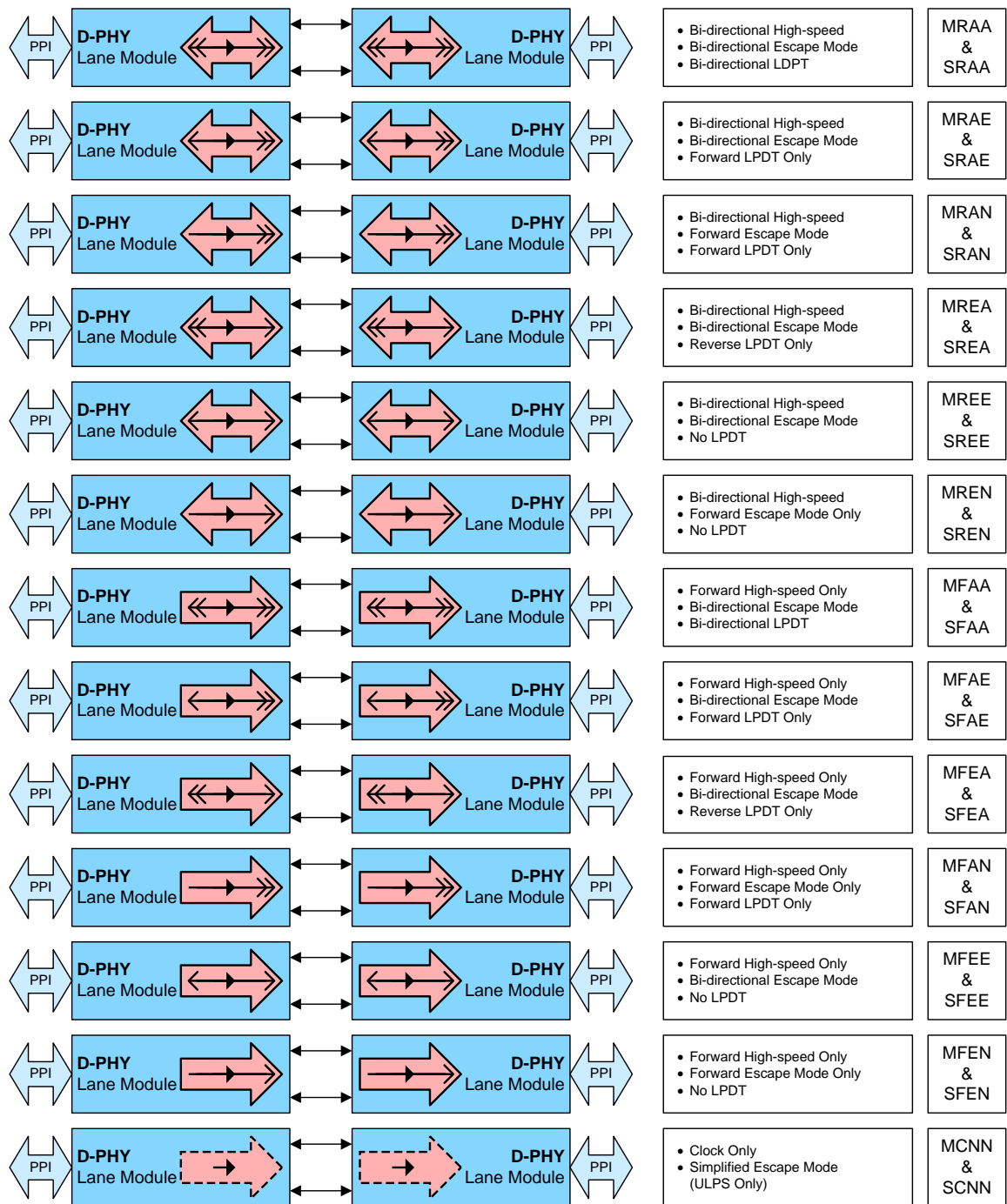
Legend:

This	Other Options	Meaning
		Supported Directions for High-Speed Data Transmission (Bi-directional or Unidirectional)
		Clock Lane
		Supported Directions for Escape mode excluding LPDT (Bi-directional or Forward Only)
		Supported Directions for Escape mode including LPDT (Bi-directional, Forward Only or Reverse Only)
		Clock Direction (by definition from Master to Slave, must point in the same direction as the "Clock Only Lane" arrow)
		PPI: PHY-Protocol Interface

319

Figure 5 Lane Symbol Macros and Symbols Legend

320 For multiple Data Lanes a large variety of configurations is possible. Figure 6 shows an overview of
 321 symbolic representations for different Lane types. The acronyms mentioned for each Lane type represent
 322 the functionality of each module in a short way. This also sets the requirements for the CIL function inside
 323 each Module.



324

Figure 6 All Possible Data Lane Types and a Basic Unidirectional Clock Lane

5.7.1 Unidirectional Configurations

325

All unidirectional configurations are constructed with a Clock Lane and one or more Unidirectional Data Lanes. Two basic configurations can be distinguished: Single Data Lane and Multiple Data Lanes. For completeness a Dual-Simplex configuration is also shown. At the PHY level there is no difference between a Dual-Simplex configuration and two independent unidirectional configurations.

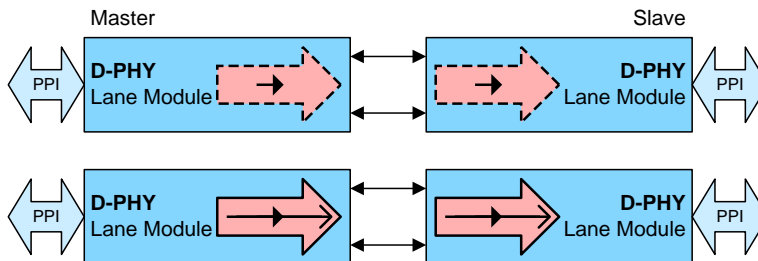
326

327

328

5.7.1.1 PHY Configuration with a Single Data Lane

329 This configuration includes one Clock Lane and one Unidirectional Data Lane from Master to Slave.
330 Communication is therefore only possible in the Forward direction. Figure 7 shows an example
331 configuration without LPDT. This configuration requires four interconnect signal wires.

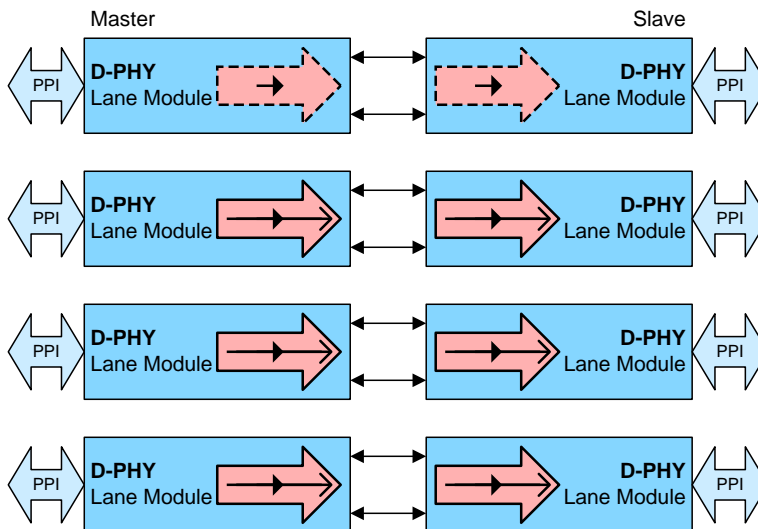


332

Figure 7 Unidirectional Single Data Lane Configuration

5.7.1.2 PHY Configuration with Multiple Data Lanes

333 This configuration includes one Clock Lane and multiple Unidirectional Data Lanes from Master to Slave.
334 Bandwidth is extended, but communication is only possible in the Forward direction. The PHY
335 specification does not require all Data Lanes to be active simultaneously. In fact, the Protocol layer controls
336 all Data Lanes individually. Figure 8 shows an example of this configuration for three Data Lanes. If N is
337 the number of Data Lanes, this configuration requires $2*(N+1)$ interconnect wires.

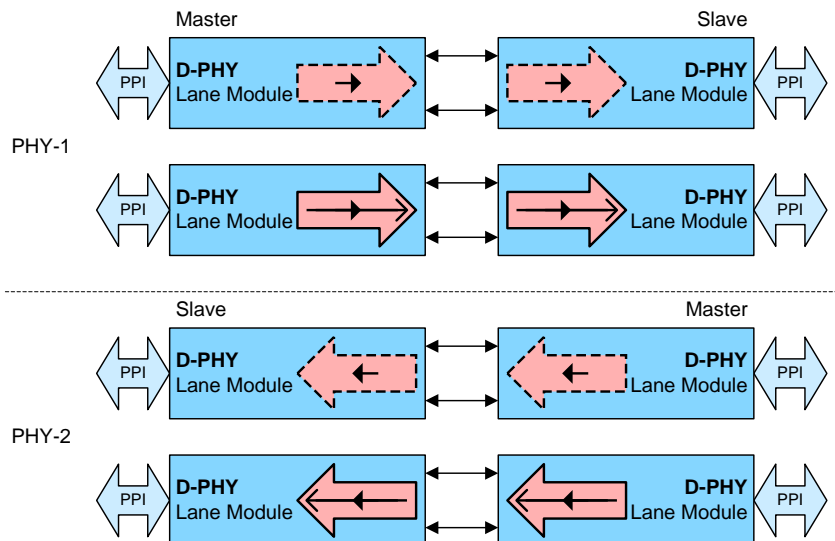


338

Figure 8 Unidirectional Multiple Data Lane Configuration without LPDT

5.7.1.3 Dual-Simplex (Two Directions with Unidirectional Lanes)

339 This case is the same as two independent (dual), unidirectional (simplex) Links: one for each direction.
340 Each direction has its own Clock Lane and may contain either a single, or multiple, Data Lanes. Please note
341 that the Master and Slave side for the two different directions are opposite. The PHY configuration for each
342 direction shall comply with the D-PHY specifications. As both directions are conceptually independent, the
343 bit rates for each direction do not have to match. However, for practical implementations, it is attractive to
344 match rates and share some internal signals as long as both Links fulfill all specifications externally. Figure
345 9 shows an example of this dual PHY configuration.



346

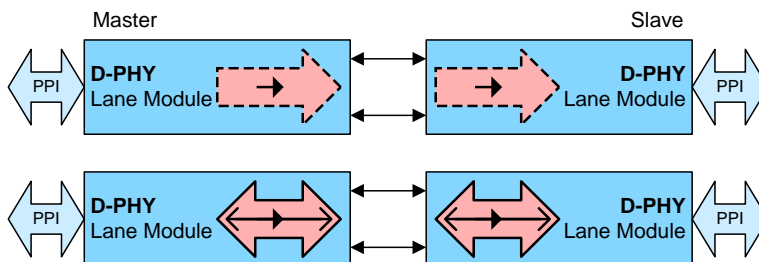
Figure 9 Two Directions Using Two Independent Unidirectional PHYs without LPDT

5.7.2 Bi-Directional Half-Duplex Configurations

347 Bi-directional configurations consist of a Clock Lane and one or more bi-directional Data Lanes. Half-
 348 duplex operation enables bi-directional traffic across shared interconnect wires. This configuration saves
 349 wires compared to the Dual-Simplex configuration. However, time on the Link is shared between Forward
 350 and Reverse traffic and Link Turnaround. The High-Speed bit rate in the Reverse direction is, by definition,
 351 one-fourth of the bit rate in the Forward direction. LPDT can have similar rates in the Forward and Reverse
 352 directions. This configuration is especially useful for cases with asymmetrical data traffic.

5.7.2.1 PHY Configurations with a Single Data Lane

353 This configuration includes one Clock Lane and one of any kind of bi-directional Data Lane. This allows
 354 time-multiplexed data traffic in both Forward and Reverse directions. Figure 10 shows this configuration
 355 with a Data Lane that supports both High-Speed and Escape (without LPDT) communication in both
 356 directions. Other possibilities are that only one type of reverse communication is supported or LPDT is also
 357 included in one or both directions. All these configurations require four interconnect wires.

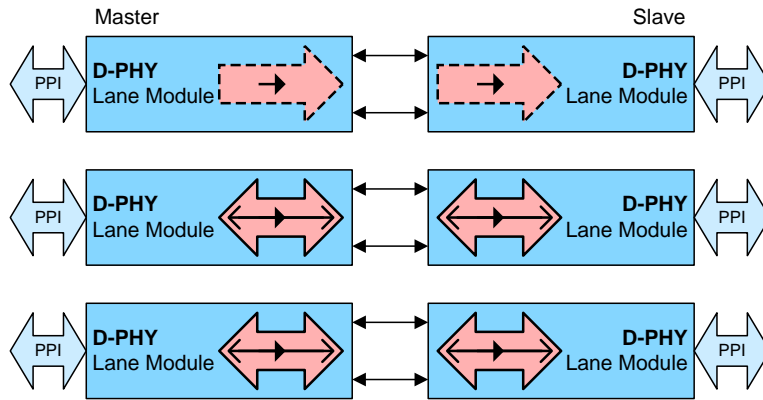


358

Figure 10 Bidirectional Single Data Lane Configuration

5.7.2.2 PHY Configurations with Multiple Data Lanes

359 This configuration includes one Clock Lane and multiple bi-directional Data Lanes. Communication is
 360 possible in both the Forward and Reverse direction for each individual Lane. The maximum available
 361 bandwidth scales with the number of Lanes for each direction. The PHY specification does not require all
 362 Data Lanes to be active simultaneously or even to be operating in the same direction. In fact, the Protocol
 363 layer controls all Data Lanes individually. Figure 11 shows an example configuration with two Data Lanes.
 364 If N is the number of Data Lanes, this configuration requires 2*(N+1) interconnect wires.

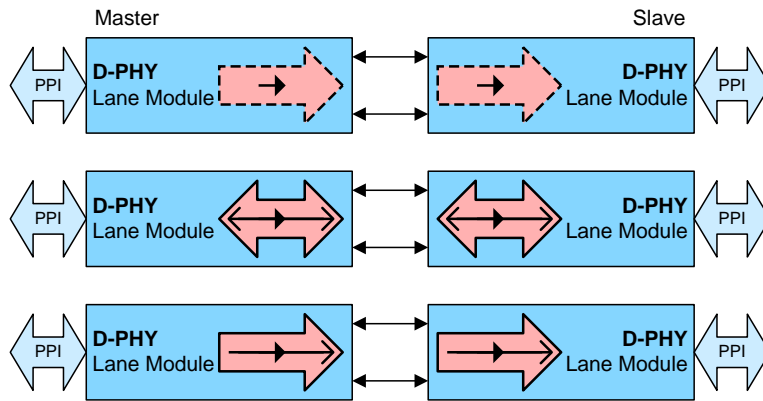


365

Figure 11 Bi-directional Multiple Data Lane Configuration

5.7.3 Mixed Data Lane Configurations

366 Instead of using only one Data Lane type, PHY configurations may combine different unidirectional and bi-
367 directional Data Lane types. Figure 12 shows an example configuration with one bi-directional and one
368 unidirectional Data Lane, both without LPDT.



369

Figure 12 Mixed Type Multiple Data Lane Configuration

6 Global Operation

370 This section specifies operation of the D-PHY including signaling types, communication mechanisms,
371 operating modes and coding schemes. Detailed specifications of the required electrical functions can be
372 found in Section 9.

6.1 Transmission Data Structure

373 During High-Speed, or Low-Power, transmission, the Link transports payload data provided by the protocol
374 layer to the other side of the Link. This section specifies the restrictions for the transmitted and received
375 payload data.

6.1.1 Data Units

376 The minimum payload data unit shall be one byte. Data provided to a TX and taken from a RX on any Lane
377 shall be an integer number of bytes. This restriction holds for both High-Speed and Low-Power data
378 transmission in any direction.

6.1.2 Bit order, Serialization, and De-Serialization

379 For serial transmission, the data shall be serialized in the transmitting PHY and de-serialized in the
380 receiving PHY. The PHY assumes no particular meaning, value or order of incoming and outgoing data.

6.1.3 Encoding and Decoding

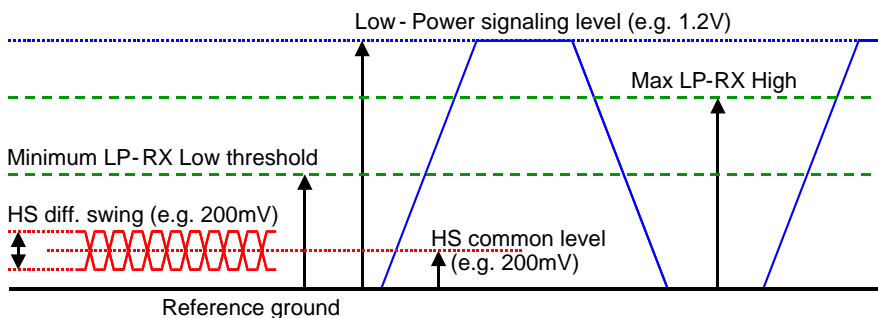
381 Line coding is not required by this specification. However, if line coding is used, it shall be implemented
382 according to Annex C.

6.1.4 Data Buffering

383 Data transmission takes place on protocol request. As soon as communication starts, the protocol layer at
384 the transmit side shall provide valid data as long as it does not stop its transmission request. For Lanes that
385 use line coding, control symbols can also be inserted into the transmission. The protocol on the receive side
386 shall take the data as soon as delivered by the receiving PHY. The signaling concept, and therefore the PHY
387 protocol handshake, does not allow data throttling. Any data buffering for this purpose shall be inside the
388 protocol layer.

6.2 Lane States and Line Levels

389 Transmitter functions determine the Lane state by driving certain Line levels. During normal operation
390 either a HS-TX or a LP-TX is driving a Lane. A HS-TX always drives the Lane differentially. The two LP-
391 TX's drive the two Lines of a Lane independently and single-ended. This results in two possible High-
392 Speed Lane states and four possible Low-Power Lane states. The High-Speed Lane states are Differential-0
393 and Differential-1. The interpretation of Low-Power Lane states depends on the mode of operation. The
394 LP-Receiver shall always interpret both High-Speed differential states as LP-00.



395

Figure 13 Line Levels

396 The Stop state has a very exclusive and central function. If the Line levels show a Stop state for the
397 minimum required time, the PHY state machine shall return to the Stop state regardless of the previous
398 state. This can be in RX or TX mode depending on the most recent operating direction. Table 2 lists all the
399 states that can appear on a Lane during normal operation. Detailed specifications of electrical levels can be
400 found in Section 9.

401 All LP state periods shall be at least T_{LPX} in duration. State transitions shall be smooth and exclude glitch
402 effects. A clock signal can be reconstructed by exclusive-ORing the Dp and Dn Lines. Ideally, the
403 reconstructed clock has a duration of at least $2 * T_{LPX}$, but may have a duty cycle other than 50% due to
404 signal slope and trip levels effects.

405 **Table 2 Lane State Descriptions**

State Code	Line Voltage Levels		High-Speed	Low-Power	
	Dp-Line	Dn-Line	Burst Mode	Control Mode	Escape Mode
HS-0	HS Low	HS High	Differential-0	N/A, Note 1	N/A, Note 1
HS-1	HS High	HS Low	Differential-1	N/A, Note 1	N/A, Note 1
LP-00	LP Low	LP Low	N/A	Bridge	Space
LP-01	LP Low	LP High	N/A	HS-Rqst	Mark-0
LP-10	LP High	LP Low	N/A	LP-Rqst	Mark-1
LP-11	LP High	LP High	N/A	Stop	N/A, Note 2

Note:

1. During High-Speed transmission the Low-Power Receivers observe LP-00 on the Lines.
2. If LP-11 occurs during Escape mode the Lane returns to Stop state (Control Mode LP-11).

6.3 Operating Modes: Control, High-Speed, and Escape

406 During normal operation a Data Lane will be either in Control or High-Speed mode. High-Speed Data
407 transmission happens in bursts and starts from and ends at a Stop state (LP-11), which is by definition in
408 Control mode. The Lane is only in High-Speed mode during Data bursts. The sequence to enter High-Speed
409 mode is: LP-11, LP-01, LP-00 at which point the Data Lane remains in High-Speed mode until a LP-11 is
410 received. The Escape mode can only be entered via a request within Control mode. The Data Lane shall
411 always exit Escape mode and return to Control mode after detection of a Stop state. If not in High-Speed or
412 Escape mode the Data Lane shall stay in Control mode. For Data Lanes and for Clock Lanes the Stop state
413 serves as general standby state and may last for any period of time $> T_{LPX}$. Possible events starting from the
414 Stop state are High-Speed Data Transmission request (LP-11, LP-01, LP-00), Escape mode request (LP-11,
415 LP-10, LP-00, LP-01, LP-00) or Turnaround request (LP-11, LP-10, LP-00, LP-10, LP-00).

6.4 High-Speed Data Transmission

416 High-Speed Data Transmission occurs in bursts. To aid receiver synchronization, data bursts shall be
417 extended on the transmitter side with a leader and trailer sequence and shall be eliminated on the receiver
418 side. These leader and trailer sequences can therefore only be observed on the transmission lines.

419 Transmission starts from, and ends with, a Stop state. During the intermediate time between bursts a Data
420 Lane shall remain in the Stop state, unless a Turnaround or Escape request is presented on the Lane. During
421 a HS Data Burst the Clock Lane shall be in High-Speed mode, providing a DDR Clock to the Slave side.

6.4.1 Burst Payload Data

422 The payload data of a burst shall always represent an integer number of payload data bytes with a minimum
423 length of one byte. Note that for short bursts the Start and End overhead consumes much more time than
424 the actual transfer of the payload data. There is no maximum number of bytes implied by the PHY.
425 However, in the PHY there is no autonomous way of error recovery during a HS data burst and the practical

426 BER will not be zero. Therefore, it is important to consider for every individual protocol what the best
427 choice is for maximum burst length.

6.4.2 Start-of-Transmission

428 After a Transmit request, a Data Lane leaves the Stop state and prepares for High-Speed mode by means of
429 a Start-of-Transmission (SoT) procedure. Table 3 describes the sequence of events on TX and RX side.

430 **Table 3 Start-of-Transmission Sequence**

TX Side	RX Side
Drives Stop state (LP-11)	Observes Stop state
Drives HS-Rqst state (LP-01) for time T_{LPX}	Observes transition from LP-11 to LP-01 on the Lines
Drives Bridge state (LP-00) for time $T_{HS-PREPARE}$	Observes transition from LP-01 to LP-00 on the Lines, enables Line Termination after time $T_{D-TERM-EN}$
Enables High-Speed driver and disables Low-Power drivers simultaneously.	
Drives HS-0 for a time $T_{HS-ZERO}$	Enables HS-RX and waits for timer $T_{HS-SETTLE}$ to expire in order to neglect transition effects
	Starts looking for Leader-Sequence
Inserts the HS Sync-Sequence '00011101' beginning on a rising Clock edge	
	Synchronizes upon recognition of Leader Sequence '011101'
Continues to Transmit High-Speed payload data	
	Receives payload data

6.4.3 End-of-Transmission

431 At the end of a Data Burst, a Data Lane leaves High-Speed Transmission mode and enters the Stop state by
432 means of an End-of-Transmission (EoT) procedure. Table 4 shows a possible sequence of events during the
433 EoT procedure. Note, EoT processing may be handled by the protocol or by the D-PHY.

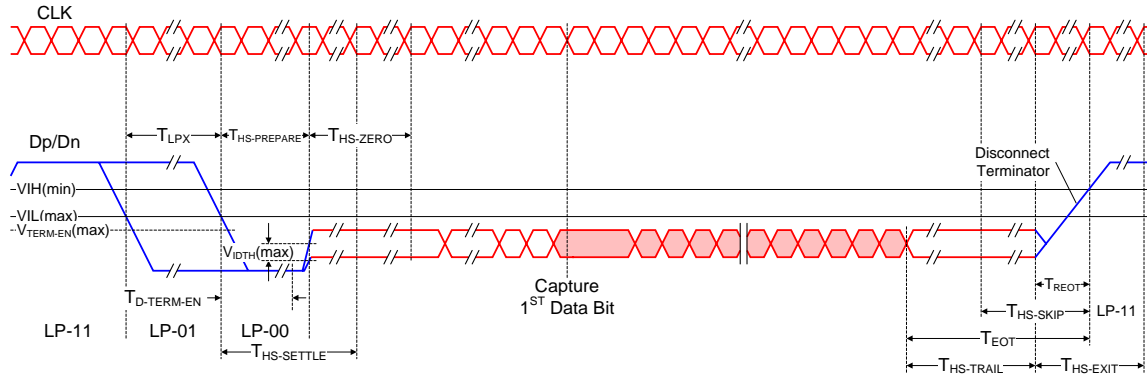
434 **Table 4 End-of-Transmission Sequence**

TX Side	RX Side
Completes Transmission of payload data	Receives payload data
Toggles differential state immediately after last payload data bit and keeps that state for a time $T_{HS-TRAIL}$	
Disables the HS-TX, enables the LP-TX, and drives Stop state (LP-11) for a time $T_{HS-EXIT}$	Detects the Lines leaving LP-00 state and entering Stop state (LP-11) and disables Termination
	Neglect bits of last period $T_{HS-SKIP}$ to hide transition effects
	Detect last transition in valid Data, determine last valid Data byte and skip trailer sequence

6.4.4 HS Data Transmission Burst

435 Figure 14 shows the sequence of events during the transmission of a Data Burst. Transmission can be
436 started and ended independently for any Lane by the protocol. However, for most applications the Lanes

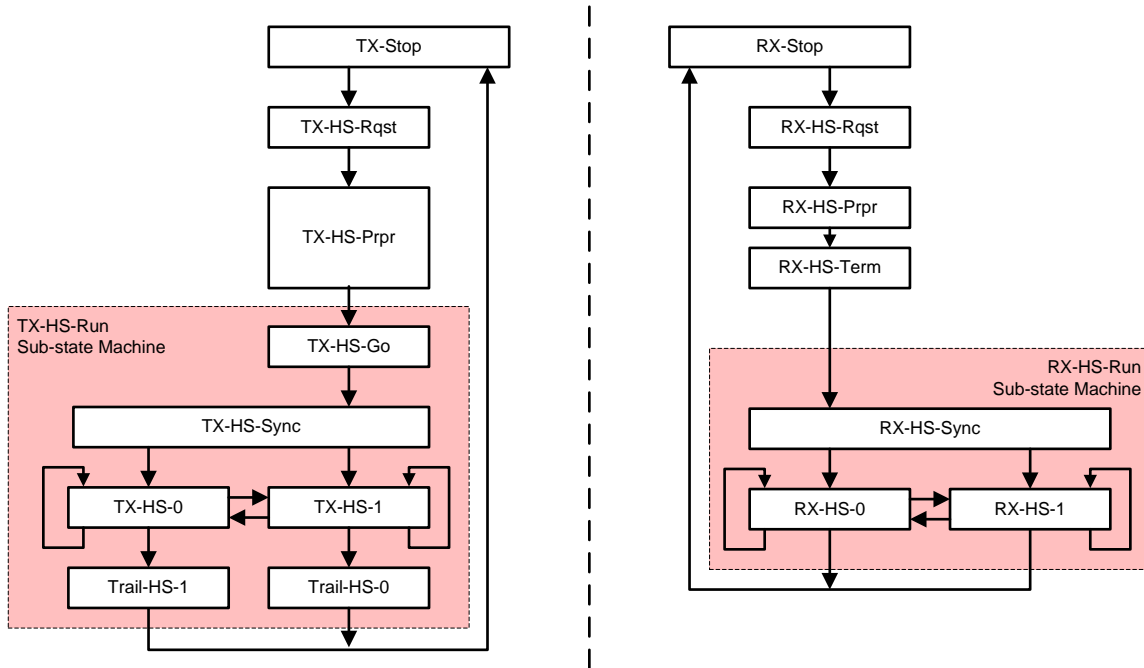
437 will start synchronously but may end at different times due to an unequal amount of transmitted bytes per
438 Lane. The handshake with the protocol-layer is described in Annex A.



439

Figure 14 High-Speed Data Transmission in Bursts

440 Figure 15 shows the state machine for High-Speed data transmission that is described in Table 5.



Note: Horizontally aligned states occur simultaneously.

441

Figure 15 TX and RX State Machines for High-Speed Data Transmission

442

Table 5 High-Speed Data Transmission State Machine Description

State	Line Condition/State	Exit State	Exit Conditions
TX-Stop	Transmit LP-11	TX-HS-Rqst	On request of Protocol for High-Speed Transmission
TX-HS-Rqst	Transmit LP-01	TX-HS-Prpr	End of timed interval T_{LPX}
TX-HS-Prpr	Transmit LP-00	TX-HS-Go	End of timed interval $T_{HS-PREPARE}$

State	Line Condition/State	Exit State	Exit Conditions
TX-HS-Go	Transmit HS-0	TX-HS-Sync	End of timed interval $T_{HS-ZERO}$
TX-HS-Sync	Transmit sequence HS-00011101	TX-HS-0	After Sync sequence if first payload data bit is 0
		TX-HS-1	After Sync sequence if first payload data bit is 1
TX-HS-0	Transmit HS-0	TX-HS-0	Send another HS-0 bit after a HS-0 bit
		TX-HS-1	Send a HS-1 bit after a HS-0 bit
		Trail-HS-1	Last payload bit is HS-0, trailer sequence is HS-1
TX-HS-1	Transmit HS-1	TX-HS-0	Send a HS-1 bit after a HS-0 bit
		TX-HS-1	Send another HS-1 bit after a HS-1
		Trail-HS-0	Last payload bit is HS-1, trailer sequence is HS-0
Trail-HS-0	Transmit HS-0	TX-Stop	End of timed interval $T_{HS-TRAIL}$
Trail-HS-1	Transmit HS-1	TX-Stop	End of timed interval $T_{HS-TRAIL}$
RX-Stop	Receive LP-11	RX-HS-Rqst	Line transition to LP-01
RX- HS-Rqst	Receive LP-01	RX-HS-Prpr	Line transition to LP-00
RX-HS- Prpr	Receive LP-00	RX-HS-Term	End of timed interval $T_{D-TERM-EN}$
RX-HS-Term	Receive LP-00	RX-HS-Sync	End of timed interval $T_{HS-SETTLE}$
RX-HS-Sync	Receive HS sequence ...00000011101	RX-HS-0	Proper match found (any single bit error allowed) for Sync sequence in HS stream, the following bits are payload data.
		RX-HS-1	
RX-HS-0	Receive HS-0	RX-HS-0	Receive payload data bit or trailer bit
		RX-HS-1	
		RX-Stop	Line transition to LP-11
RX-HS-1	Receive HS-1	RX-HS-0	Receive payload data bit or trailer bit
		RX-HS-1	
		RX-Stop	Line transition to LP-11

Note:

Stop states (TX-Stop, RX-Stop) have multiple valid exit states.

6.5 Bi-directional Data Lane Turnaround

443 The transmission direction of a bi-directional Data Lane can be swapped by means of a Link Turnaround
 444 procedure. This procedure enables information transfer in the opposite direction of the current direction.
 445 The procedure is the same for either a change from Forward-to-Reverse direction or Reverse-to-Forward
 446 direction. Notice that Master and Slave side shall not be changed by Turnaround. Link Turnaround shall be
 447 handled completely in Control mode. Table 6 lists the sequence of events during Turnaround.

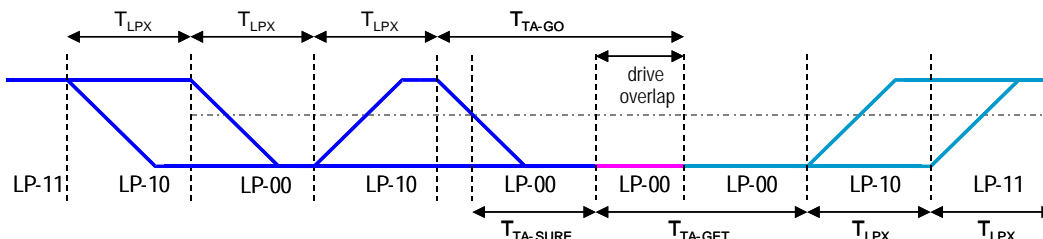
448

Table 6 Link Turnaround Sequence

Initial TX Side = Final RX Side	Initial RX Side = Final TX Side
Drives Stop state (LP-11)	Observes Stop state
Drives LP-Rqst state (LP-10) for a time T_{LPX}	Observes transition from LP-11 to LP-10 states
Drives Bridge state (LP-00) for a time T_{LPX}	Observes transition from LP-10 to LP-00 states
Drives LP-10 for a time T_{LPX}	Observes transition from LP-00 to LP-10 states

Initial TX Side = Final RX Side	Initial RX Side = Final TX Side
Drives Bridge state (LP-00) for a time T_{TA-GO}	Observes the transition from LP-10 to Bridge state and waits for a time $T_{TA-SURE}$. After correct completion of this time-out this side knows it is in control.
	Drives Bridge state (LP-00) for a period T_{TA-GET}
Stops driving the Lines and observes the Line states with its LP-RX in order to see an acknowledgement.	
	Drives LP-10 for a period T_{LPX}
Observes LP-10 on the Lines, interprets this as acknowledge that the other side has indeed taken control. Waits for Stop state to complete Turnaround procedure.	
	Drives Stop state (LP-11) for a period T_{LPX}
Observes transition to Stop state (LP-11) on the Lines, interprets this as Turnaround completion acknowledgement, switches to normal LP receive mode and waits for further actions from the other side	

449 Figure 16 shows the Turnaround procedure graphically.

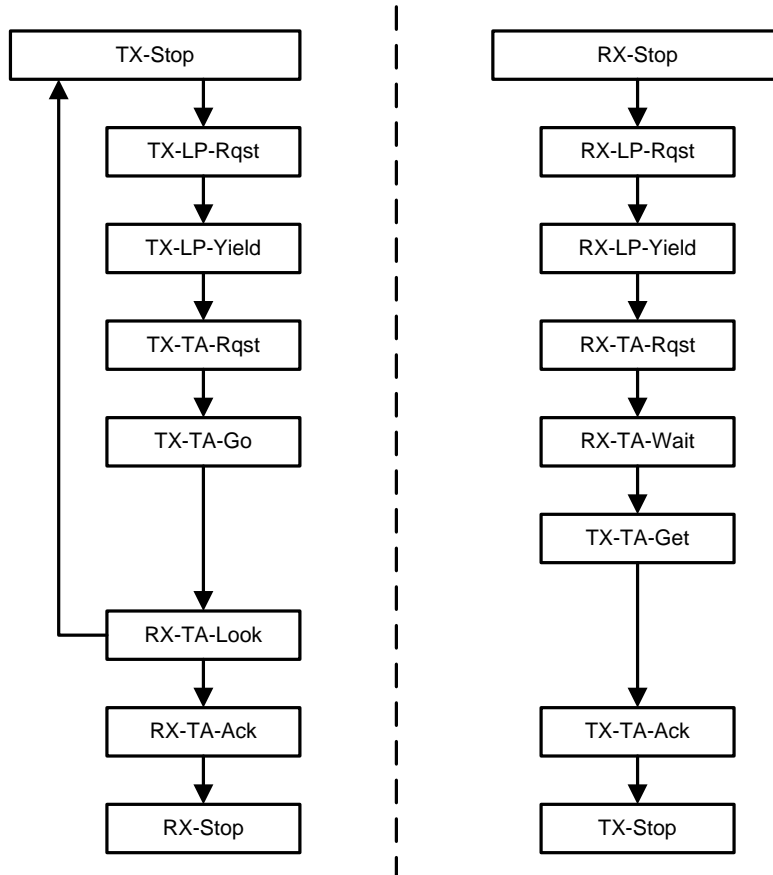


450

Figure 16 Turnaround Procedure

451 The Low-Power clock timing for both sides of the Link does not have to be the same, but may differ.
452 However, the ratio between the Low-Power State Periods, T_{LPX} , is constrained to ensure proper Turnaround
453 behavior. See Table 14 for the ratio of $T_{LPX(MASTER)}$ to $T_{LPX(SLAVE)}$.

454 The Turnaround procedure can be interrupted if the Lane is not yet driven into TX-LP-Yield by means of
455 driving a Stop state. Driving the Stop state shall abort the Turnaround procedure and return the Lane to the
456 Stop state. The PHY shall ensure against interruption of the procedure after the end of TX-TA-Rqst, RX-
457 TA-Rqst, or TX-TA-GO. Once the PHY drives TX-LP-Yield, it shall not abort the Turnaround procedure.
458 The Protocol may take appropriate action if it determines an error has occurred because the Turnaround
459 procedure did not complete within a certain time. See Section 7.3.5 for more details. Figure 17 shows the
460 Turnaround state machine that is described in Table 7.



Note: Horizontally aligned states occur simultaneously.

461

Figure 17 Turnaround State Machine

462

Table 7 Turnaround State Machine Description

State	Line Condition/State	Exit State	Exit Conditions
Any RX state	Any Received	RX-Stop	Observe LP-11 at Lines
TX-Stop	Transmit LP-11	TX-LP-Rqst	On request of Protocol for Turnaround
TX-LP-Rqst	Transmit LP-10	TX-LP-Yield	End of timed interval T_{LPX}
TX-LP-Yield	Transmit LP-00	TX-TA-Rqst	End of timed interval T_{LPX}
TX-TA-Rqst	Transmit LP-10	TX-TA-Go	End of timed interval T_{LPX}
TX-TA-Go	Transmit LP-00	RX-TA-Look	End of timed interval T_{TA-GO}
RX-TA-Look	Receive LP-00	RX-TA-Ack	Line transition to LP-10
RX-TA-Ack	Receive LP-10	RX-Stop	Line transition to LP-11
RX-Stop	Receive LP-11	RX-LP-Rqst	Line transition to LP-10
RX-LP-Rqst	Receive LP-10	RX-LP-Yield	Line transition to LP-00
RX-LP-Yield	Receive LP-00	RX-TA-Rqst	Line transition to LP-10
RX-TA-Rqst	Receive LP-10	RX-TA-Wait	Line transition to LP-00
RX-TA-Wait	Receive LP-00	TX-TA-Get	End of timed interval $T_{TA-SURE}$

State	Line Condition/State	Exit State	Exit Conditions
TX-TA-Get	Transmit LP-00	TX-TA-Ack	End of timed interval T_{TA-GET}
TX-TA-Ack	Transit LP-10	TX-Stop	End of timed interval T_{LPX}

Note:

*During RX-TA-Look, the protocol may cause the PHY to transition to TX-Stop.
During High-Speed data transmission, Stop states (TX-Stop, RX-Stop) have multiple valid exit states.*

6.6 Escape Mode

463 Escape mode is a special mode of operation for Data Lanes using Low-Power states. With this mode some
464 additional functionality becomes available. Escape mode operation shall be supported in the Forward
465 direction and is optional in the Reverse direction. If supported, Escape mode does not have to include all
466 available features.

467 A Data Lane shall enter Escape mode via an Escape mode Entry procedure (LP-11, LP-10, LP-00, LP-01,
468 LP-00). As soon as the final Bridge state (LP-00) is observed on the Lines the Lane shall enter Escape
469 mode in Space state (LP-00). If an LP-11 is detected at any time before the final Bridge state (LP-00), the
470 Escape mode Entry procedure shall be aborted and the receive side shall wait for, or return to, the Stop
471 state.

472 For Data Lanes, once Escape mode is entered, the transmitter shall send an 8-bit entry command to indicate
473 the requested action. Table 8 lists all currently available Escape mode commands and actions. All
474 unassigned commands are reserved for future expansion.

475 The Stop state shall be used to exit Escape mode and cannot occur during Escape mode operation because
476 of the Spaced-One-Hot encoding. Stop state immediately returns the Lane to Control mode. If the entry
477 command doesn't match a supported command, that particular Escape mode action shall be ignored and the
478 receive side waits until the transmit side returns to the Stop state.

479 The PHY in Escape mode shall apply Spaced-One-Hot bit encoding for asynchronous communication.
480 Therefore, operation of a Data Lane in this mode does not depend on the Clock Lane. The complete Escape
481 mode action for a Trigger-Reset command is shown in Figure 18.

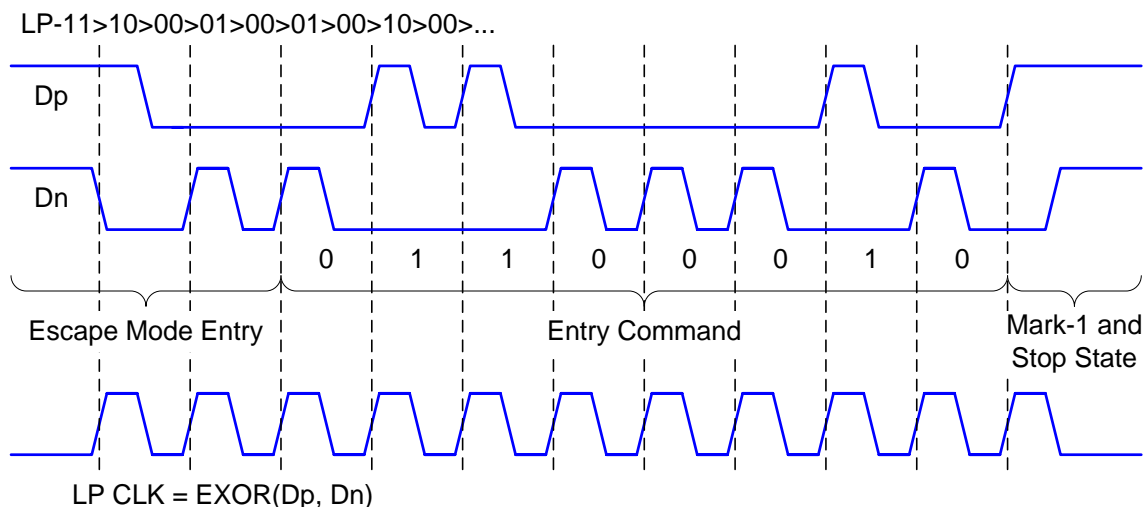


Figure 18 Trigger-Reset Command in Escape Mode

484 Spaced-One-Hot coding means that each Mark state is interleaved with a Space state. Each symbol consists
 485 therefore of two parts: a One-Hot phase (Mark-0 or Mark-1) and a Space phase. The TX shall send Mark-0
 486 followed by a Space to transmit a 'zero-bit' and it shall send a Mark-1 followed by a Space to transmit a
 487 'one-bit'. A Mark that is not followed by a Space does not represent a bit. The last phase before exiting
 488 Escape mode with a Stop state shall be a Mark-1 state that is not part of the communicated bits, as it is not
 489 followed by a Space state. The Clock can be derived from the two Line signals, Dp and Dn, by means of an
 490 exclusive-OR function. The length of each individual LP state period shall be at least $T_{LTX,MIN}$.

491

Table 8 Escape Entry Codes

Escape Mode Action	Command Type	Entry Command Pattern (first bit transmitted to last bit transmitted)
Low-Power Data Transmission	mode	11100001
Ultra-Low Power State	mode	00011110
Undefined-1	mode	10011111
Undefined-2	mode	11011110
Reset-Trigger [Remote Application]	Trigger	01100010
Unknown-3	Trigger	01011101
Unknown-4	Trigger	00100001
Unknown-5	Trigger	10100000

6.6.1 Remote Triggers

492 Trigger signaling is the mechanism to send a flag to the protocol at the receiving side, on request of the
 493 protocol on the transmitting side. This can be either in the Forward or Reverse direction depending on the
 494 direction of operation and available Escape mode functionality. Trigger signaling requires Escape mode
 495 capability and at least one matching Trigger Escape Entry Command on both sides of the interface.

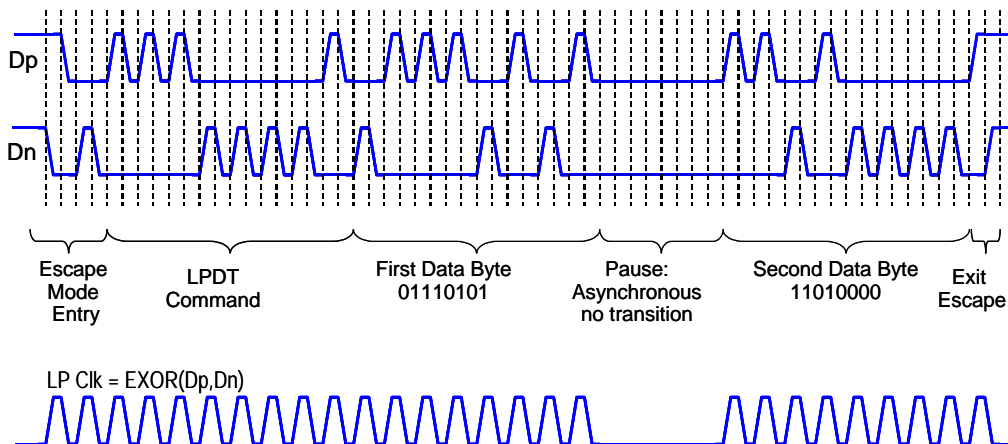
496 Figure 18 shows an example of an Escape mode Reset-Trigger action. The Lane enters Escape mode via the
 497 Escape mode Entry procedure. If the Entry Command Pattern matches the Reset-Trigger Command a
 498 Trigger is flagged to the protocol at the receive side via the logical PPI. Any bit received after a Trigger
 499 Command but before the Lines go to Stop state shall be ignored. Therefore, dummy bytes can be
 500 concatenated in order to provide Clock information to the receive side.

501 Note that Trigger signaling including Reset-Trigger is a generic messaging system. The Trigger commands
 502 do not impact the behavior of the PHY itself. Therefore, Triggers can be used for any purpose by the
 503 Protocol layer.

6.6.2 Low-Power Data Transmission

504 If the Escape mode Entry procedure is followed-up by the Entry Command for Low-Power Data
 505 Transmission (LPDT), Data can be communicated by the protocol at low speed, while the Lane remains in
 506 Low-Power mode.

507 Data shall be encoded on the lines with the same Spaced-One-Hot code as used for the Entry Commands.
 508 The data is self-clocked by the applied bit encoding and does not rely on the Clock Lane. The Lane can
 509 pause while using LPDT by maintaining a Space state on the Lines. A Stop state on the Lines stops LPDT,
 510 exits Escape mode, and switches the Lane to Control mode. The last phase before Stop state shall be a
 511 Mark-1 state, which does not represent a data-bit. Figure 19 shows a two-byte transmission with a pause
 512 period between the two bytes.



513

Figure 19 Two Data Byte Low-Power Data Transmission Example

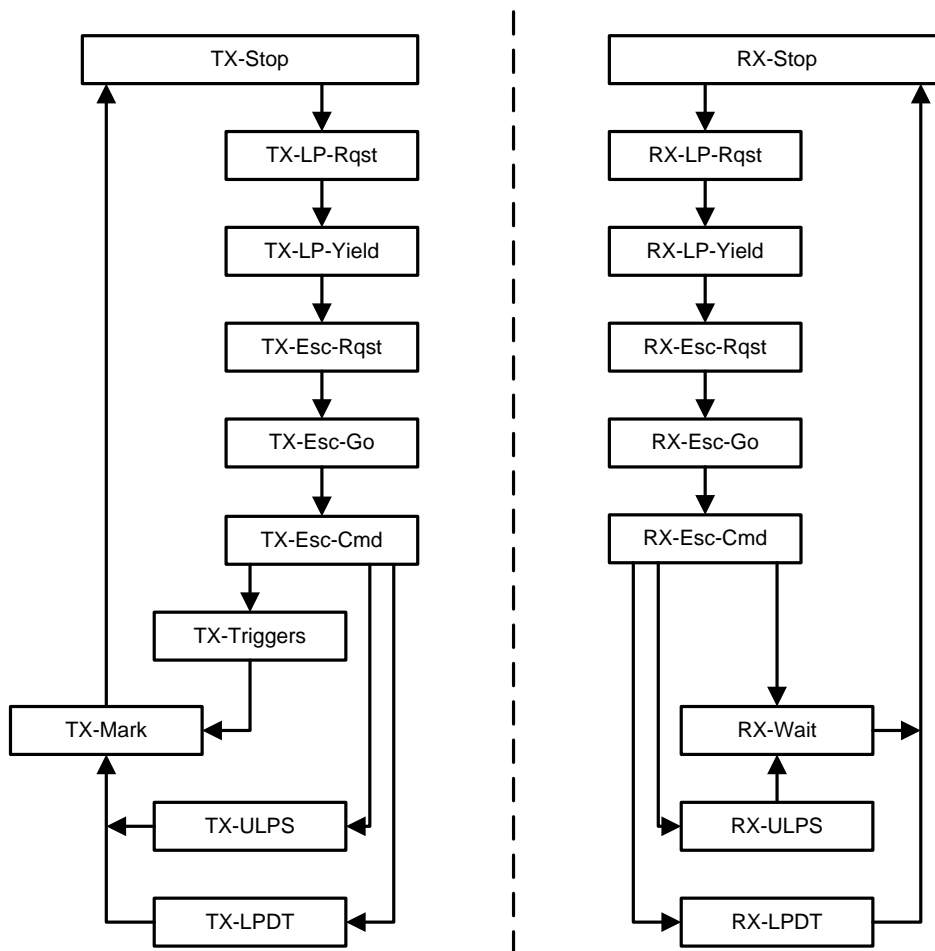
514 Using LPDT, a Low-Power (Bit) Clock signal ($f_{\text{MOMENTARY}} < 20\text{MHz}$) provided to the transmit side is used
 515 to transmit data. Data reception is self-timed by the bit encoding. Therefore, a variable clock rate can be
 516 allowed. At the end of LPDT the Lane shall return to the Stop state.

6.6.3 Ultra-Low Power State

517 If the Ultra-Low Power State Entry Command is sent after an Escape mode Entry command, the Lane shall
 518 enter the Ultra-Low Power State (ULPS). This command shall be flagged to the receive side Protocol.
 519 During this state, the Lines are in the Space state (LP-00). Ultra-Low Power State is exited by means of a
 520 Mark-1 state with a length T_{WAKEUP} followed by a Stop state. Annex A describes an example of an exit
 521 procedure and a procedure to control the length of time spent in the Mark-1 state.

6.6.4 Escape Mode State Machine

522 The state machine for Escape mode operation is shown in Figure 20 and described in Table 9.



Note: Horizontally aligned states occur simultaneously.

523

Figure 20 Escape Mode State Machine

524

Table 9 Escape Mode State Machine Description

State	Line Condition/State	Exit State	Exit Conditions
Any RX state	Any Received	RX-Stop	Observe LP-11 at Lines
TX-Stop	Transmit LP-11	TX-LP-Rqst	On request of Protocol for Esc mode (PPI)
TX-LP-Rqst	Transmit LP-10	TX-LP-Yield	After time T_{LPX}
TX-LP-Yield	Transmit LP-00	TX-Esc-Rqst	After time T_{LPX}
TX-Esc-Rqst	Transmit LP-01	TX-Esc-Go	After time T_{LPX}
TX-Esc-Go	Transmit LP-00	TX-Esc-Cmd	After time T_{LPX}
TX-Esc-Cmd	Transmit sequence of 8-bit (16-line-states) One-Spaced-Hot encoded Entry Command	TX-Triggers	After a Trigger Command
		TX-ULPS	After Ultra-Low Power Command
		TX-LPDT	After Low-Power Data Transmission Command

State	Line Condition/State	Exit State	Exit Conditions
TX-Triggers	Space state or optional dummy bytes for the purpose of generating clocks	TX-Mark	Exit of the Trigger State on request of Protocol (PPI)
TX-ULPS	Transmit LP-00	TX-Mark	End of ULP State on request of Protocol (PPI)
TX-LPDT	Transmit serialized, Spaced-One-Hot encoded payload data		After last transmitted data bit
TX-Mark	Mark-1	TX-Stop	Next driven state after time T_{LPX} , or T_{WAKEUP} if leaving ULP State
RX-Stop	Receive LP-11	RX-LP-Rqst	Line transition to LP-10
RX-LP-Rqst	Receive LP-10	RX-LP-Yield	Line transition to LP-00
RX-LP-Yield	Receive LP-00	RX-Esc-Rqst	Line transition to LP-01
RX-Esc-Rqst	Receive LP-01	RX-Esc-Go	Line transition to LP-00
RX-Esc-Go	Receive LP-00	RX-Esc-Cmd	Line transition out of LP-00
RX-Esc-Cmd	Receive sequence of 8-bit (16-line-states) One-Spaced-Hot encoded Entry Command	RX-Wait	After Trigger and Unrecognized Commands
		RX-ULPS	After Ultra-Low Power Command
		RX-LPDT	After Low-Power Data Transmission Command
RX-ULPS	Receive LP-00	RX-Wait	Line transition to LP-10
RX-LPDT	Receive serial, Spaced-One-Hot encoded payload data	RX-Stop	Line transition to LP-11 (Last state should be a Mark-1)
RX-Wait	Any, except LP-11	RX-Stop	Line transition to LP-11

Note:

During High-Speed data transmission, Stop states (TX-Stop, RX-Stop) have multiple valid exit states.

6.7 High-Speed Clock Transmission

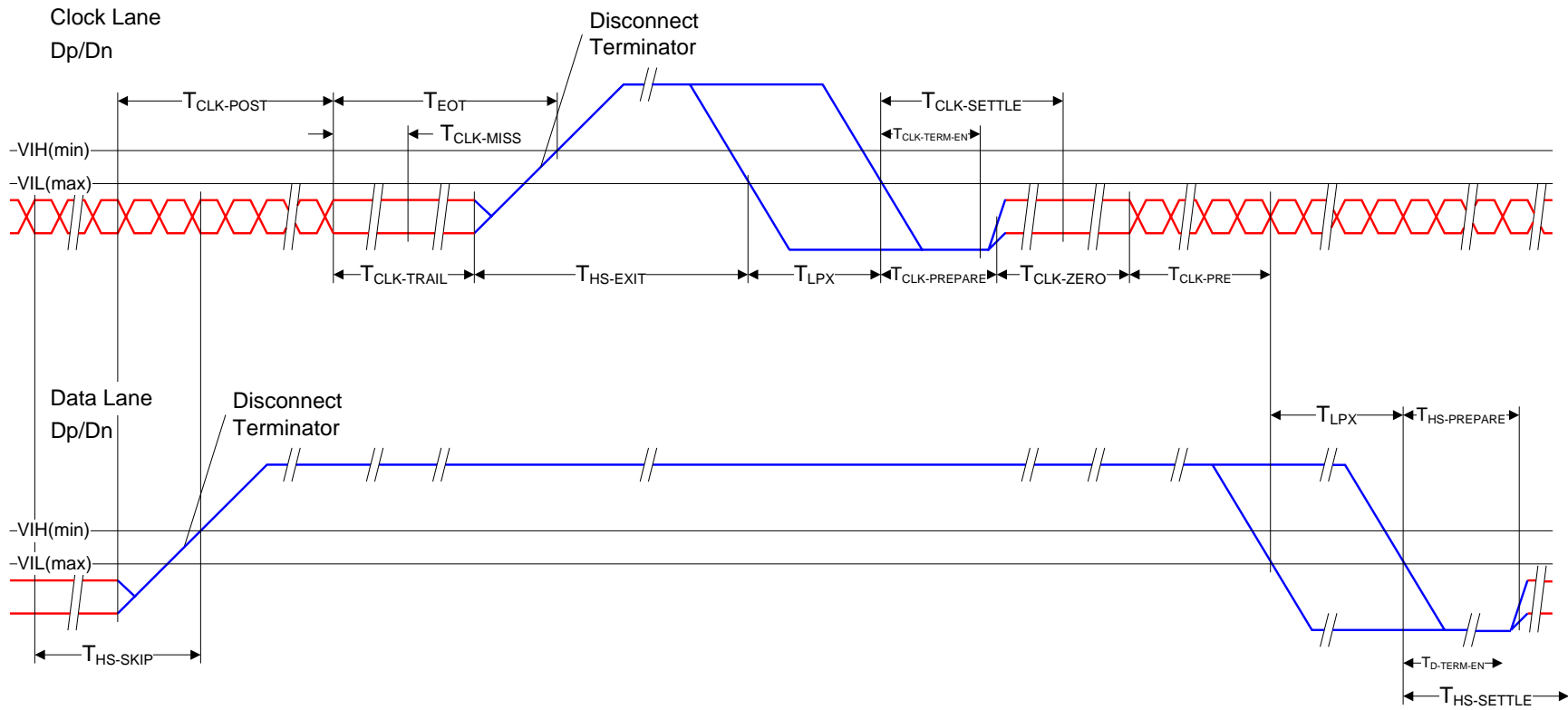
525 In High-Speed mode the Clock Lane provides a low-swing, differential DDR (half-rate) clock signal from
 526 Master to Slave for High-Speed Data Transmission. The Clock signal shall have quadrature-phase with
 527 respect to a toggling bit sequence on a Data Lane in the Forward direction and a rising edge in the center of
 528 the first transmitted bit of a burst. Details of the Data-Clock relationship and timing specifications can be
 529 found in Section 10.

530 A Clock Lane is similar to a Unidirectional Data Lane. However, there are some timing differences and a
 531 Clock Lane transmits a High-Speed DDR clock signal instead of data bits. Furthermore, the Low-Power
 532 mode functionality is defined differently for a Clock Lane than a Data Lane. A Clock Lane shall be
 533 unidirectional and shall not include regular Escape mode functionality. Only ULPS shall be supported via a
 534 special entry sequence using the LP-Rqst state. High-Speed Clock Transmission shall start from, and exit
 535 to, a Stop state.

536 The Clock Lane module is controlled by the Protocol via the Clock Lane PPI. The Protocol shall only stop
 537 the Clock Lane when there are no High-Speed transmissions active in any Data Lane.

538 The High-Speed Data Transmission start-up time of a Data Lane is extended if the Clock Lane is in Low-
539 Power mode. In that case the Clock Lane shall first return to High-Speed operation before the Transmit
540 Request can be handled.

541 The High-Speed Clock signal shall continue running for a period $T_{\text{CLK-POST}}$ after the last Data Lane switches
542 to Low-Power mode and ends with a HS-0 state. The procedure for switching the Clock Lane to Low-
543 Power mode is given in Table 10. Note the Clock Burst always contains an even number of transitions as it
544 starts and ends with a HS-0 state. This implies that the clock provides transitions to sample an even number
545 of bits on any associated Data Lanes. Clock periods shall be reliable and according to the HS timing
546 specifications. The procedure to return the Clock Lane to High-Speed Clock Transmission is given in Table
547 11. Both Clock Start and Stop procedures are shown in Figure 21.



548

Figure 21 Switching the Clock Lane between Clock Transmission and Low-Power Mode

549

Table 10 Procedure to Switch Clock Lane to Low-Power Mode

Master Side	Slave Side
Drives High-Speed Clock signal (Toggling HS-0/HS-1)	Receives High-Speed Clock signal (Toggling HS-0/HS-1)
Last Data Lane goes into Low-Power mode	
Continues to drives High-Speed Clock signal for a period $T_{CLK-POST}$ and ends with HS-0 state	
Drives HS-0 for a time $T_{CLK-TRAIL}$	Detects absence of Clock transitions within a time $T_{CLK-MISS}$, disables HS-RX then waits for a transition to the Stop state
Disables the HS-TX, enables LP-TX, and drives Stop state (LP-11) for a time $T_{HS-EXIT}$	
	Detects the Lines transitions to LP-11, disables HS termination, and enters Stop state

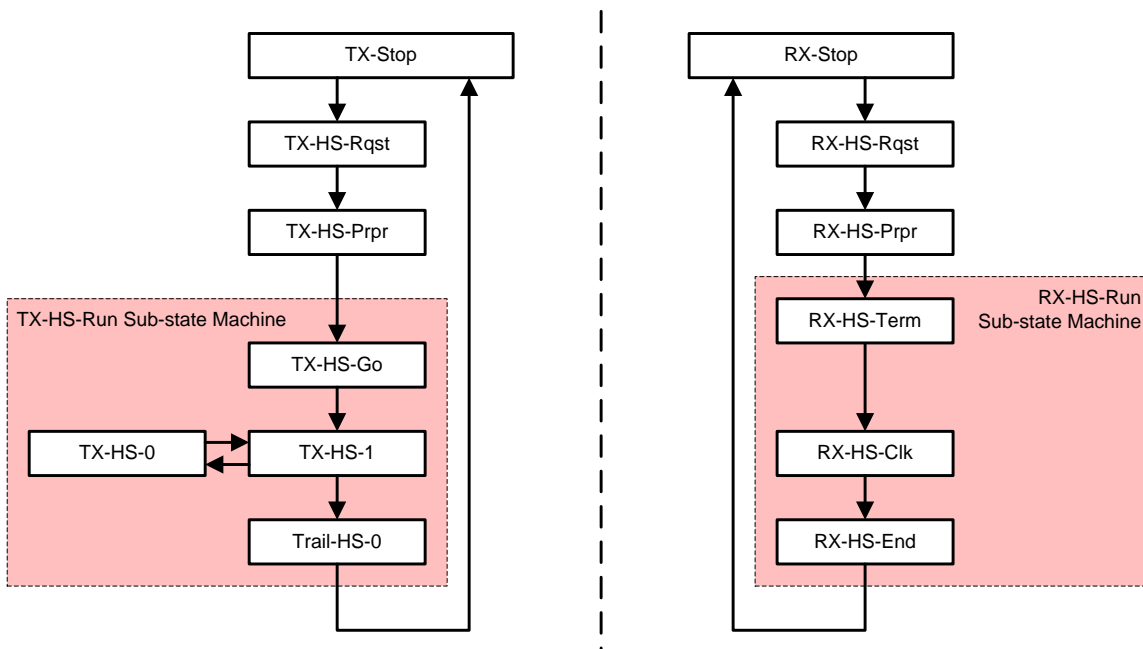
550

Table 11 Procedure to Initiate High-Speed Clock Transmission

TX Side	RX Side
Drives Stop state (LP-11)	Observes Stop state
Drives HS-Req state (LP-01) for time T_{LPX}	Observes transition from LP-11 to LP-01 on the Lines
Drives Bridge state (LP-00) for time $T_{CLK-PREPARE}$	Observes transition from LP-01 to LP-00 on the Lines. Enables Line Termination after time $T_{CLK-TERM-EN}$
Enables High-Speed driver and disables Low-Power drivers simultaneously. Drives HS-0 for a time $T_{CLK-ZERO}$.	Enables HS-RX and waits for timer $T_{CLK-SETTLE}$ to expire in order to neglect transition effects
	Receives HS-signal
Drives the High-Speed Clock signal for time period $T_{CLK-PRE}$ before any Data Lane starts up	Receives High-Speed Clock signal

551

The Clock Lane state machine is shown in Figure 22 and is described in Table 12.



Note: Horizontally aligned states occur simultaneously.

552

Figure 22 High-Speed Clock Transmission State Machine

553

Table 12 Description of High-Speed Clock Transmission State Machine

State	Line Condition/State	Exit State	Exit Conditions
TX-Stop	Transmit LP-11	TX-HS-Rqst	On request of Protocol for High-Speed Transmission
TX-HS-Rqst	Transmit LP-01	TX-HS-Prpr	End of timed interval T_{LTX}
TX-HS-Prpr	Transmit LP-00	TX-HS-Go	End of timed interval $T_{CLK-PREPARE}$
TX-HS-Go	Transmit HS-0	TX-HS-1	End of timed interval $T_{CLK-ZERO}$
TX-HS-0	Transmit HS-0	TX-HS-1	Send a HS-1 phase after a HS-0 phase: DDR Clock
TX-HS-1	Transmit HS-1	TX-HS-0	Send a HS-0 phase after a HS-1 phase: DDR Clock
		Trail-HS-0	On request to put Clock Lane in Low-Power
Trail-HS-0	Transmit HS-0	TX-Stop	End of timed interval $T_{CLK-TRAIL}$
RX-Stop	Receive LP-11	RX-HS-Rqst	Line transition to LP-01
RX-HS-Rqst	Receive LP-01	RX-HS-Prpr	Line transition to LP-00

State	Line Condition/State	Exit State	Exit Conditions
RX-HS-Prpr	Receive LP-00	RX-HS-Term	End of timed interval $T_{CLK-TERM-EN}$
RX-HS-Term	Receive LP-00	RX-HS-Clk	End of timed interval $T_{CLK-SETTLE}$
RX-HS-Clk	Receive DDR-Q Clock signal	RX-Clk-End	Time-out $T_{CLK-MISS}$ on the period on the Clock Lane without Clock signal transitions
RX-HS-End	Receive HS-0	RX-HS-Stop	Line transition to LP-11

Note:

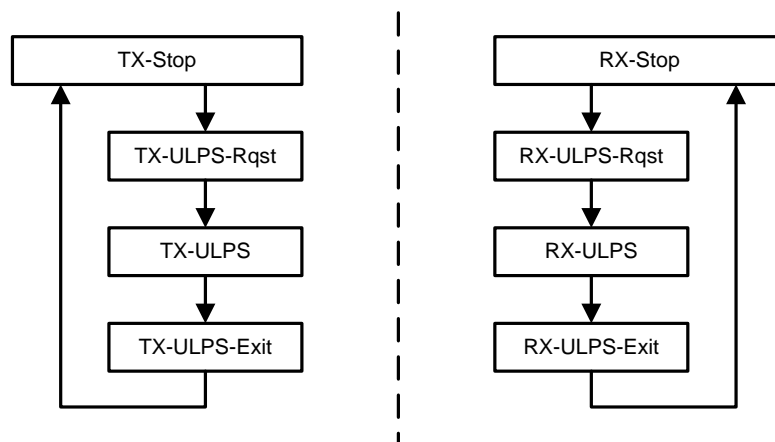
During High-Speed data transmission, Stop states (TX-Stop, RX-Stop) have multiple valid exit states.

6.8 Clock Lane Ultra-Low Power State

554 Although a Clock Lane does not include regular Escape mode, the Clock Lane shall support the Ultra-Low
555 Power State.

556 A Clock Lane shall enter Ultra-Low Power State via a Clock Lane Ultra-Low Power State Entry procedure.
557 In this procedure, starting from Stop state, the transmit side shall drive TX-ULPS-Rqst State (LP-10) and
558 then drive TX-ULPS State (LP-00). After this, the Clock Lane shall enter Ultra-Low Power State. If an
559 error occurs, and an LP-01 or LP-11 is detected immediately after the TX-ULPS-Rqst state, the Ultra-Low
560 Power State Entry procedure shall be aborted, and the receive side shall wait for, or return to, the Stop state,
561 respectively.

562 The receiving PHY shall flag the appearance of ULP State to the receive side Protocol. During this state the
563 Lines are in the ULP State (LP-00). Ultra-Low Power State is exited by means of a Mark-1 TX-ULPS-Exit
564 State with a length T_{WAKEUP} followed by a Stop State. Annex A describes an example of an exit procedure
565 that allows control of the length of time spent in the Mark-1 TX-ULPS-Exit State.



Note: Horizontally aligned states occur simultaneously.

Figure 23 Clock Lane Ultra-Low Power State State Machine

Table 13 Clock Lane Ultra-Low Power State State Machine Description

State	Line Condition/State	Exit State	Exit Conditions
TX-Stop	Transmit LP-11	TX-ULPS-Rqst	On request of Protocol for Ultra-Low Power State

State	Line Condition/State	Exit State	Exit Conditions
TX-ULPS-Rqst	Transmit LP-10	TX-ULPS	End of timed interval T_{LPX}
TX-ULPS	Transmit LP-00	TX-ULPS-Exit	On request of Protocol to leave Ultra-Low Power State
TX-ULPS-Exit	Transmit LP-10	TX-Stop	End of timed interval T_{WAKEUP}
RX-Stop	Receive LP-11	RX-ULPS-Rqst	Line transition to LP-10
RX-ULPS-Rqst	Receive LP-10	RX-ULPS	Line transition to LP-00
RX-ULPS	Receive LP-00	RX-ULPS-Exit	Line transition to LP-10
RX-ULPS-Exit	Receive LP-10	RX-Stop	Line transition to LP-11

Note:

During High-Speed data transmission, Stop states (TX-Stop, RX-Stop) have multiple valid exit states.

6.9 Global Operation Timing Parameters

- 568 Table 14 lists the ranges for all timing parameters used in this section. The values in the table assume a UI
569 variation in the range defined by ΔUI (see Table 29).
- 570 Transmitters shall support all transmitter-specific timing parameters defined in Table 14.
- 571 Receivers shall support all Receiver-specific timing parameters in defined in Table 14.
- 572 Also note that while corresponding receiver tolerances are not defined for every transmitter-specific
573 parameter, receivers shall also support reception of all allowed conformant values for all transmitter-
574 specific timing parameters in Table 14 for all HS UI values up to, and including, the maximum supported
575 HS clock rate specified in the receiver's datasheet.

576

Table 14 Global Operation Timing Parameters

Parameter	Description	Min	Typ	Max	Unit	Notes
T _{CLK-MISS}	Timeout for receiver to detect absence of Clock transitions and disable the Clock Lane HS-RX.			60	ns	1, 6
T _{CLK-POST}	Time that the transmitter continues to send HS clock after the last associated Data Lane has transitioned to LP Mode. Interval is defined as the period from the end of T _{HS-TRAIL} to the beginning of T _{CLK-TRAIL} .	60 ns + 52*UI			ns	5
T _{CLK-PRE}	Time that the HS clock shall be driven by the transmitter prior to any associated Data Lane beginning the transition from LP to HS mode.	8			UI	5
T _{CLK-PREPARE}	Time that the transmitter drives the Clock Lane LP-00 Line state immediately before the HS-0 Line state starting the HS transmission.	38		95	ns	5
T _{CLK-SETTLE}	Time interval during which the HS receiver should ignore any Clock Lane HS transitions, starting from the beginning of T _{CLK-PREPARE} .	95		300	ns	6, 7
T _{CLK-TERM-EN}	Time for the Clock Lane receiver to enable the HS line termination, starting from the time point when Dn crosses V _{IL,MAX} .	Time for Dn to reach V _{TERM-EN}		38	ns	6
T _{CLK-TRAIL}	Time that the transmitter drives the HS-0 state after the last payload clock bit of a HS transmission burst.	60			ns	5
T _{CLK-PREPARE} + T _{CLK-ZERO}	T _{CLK-PREPARE} + time that the transmitter drives the HS-0 state prior to starting the Clock.	300			ns	5
T _{D-TERM-EN}	Time for the Data Lane receiver to enable the HS line termination, starting from the time point when Dn crosses V _{IL,MAX} .	Time for Dn to reach V _{TERM-EN}		35 ns + 4*UI		6
T _{EOT}	Transmitted time interval from the start of T _{HS-TRAIL} OR T _{CLK-TRAIL} , to the start of the LP-11 state following a HS burst.			105 ns + n*12*UI		3, 5
T _{HS-EXIT}	Time that the transmitter drives LP-11 following a HS burst.	100			ns	5

Parameter	Description	Min	Typ	Max	Unit	Notes
$T_{HS-PREPARE}$	Time that the transmitter drives the Data Lane LP-00 Line state immediately before the HS-0 Line state starting the HS transmission	$40 \text{ ns} + 4*UI$		$85 \text{ ns} + 6*UI$	ns	5
$T_{HS-PREPARE} + T_{HS-ZERO}$	$T_{HS-PREPARE}$ + time that the transmitter drives the HS-0 state prior to transmitting the Sync sequence.	$145 \text{ ns} + 10*UI$			ns	5
$T_{HS-SETTLE}$	Time interval during which the HS receiver shall ignore any Data Lane HS transitions, starting from the beginning of $T_{HS-PREPARE}$. The HS receiver shall ignore any Data Lane transitions before the minimum value, and the HS receiver shall respond to any Data Lane transitions after the maximum value.	$85 \text{ ns} + 6*UI$		$145 \text{ ns} + 10*UI$	ns	6
$T_{HS-SKIP}$	Time interval during which the HS-RX should ignore any transitions on the Data Lane, following a HS burst. The end point of the interval is defined as the beginning of the LP-11 state following the HS burst.	40		$55 \text{ ns} + 4*UI$	ns	6
$T_{HS-TRAIL}$	Time that the transmitter drives the flipped differential state after last payload data bit of a HS transmission burst	$\max(n*8*UI, 60 \text{ ns} + n*4*UI)$			ns	2, 3, 5
T_{INIT}	See Section 6.11.	100			μs	5
T_{LPX}	Transmitted length of any Low-Power state period	50			ns	4, 5
Ratio T_{LPX}	Ratio of $T_{LPX(MASTER)}/T_{LPX(SLAVE)}$ between Master and Slave side	2/3		3/2		
T_{TA-GET}	Time that the new transmitter drives the Bridge state (LP-00) after accepting control during a Link Turnaround.	$5*T_{LPX}$			ns	5
T_{TA-GO}	Time that the transmitter drives the Bridge state (LP-00) before releasing control during a Link Turnaround.	$4*T_{LPX}$			ns	5
$T_{TA-SURE}$	Time that the new transmitter waits after the LP-10 state before transmitting the Bridge state (LP-00) during a Link Turnaround.	T_{LPX}		$2*T_{LPX}$	ns	5
T_{WAKEUP}	Time that a transmitter drives a Mark-1 state prior to a Stop state in order to initiate an exit from ULPS.	1			ms	5

Note:

1. The minimum value depends on the bit rate. Implementations should ensure proper operation for all the supported bit rates.
2. If $a > b$ then $\max(a, b) = a$ otherwise $\max(a, b) = b$.

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3. *Where $n = 1$ for Forward-direction HS mode and $n = 4$ for Reverse-direction HS mode.*
4. *T_{LPX} is an internal state machine timing reference. Externally measured values may differ slightly from the specified values due to asymmetrical rise and fall times.*
5. *Transmitter-specific parameter.*
6. *Receiver-specific parameter.*
7. *The stated values are considered informative guidelines rather than normative requirements since this parameter is untestable in typical applications.*

6.10 System Power States

577 Each Lane within a PHY configuration, that is powered and enabled, has potentially three different power
578 consumption levels: High-Speed Transmission mode, Low-Power mode and Ultra-Low Power State. For
579 details on Ultra-Low Power State see Section 6.6.3 and Section 6.8. The transition between these modes
580 shall be handled by the PHY.

6.11 Initialization

581 After power-up, the Slave side PHY shall be initialized when the Master PHY drives a Stop State (LP-11)
582 for a period longer than T_{INIT} . The first Stop state longer than the specified T_{INIT} is called the Initialization
583 period. The Master PHY itself shall be initialized by a system or Protocol input signal (PPI). The Master
584 side shall ensure that a Stop State longer than T_{INIT} does not occur on the Lines before the Master is
585 initialized. The Slave side shall ignore all Line states during an interval of unspecified length prior to the
586 Initialization period. In multi-Lane configurations, all Lanes shall be initialized simultaneously.

587 Note that T_{INIT} is considered a protocol-dependent parameter, and thus the exact requirements for
588 $T_{INIT,MASTER}$ and $T_{INIT,SLAVE}$ (transmitter and receiver initialization Stop state lengths, respectively,) are
589 defined by the protocol layer specification and are outside the scope of this document. However, the D-
590 PHY specification does place a minimum bound on the lengths of $T_{INIT,MASTER}$ and $T_{INIT,SLAVE}$, which each
591 shall be no less than 100 μ s. A protocol layer specification using the D-PHY specification may specify any
592 values greater than this limit, for example, $T_{INIT,MASTER} \geq 1$ ms and $T_{INIT,SLAVE} = 500$ to 800 μ s.

593

Table 15 Initialization States

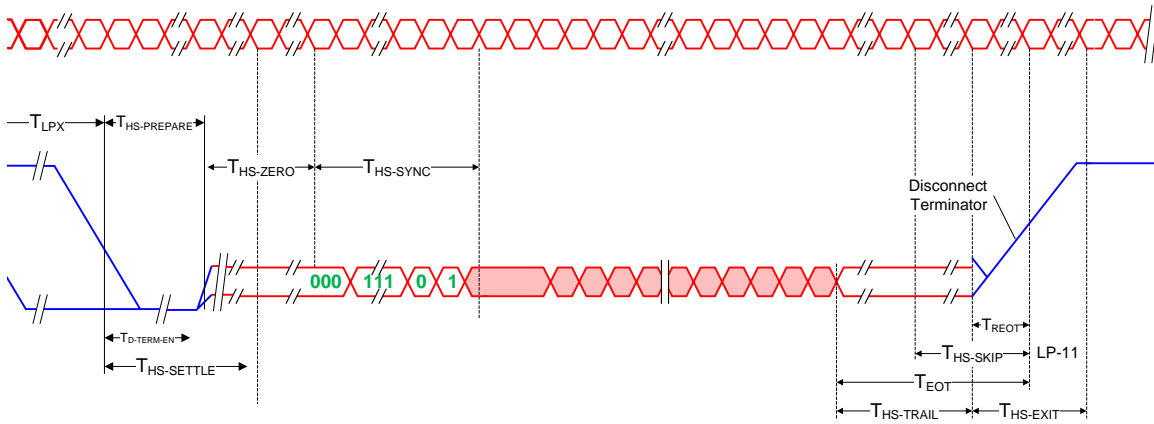
State	Entry Conditions	Exit State	Exit Conditions	Line Levels
Master Off	Power-down	Master Initialization	Power-up	Any LP level except Stop States for periods >100us
Master Init	Power-up or Protocol request	TX-Stop	A First Stop state for a period longer than $T_{INIT,MASTER}$ as specified by the Protocol	Any LP signaling sequence that ends with a long Initialization Stop state
Slave Off	Power-down	Any LP state	Power-up	Any
Slave Init	Power-up or Protocol request	RX-Stop	Observe Stop state at the inputs for a period $T_{INIT,SLAVE}$ as specified by the Protocol	Any LP signaling sequence which ends with the first long Initialization Stop period

6.12 Calibration

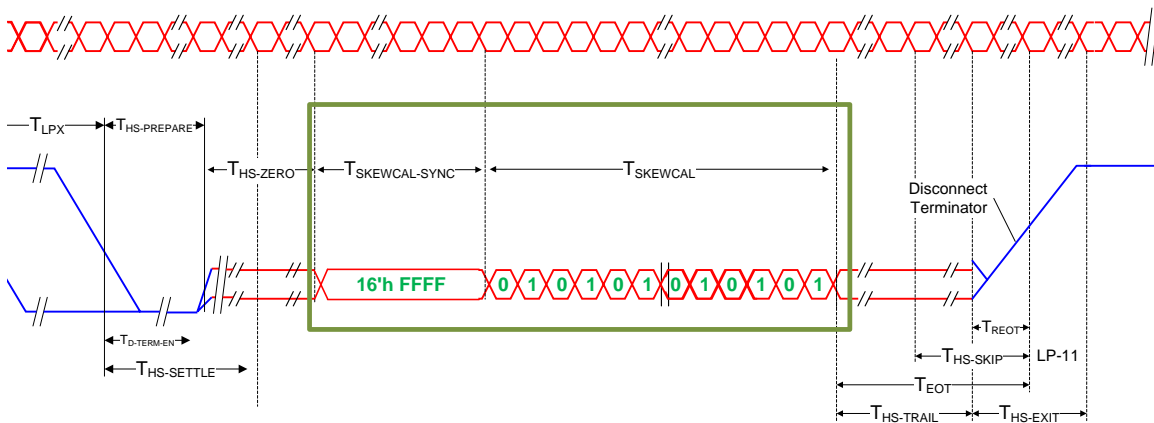
594 Receiver deskew shall be initiated by the transmitter for the DUT's supporting > 1.5 Gbps. The transmitter
595 shall send a special deskew burst, as shown in Figure 24. When operating above 1.5 Gbps or changing to
596 any rate above 1.5 Gbps, an initial deskew sequence shall be transmitted before High-Speed Data
597 Transmission in normal operation. When operating at or below 1.5 Gbps, the transmission of the initial
598 deskew sequence is optional. Periodic deskew is optional irrespective of data rate.

599 When changing states, for example from ULPS to HS, transmission of any deskew sequence is optional,
600 provided HS operation resumes at a rate for which an initial deskew sequence has previously been
601 transmitted.

High-Speed Data Transmission in Normal Mode



High-Speed Skew Calibration



609
610

Figure 26 Normal Mode vs Skew Calibration (Zoom-In)

611 The receiver shall detect the deskew sync pattern and initiate deskew calibration upon detection. The
612 transmitter deskew sequence transmission shall be initiated under the transmitter configuration control. The
613 start-of-transmission sequence is described in Table 16, and the end-of-transmission sequence is described
614 in Table 17.

615

Table 16 Start-of-Skew Calibration Sequence

TX Side	RX Side
Drives stop state (LP-11)	Observes stop state
Drives HS-Rqst state (LP-01) for time T_{LPX}	Observes transition from LP-11 to LP-01 on the lines
Drives bridge state (LP-00) for time $T_{HS-PREPARE}$	Observes transition from LP-01 to LP-00 on the lines, and enables line termination after time

	T _{D-TERMEN}
Simultaneously enables high-speed driver and disables low-power drivers	
Drives HS-0 for a time T _{HS-ZERO}	Enables HS-RX and waits for timer T _{HS-SETTLE} to expire in order to neglect transition effects
	Starts looking for leader sequence
Inserts the high-speed sync sequence for high-speed skew-calibration: '11111111_11111111' beginning on a rising clock edge	
	Synchronizes upon recognition of leader sequence: '1111_1111'
Continues to transmit high speed data that is the same as the clock lane: '01010101'	
	Receives '01010101' data
	Performs high-speed skew-calibration between clock and data lanes
	Finishes high-speed skew-calibration between clock and data lanes

616

617

Table 17 End-of-Skew Calibration Sequence

TX Side	RX Side
Completes transmission of '01010101' data	Receives '01010101' data
Toggles differential state immediately after last payload data bit and holds that state for a time T _{HS-TRAIL}	
Disables the HS-TX, enables the LP-TX, and drives the stop state (LP-11) for a time T _{HS-EXIT}	Detects the lines leaving LP-00 state and entering the stop state (LP-11), and disables termination
	Neglects bits of last period T _{HS-SKIP} to hide transition effects
	Detects last transition of valid data, determines last valid data byte and skip trailer sequence
	Starts looking for leader sequence

Note:

During skew calibration time, high-speed skew calibration on the RX side has to finish. The TX side is not aware of the RX side completing calibration.

618

The T_{SKEWCAL} maximum is 100 μsec at initial calibration and 10 μsec maximum for periodic calibration.

619

The timing parameters are shown in Table 18.

620

Table 18 Skew-Calibration Timing Parameters

Parameter	Description	Min	Typ	Max	Unit	Notes
T _{SKEWCAL_SYNC}	Time that the transmitter drives the skew-calibration sync pattern, FFFF _H		16		UI	
T _{SKEWCAL}	Time that the transmitter drives the skew-calibration pattern in the initial skew-calibration mode			100	μs	
		2 ¹⁵			UI	
T _{SKEWCAL}	Time that the transmitter drives the skew-			10	μs	

	calibration pattern in the periodic skew-calibration mode	2 ¹⁰			UI	
--	---	-----------------	--	--	----	--

621 For periodic deskew calibration, the transmitter shall finish the current burst before sending a deskew
622 sequence.

6.13 Global Operation Flow Diagram

623 All previously described aspects of operation, either including or excluding optional parts, are contained in
624 Lane Modules. Figure 27 shows the operational flow diagram for a Data Lane Module. Within both TX and
625 RX four main processes can be distinguished: High-Speed Transmission, Escape mode, Turnaround, and
626 Initialization.

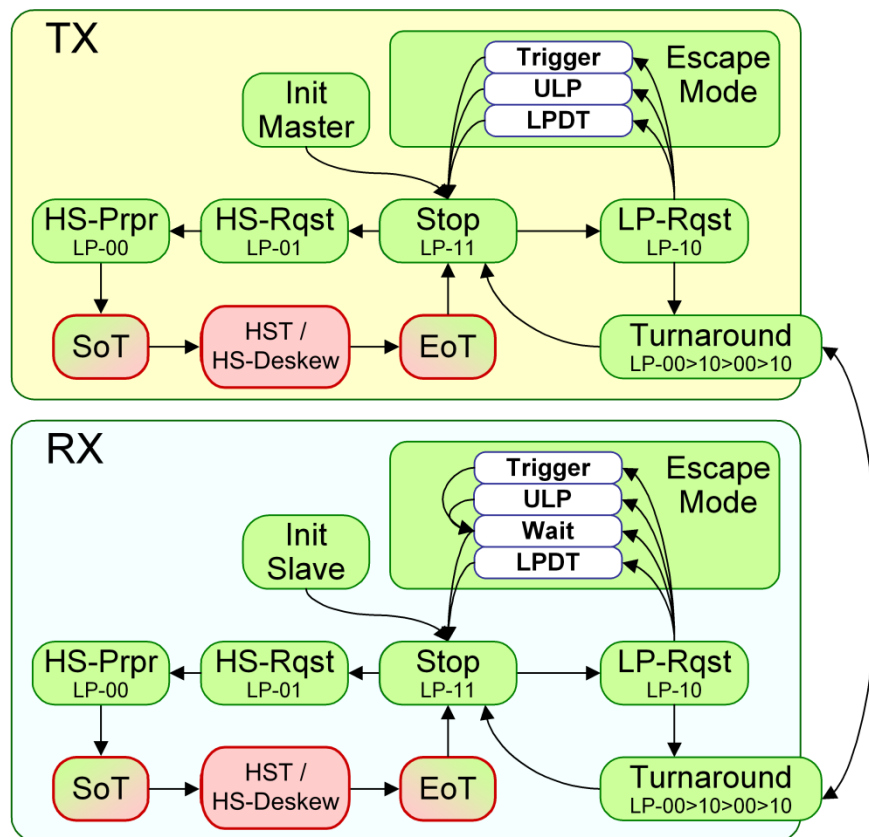
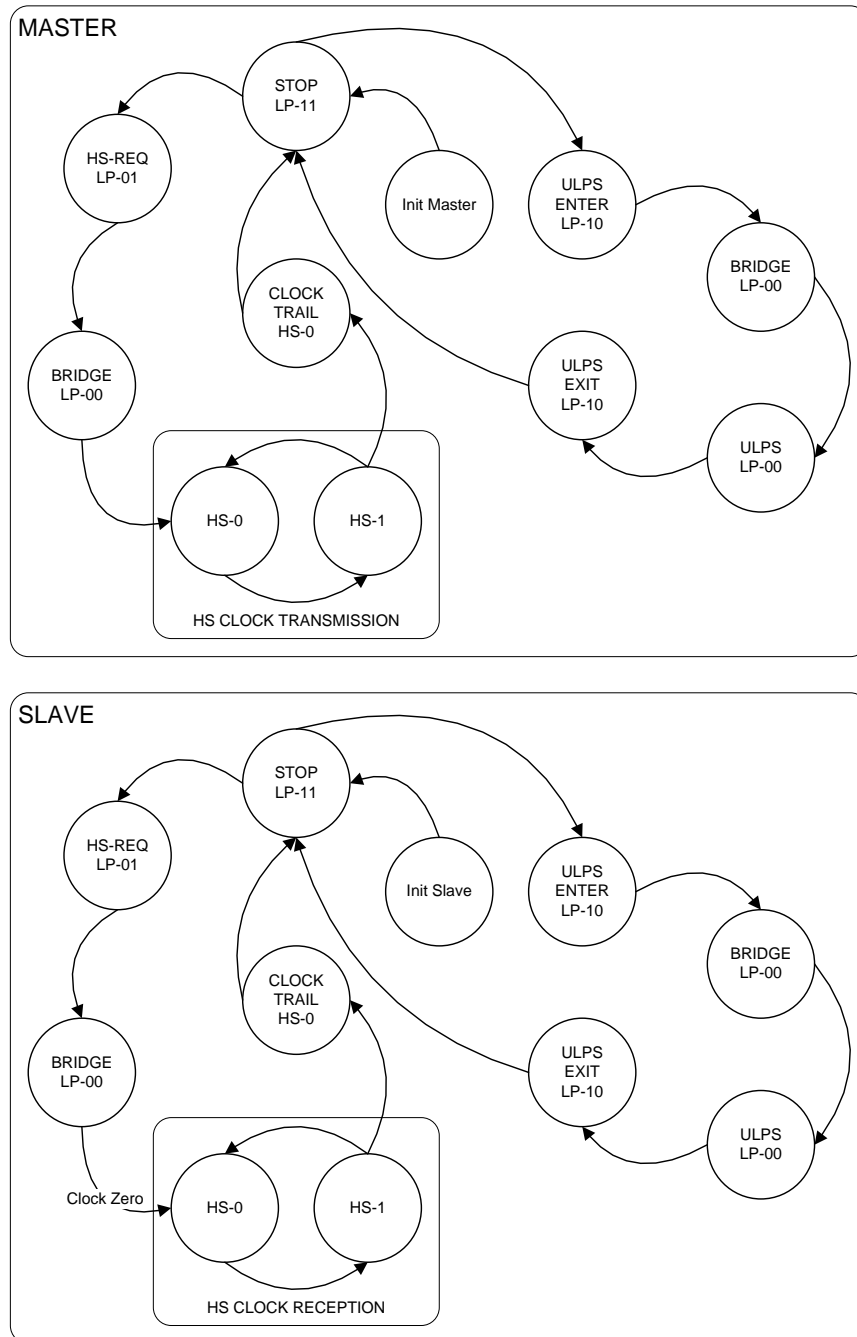


Figure 27 Data Lane Module State Diagram

628 Figure 28 shows the state diagram for a Clock Lane Module. The Clock Lane Module has four major
629 operational states: Init (of unspecified duration), Low-Power Stop state, Ultra-Low Power state, and High-
630 Speed clock transmission. The figure also shows the transition states as described previously.



631

Figure 28 Clock Lane Module State Diagram

6.14 Data Rate Dependent Parameters (informative)

632 The high speed data transfer rate of the D-PHY may be programmable to values determined by a particular
 633 implementation. Any individual data transfer between SoT and EoT sequences must take place at a given,
 634 fixed rate. However, reprogramming the data rate of the D-PHY high speed transfer is allowed at
 635 initialization, before starting the exit from ULP state or in Stop state whenever the HS clock is not running.
 636 The method of data rate reprogramming is out of the scope of this document.

637 Many time parameter values in this document are specified as the sum of a fixed time and a particular
638 number of High-Speed UIs. The parameters may need to be recomputed if the data rate, and therefore the
639 UI value, is changed. These parameters, with their allowed values, are listed in Table 14. For clarity, the
640 parameter names and purposes are repeated here.

6.14.1 Parameters Containing Only UI Values

641 $T_{\text{CLK-PRE}}$ is the minimum number of High-Speed clock cycles the Master must send over the Clock Lane
642 after it is restarted in HS mode and before any data transmission may begin. If a particular protocol at the
643 Slave side requires more clock cycles than $T_{\text{CLK-PRE}}$, the Master side protocol should ensure that these are
644 transmitted.

6.14.2 Parameters Containing Time and UI values

645 Several parameters are specified as the sum of an explicit time and a number of UI. The explicit time
646 values, in general, are derived from the time needed to charge and discharge the interconnect to its specified
647 values given the specified drive voltages and line termination values. As such, the explicit time values are
648 not data rate dependent. It is conceivable to use the sum of an analog timer and a HS clock counter to
649 ensure the implementation satisfies these parameters. If these explicit time values are implemented by
650 counting HS clock cycles only, the count value is a function of the data rate and, therefore, must be changed
651 when the data rate is changed.

652 $T_{\text{D-TERM-EN}}$ is the time to enable Data Lane receiver line termination measured from when Dn crosses
653 $V_{\text{IL,MAX}}$.

654 $T_{\text{HS-PREPARE}}$, is the time to drive LP-00 before starting the HS transmission on a Data Lane.

655 $T_{\text{HS-PREPARE}} + T_{\text{HS-ZERO,MIN}}$ is the sum of the time to drive LP-00 in preparation for the start of HS
656 transmission plus the time to send HS-0, i.e. turn on the line termination and drive the interconnect with the
657 HS driver, prior to sending the SoT Sync sequence.

658 $T_{\text{HS-TRAIL}}$ is the time the transmitter must drive the flipped last data bit after sending the last payload data bit
659 of a HS transmission burst. This time is required by the receiver to determine EoT.

660 $T_{\text{HS-SKIP}}$ is the time the receiver must “back up” and skip data to ignore the transition period of the EoT
661 sequence.

662 $T_{\text{CLK-POST,MIN}}$ is the minimum time that the transmitter continues sending HS clocks after the last Data Lane
663 has transitioned to LP mode following a HS transmission burst. If a particular receiver implementation
664 requires more clock cycles than $T_{\text{CLK-POST,MIN}}$ to finish reception, the transmitter must supply sufficient
665 clocks to accomplish the reception.

6.14.3 Parameters Containing Only Time Values

666 Several parameters are specified only as explicit time values. As in Section 6.14.2, these explicit time
667 values are typically derived from the time needed to charge and discharge the interconnect and are,
668 therefore, not data rate dependent. It is conceivable to use an analog timer or a HS clock counter to ensure
669 the implementation satisfies these parameters. However, if these time values are implemented by counting
670 HS clock cycles only, the count value is a function of the data rate and, therefore, must be changed when
671 the data rate is changed.

672 The following parameters are based on time values alone:

- 673 • $T_{\text{HS-SKIP,MIN}}$
- 674 • $T_{\text{CLK-MISS,MAX}}$
- 675 • $T_{\text{CLK-TRAIL,MIN}}$
- 676 • $T_{\text{CLK-TERM-EN}}$
- 677 • $T_{\text{CLK-PREPARE}}$

6.14.4 Parameters Containing Only Time Values That Are Not Data Rate Dependent

678 The remaining parameters in Table 14 shall be complied with even when the High-Speed clock is off. These
679 parameters include Low-Power and initialization state durations and LP signaling intervals. Though these
680 parameters are not HS data rate dependent, some implementations of D-PHY may need to adjust these
681 values when the data rate is changed.

7 Fault Detection

682 There are three different mechanisms to detect malfunctioning of the Link. Bus contention and error
683 detection functions are contained within the D-PHY. These functions should detect many typical faults.
684 However, some faults cannot be detected within the D-PHY and require a protocol-level solution.
685 Therefore, the third detection mechanism is a set of application specific watchdog timers.

7.1 Contention Detection

686 If a bi-directional Lane Module and a Unidirectional Module are combined in one Lane, only unidirectional
687 functionality is available. Because in this case the additional functionality of one bi-directional PHY
688 Module cannot be reliably controlled from the limited functionality PHY side, the bi-directional features of
689 the bi-directional Module shall be safely disabled. Otherwise in some cases deadlock may occur which can
690 only be resolved with a system power-down and re-initialization procedure.

691 During normal operation one and only one side of a Link shall drive a Lane at any given time except for
692 certain transition periods. Due to errors or system malfunction a Lane may end up in an undesirable state,
693 where the Lane is driven from two sides or not driven at all. This condition eventually results in a state
694 conflict and is called Contention.

695 All Lane Modules with LP bi-directionality shall include contention detection functions to detect the
696 following contention conditions:

- 697 • Modules on both sides of the same line drive opposite LP levels against each other. In this case,
698 the line voltage will settle to some value between $V_{OL,MIN}$ and $V_{OH,MAX}$. Because V_{IL} is greater than
699 V_{IHCD} , the settled value will always be either higher than V_{IHCD} , lower than V_{IL} , or both. Refer to
700 Section 8. This ensures that at least one side of the link, possibly both, will detect the fault
701 condition.
- 702 • The Module at one side drives LP-high while the other side drives HS-low on the same Line. In
703 this case, the line voltage will settle to a value lower than V_{IL} . The contention shall be detected at
704 the side that is transmitting the LP-high.

705 The first condition can be detected by the combination of LP-CD and LP-RX functions. The LP-RX
706 function should be able to detect the second contention condition. Details on the LP-CD and LP-RX
707 electrical specifications can be found in Section 9. Except when the previous state was TX-ULPS,
708 contention shall be checked before the transition to a new state. Contention detection in ULPS is not
709 required because the bit period is not defined and a clock might not be available.

710 After contention has been detected, the Protocol shall take proper measures to resolve the situation.

7.2 Sequence Error Detection

711 If for any reason the Lane signal is corrupted the receiving PHY may detect signal sequence errors. Errors
712 detected inside the PHY may be communicated to the Protocol via the PPI. This kind of error detection is
713 optional, but strongly recommended as it enhances reliability. The following sequence errors can be
714 distinguished:

- 715 • SoT Error
- 716 • SoT Sync Error
- 717 • EoT Sync Error
- 718 • Escape Entry Command Error
- 719 • LP Transmission Sync Error
- 720 • False Control Error

7.2.1 SoT Error

721 The Leader sequence for Start of High-Speed Transmission is fault tolerant for any single-bit error and
722 some multi-bit errors. Therefore, the synchronization may be usable, but confidence in the payload data is
723 lower. If this situation occurs an SoT Error is indicated.

7.2.2 SoT Sync Error

724 If the SoT Leader sequence is corrupted in a way that proper synchronization cannot be expected, a SoT
725 Sync Error is indicated.

7.2.3 EoT Sync Error

726 The EoT Sync Error is indicated when the last bit of a transmission does not match a byte boundary. This
727 error can only be indicated in case of EoT processing on detection of LP-11.

7.2.4 Escape Mode Entry Command Error

728 If the receiving Lane Module does not recognize the received Entry Command for Escape mode an Escape
729 mode Entry Command Error is indicated.

7.2.5 LP Transmission Sync Error

730 At the end of a Low-Power Data transmission procedure, if data is not synchronized to a Byte boundary an
731 Escape Sync Error signal is indicated.

7.2.6 False Control Error

732 If a LP-Rqst (LP-10) is not followed by the remainder of a valid Escape or Turnaround sequence, a False
733 Control Error is indicated. This error is also indicated if a HS-Rqst (LP-01) is not correctly followed by a
734 Bridge State (LP-00).

7.3 Protocol Watchdog Timers (informative)

735 It is not possible for the PHY to detect all fault cases. Therefore, additional protocol-level time-out
736 mechanisms are necessary in order to limit the maximum duration of certain modes and states.

7.3.1 HS RX Timeout

737 In HS RX mode if no EoT is received within a certain period the protocol should time-out. The timeout
738 period can be protocol specific.

7.3.2 HS TX Timeout

739 The maximum transmission length in HS TX is bounded. The timeout period is protocol specific.

7.3.3 Escape Mode Timeout

740 A device may timeout during Escape mode. The timeout should be greater than the Escape mode Silence
741 Limit of the other device. The timeout period is protocol specific.

7.3.4 Escape Mode Silence Timeout

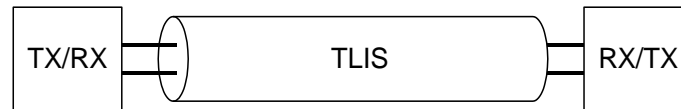
742 A device may have a bounded length for LP TX-00 during Escape mode, after which the other device may
743 timeout. The timeout period is protocol specific. For example, a display module should have an Escape
744 mode Silence Limit, after which the host processor can timeout.

7.3.5 Turnaround Errors

745 A Turnaround procedure always starts from a Stop State. The procedure begins with a sequence of Low-
746 Power States ending with a Bridge State (LP-00) during which drive sides are swapped. The procedure is
747 finalized by the response including a Turn State followed by a Stop State driven from the other side. If the
748 actual sequence of events violates the normal Turnaround procedure a "False Control Error" may be
749 flagged to the Protocol. See Section 7.2.6. The Turn State response serves as an acknowledgement for the
750 correctly completed Turnaround procedure. If no acknowledgement is observed within a certain time period
751 the Protocol should time-out and take appropriate action. This period should be larger than the maximum
752 possible Turnaround time for a particular system. There is no time-out for this condition in the PHY.

8 Interconnect and Lane Configuration

753 The interconnect between transmitter and receiver carries all signals used in D-PHY communication. This
754 includes both high speed, low voltage signaling I/O technology and low speed, low power signaling for
755 control functions. For this reason, the physical connection shall be implemented by means of balanced,
756 differential, point-to-point transmission lines referenced to ground. The total interconnect may consist of
757 several cascaded transmission line segments, such as, printed circuit boards, flex-foils, and cable
758 connections.



759

Figure 29 Point-to-point Interconnect

8.1 Lane Configuration

760 The complete physical connection of a Lane consists of a transmitter (TX), and/or receiver (RX) at each
761 side, with some Transmission-Line-Interconnect-Structure (TLIS) in between. The overall Lane
762 performance is therefore determined by the combination of these three elements. The split between these
763 elements is defined to be on the module (IC) pins. This section defines both the required performance of the
764 Transmission-Line-Interconnect-Structure for the signal routing as well as the I/O-cell Reflection properties
765 of TX and RX. This way the correct overall operation of the Lane can be ensured.

766 With respect to physical dimensions, the Transmission-Line-Interconnect-Structure will typically be the
767 largest part. Besides printed circuit board and flex-foil traces, this may also include elements such as vias
768 and connectors.

8.2 Boundary Conditions

769 The reference characteristic impedance level is 100 Ohm differential, 50 Ohm single-ended per Line, and
770 25 Ohm common-mode for both Lines together. The 50 Ohm impedance level for single-ended operation is
771 also convenient for test and characterization purposes.

772 This typical impedance level is required for all three parts of the Lane: TX, TLIS, and RX. The tolerances
773 for characteristic impedances of the interconnect and the tolerance on line termination impedances for TX
774 and RX are specified by means of S-parameter templates over the whole operating frequency range.

775 The differential channel is also used for LP single-ended signaling. Therefore, it is strongly recommended
776 to apply only very loosely coupled differential transmission lines.

777 The flight time for signals across the interconnect shall not exceed two nanoseconds.

8.3 Definitions

778 The frequency 'f_h' is the highest fundamental frequency for data transmission and is equal to
779 $1/(2 \cdot U_{INST,MIN})$. Implementers shall specify a value $U_{INST,MIN}$ that represents the minimum instantaneous
780 UI possible within a high speed data transfer for a given implementation.

781 The frequency 'f_{h,MAX}' is a device specification and indicates the maximum supported f_h for a particular
782 device.

783 The frequency 'f_{LP,MAX}' is the maximum toggle frequency for Low-Power mode.

784 RF interference frequencies are denoted by 'f_{INT}', where f_{INT,MIN} defines the lower bound for the band of
785 relevant RF interferers.

786 The frequency f_{MAX} for devices supporting data rates up to 1.5 Gbps is defined by the maximum of
 787 $(1/5t_{F,MIN}, 1/5t_{R,MIN})$, where t_R and t_F are the rise and fall times of the High-Speed signaling. For devices
 788 supporting data rates of more than 1.5 Gbps, f_{MAX} is $3/4 * \text{data rate}$.

8.4 S-parameter Specifications

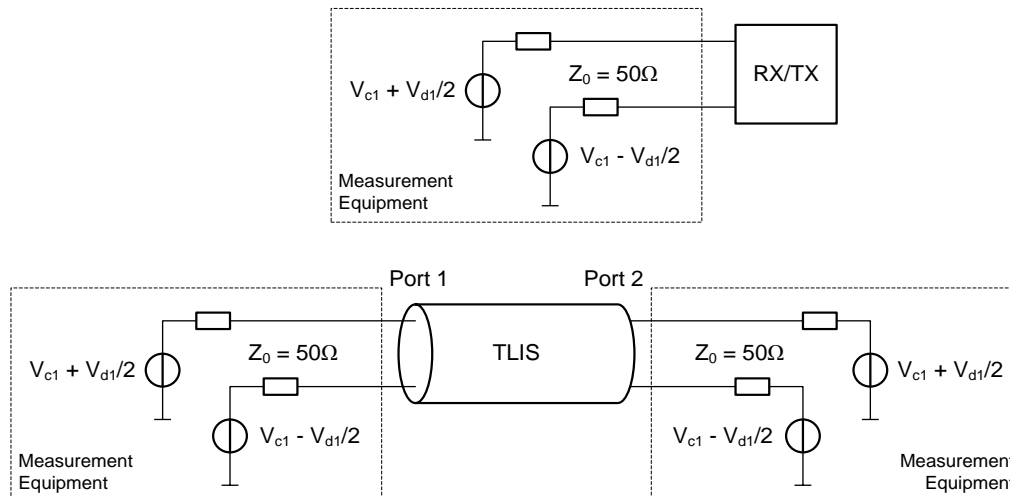
789 The required performance of the physical connection is specified by means of S-parameter requirements for
 790 TX, TLIS, and RX, for TLIS by mixed-mode, 4-port parameters, and for RX and TX by mixed-mode,
 791 reflection (return loss) parameters. The S-parameter limits are defined over the whole operating frequency
 792 range by means of templates.

793 The differential transmission properties are most relevant and therefore this specification uses mixed-mode
 794 parameters. As the performance needs depend on the targeted bit rates, most S-parameter requirements are
 795 specified on a normalized frequency axis with respect to bit rate. Only the parameters that are important for
 796 the suppression of external (RF) interference are specified on an absolute frequency scale. This scale
 797 extends up to f_{MAX} . Beyond this frequency the circuitry itself shall suppress the high-frequency interference
 798 signals sufficiently.

799 Only the overall performance of the TLIS and the maximum reflection of RX and TX are specified. This
 800 fully specifies the signal behavior at the RX/TX-module pins. The subdivision of losses, reflections and
 801 mode-conversion budget to individual physical fractions of the TLIS is left to the system designer. Annex B
 802 includes some rules of thumb for system design and signal routing guidelines.

8.5 Characterization Conditions

803 All S-parameter definitions are based on a 50Ω impedance reference level. The characterization can be
 804 done with a measurement system, as shown in Figure 30.



805

Figure 30 Set-up for S-parameter Characterization of RX, TX and TLIS

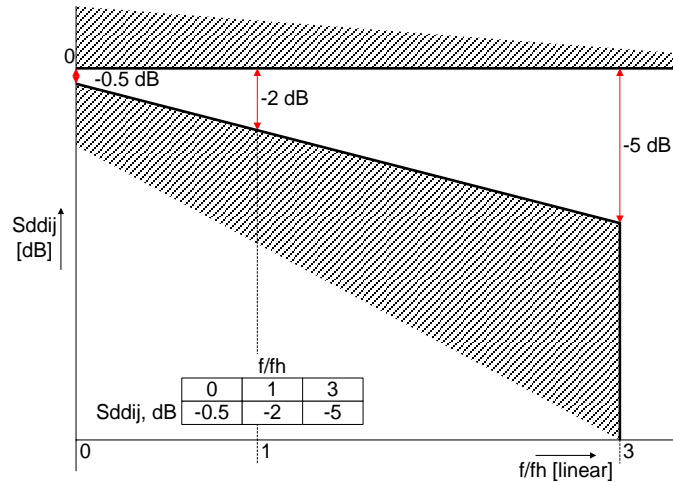
806 The syntax of S-parameters is $S[\text{measured-mode}][\text{driven-mode}][\text{measured-port}][\text{driven-port}]$. Examples:
 807 Sdd21 of TLIS is the differential signal at port 2 due to a differential signal driven at port 1; Sdc22 is the
 808 measured differential reflected signal at port 2 due to a common signal driven at port 2.

8.6 Interconnect Specifications

809 The Transmission-Line Signal-Routing (TLRS) is specified by means of mixed-mode 4-port S-parameter
 810 behavior templates over the frequency range. This includes the differential and common-mode, insertion
 811 and return losses, and mode-conversion limitations.

8.6.1 Differential Characteristics

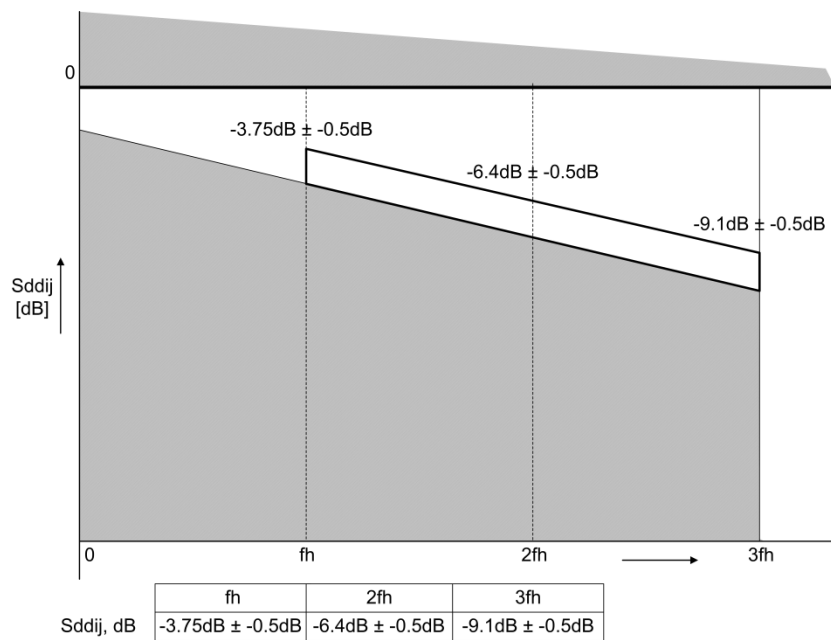
812 The differential transfer behavior (insertion loss) of the TLIS when supporting data rates ≤ 1.5 Gbps shall
813 meet the Sdd21 template shown in Figure 31, where $i \neq j$.



814

Figure 31 Template for Differential Insertion Losses, Data Rates ≤ 1.5 Gbps

815 The differential transfer behavior (insertion loss) of the TLIS when supporting data rates > 1.5 Gbps shall
816 meet the Sdd21 template shown in Figure 32, where $i \neq j$.

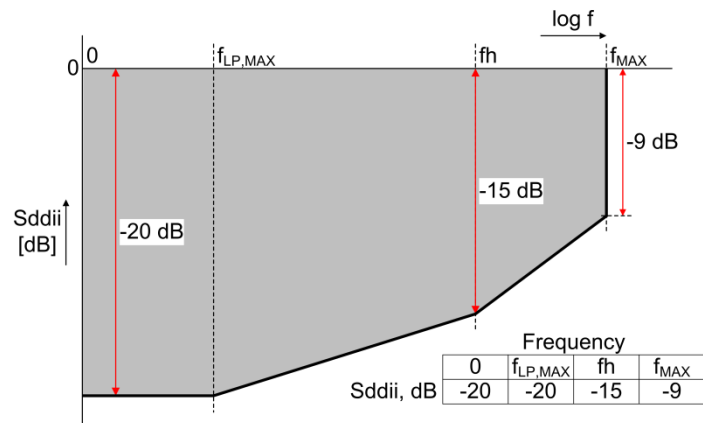


817

Figure 32 Template for Differential Insertion Losses, Data Rates > 1.5 Gbps

818 When supported data rates are ≤ 1.5 Gbps, the differential reflection for both ports of the TLIS is
819 specified by Sdd11 and Sdd22, and should match the template shown in Figure 33. Not meeting the
820 differential reflection coefficient might impact interoperability and operation.

821 When supported data rates are > 1.5 Gbps, the differential reflection for both ports of the TLIS is specified
822 by Sdd11 and Sdd22, and should be better than -12 dB in the range from 0 to f_{max} . Not meeting the
823 differential reflection coefficient might impact interoperability and operation.



824

Figure 33 Template for Differential Reflection at Both Ports

8.6.2 Common-mode Characteristics

825 The common-mode insertion loss is implicitly specified by means of the differential insertion loss and the
 826 Intra-Lane cross coupling. The requirements for common-mode insertion loss are therefore equal to the
 827 differential requirements.

828 The common-mode reflection coefficients S_{cc11} and S_{cc22} should both be below -20 dB at frequencies up to
 829 to $f_{LP,MAX}$, below -15 dB at f_h and -9 dB at f_{MAX} , similar to the differential requirements shown in Figure 33.
 830 Not meeting the common-mode reflection coefficients might impact interoperability and operation.

8.6.3 Intra-Lane Cross-Coupling

831 The two lines applied as a differential pair during HS transmission are also used individually for single-
 832 ended signaling during Low-Power mode. Therefore, the coupling between the two wires shall be restricted
 833 in order to limit single-ended cross coupling. The coupling between the two wires is defined as the
 834 difference of the S-parameters S_{cc21} and S_{dd21} or S_{cc12} and S_{dd12} . In either case, the difference shall not
 835 exceed -20 dB for frequencies up to $10 \cdot f_{LP,MAX}$.

8.6.4 Mode-Conversion Limits

836 All mixed-mode, 4-port S-parameters for differential to common-mode conversion, and vice-versa, shall
 837 not exceed -26 dB for frequencies below f_{MAX} . This includes S_{dc12} , S_{cd21} , S_{cd12} , S_{dc21} , S_{cd11} , S_{dc11} ,
 838 S_{cd22} , and S_{dc22} .

8.6.5 Inter-Lane Cross-Coupling

839 The common-mode and differential inter-Lane cross coupling between Lanes (clock and data) shall meet
 840 the requirements as shown in Figure 34 and Figure 35, respectively.

841

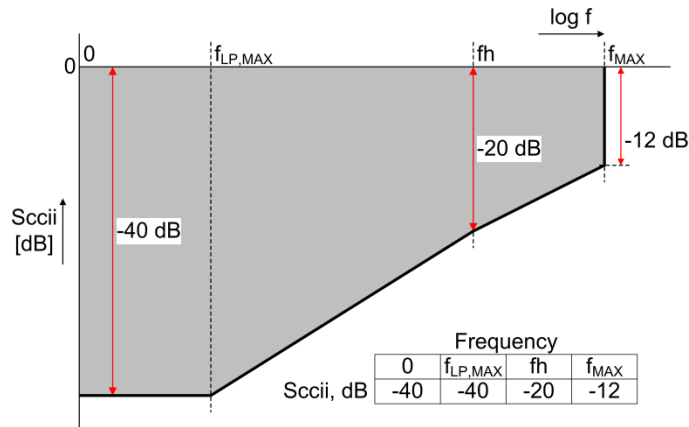


Figure 34 Inter-Lane Common-mode Cross-Coupling Template

842

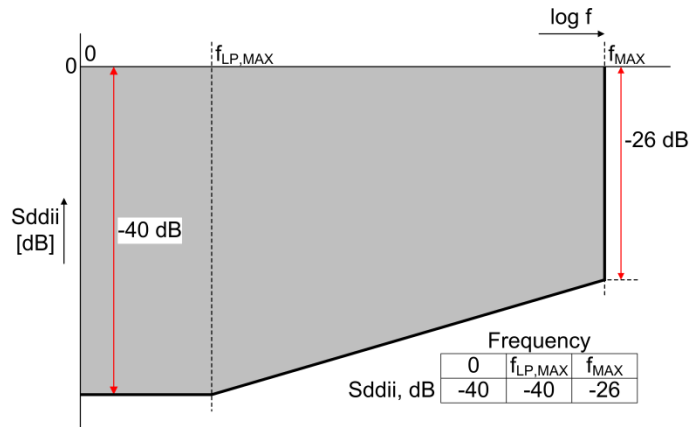


Figure 35 Inter-Lane Differential Cross-Coupling Template

8.6.6 Inter-Lane Static Skew

843 The difference in signal delay between any Data Lane and the Clock Lane shall be less than UI/50 for all
844 frequencies up to, and including, f_h when the supported data rate is less than or equal to 1.5 Gbps. For data
845 rates higher than 1.5Gbps, refer to Table 30.

846

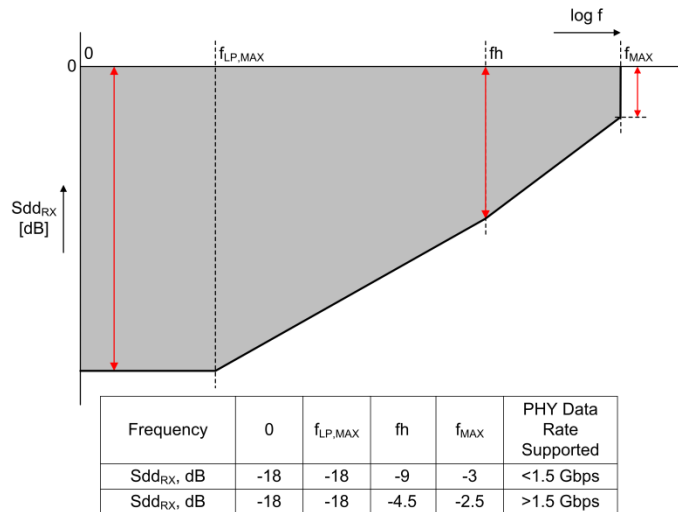
$$\frac{|Sdd12_{DATA}(\varphi) - Sdd12_{CLOCK}(\varphi)|}{\omega} < \frac{UI}{50}$$

8.7 Driver and Receiver Characteristics

847 Besides the TLIS the Lane consists of two RX-TX modules, one at each side. This paragraph specifies the
848 reflection behavior (return loss) of these RX-TX modules in HS-mode. The signaling characteristics of all
849 possible functional blocks inside the RX-TX modules can be found in Section 9. The low-frequency
850 impedance range for line terminations at Transmitter and Receiver is 80-125Ohm.

8.7.1 Differential Characteristics

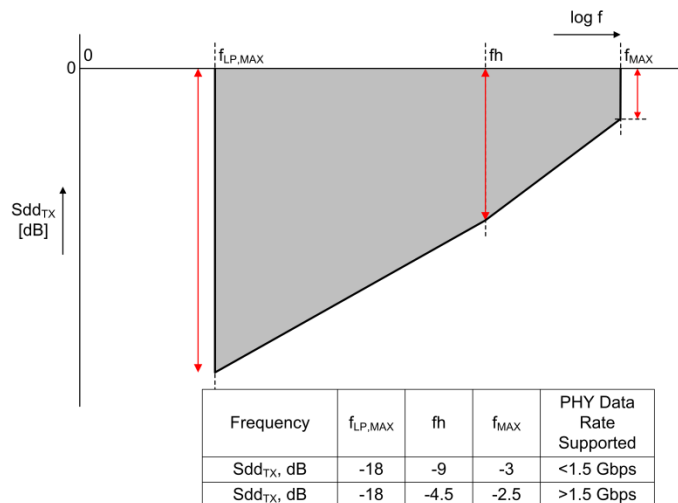
851 The differential reflection of a Lane Module in High-Speed RX mode is specified by the template shown in
852 Figure 36.



853

Figure 36 Differential Reflection Template for Lane Module Receivers

854 The differential reflection of a Lane Module in High-Speed TX mode is specified by the template shown in
855 Figure 37.



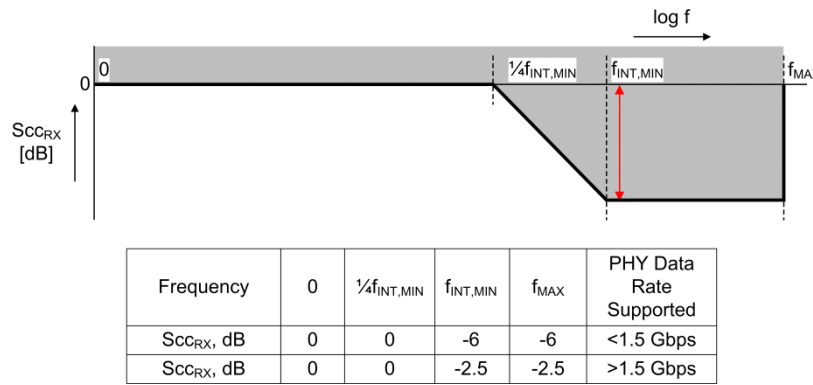
856

Figure 37 Differential Reflection Template for Lane Module Transmitters

8.7.2 Common-Mode Characteristics

857 The common-mode return loss specification is different for a High-Speed TX and RX mode, because the
858 RX is not DC terminated to ground. The common-mode reflection of a Lane Module in High-Speed TX
859 mode shall be less than -6dB from $f_{LP,MAX}$ up to f_{MAX} for devices supporting data rates up to 1.5 Gbps, and
860 -2.5 dB for devices supporting data rates higher than 1.5 Gbps.

861 The common-mode reflection of a Lane Module in High-Speed RX mode shall conform to the limits
862 specified by the template shown in Figure 38. Assuming a high DC common-mode impedance, this implies
863 a sufficiently large capacitor at the termination center tap. The minimum value allows integration. While
864 the common-mode termination is especially important for reduced influence of RF interferers, the RX
865 requirement limits reflection for the most relevant frequency band.



866

Figure 38 Template for RX Common-Mode Return Loss

8.7.3 Mode-Conversion Limits

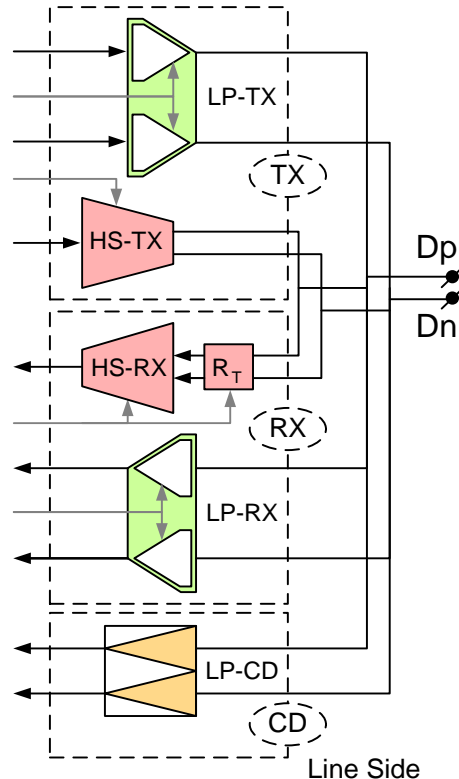
867 The differential to common-mode conversion limits of TX and RX shall be -26dB up to f_{MAX} .

8.7.4 Inter-Lane Matching

868 The return loss difference between multiple Lanes shall be less than -26dB for all frequencies up to f_{MAX} .

9 Electrical Characteristics

869 A PHY may contain the following electrical functions: a High-Speed Transmitter (HS-TX), a High-Speed
 870 Receiver (HS-RX), a Low-Power Transmitter (LP-TX), a Low-Power Receiver (LP-RX), and a Low-Power
 871 Contention Detector (LP-CD). A PHY does not need to contain all electrical functions, only the functions
 872 that are required for a particular PHY configuration. The required functions for each configuration are
 873 specified in Section 5. All electrical functions included in any PHY shall meet the specifications in this
 874 section. Figure 39 shows the complete set of electrical functions required for a fully featured PHY
 875 transceiver.



876

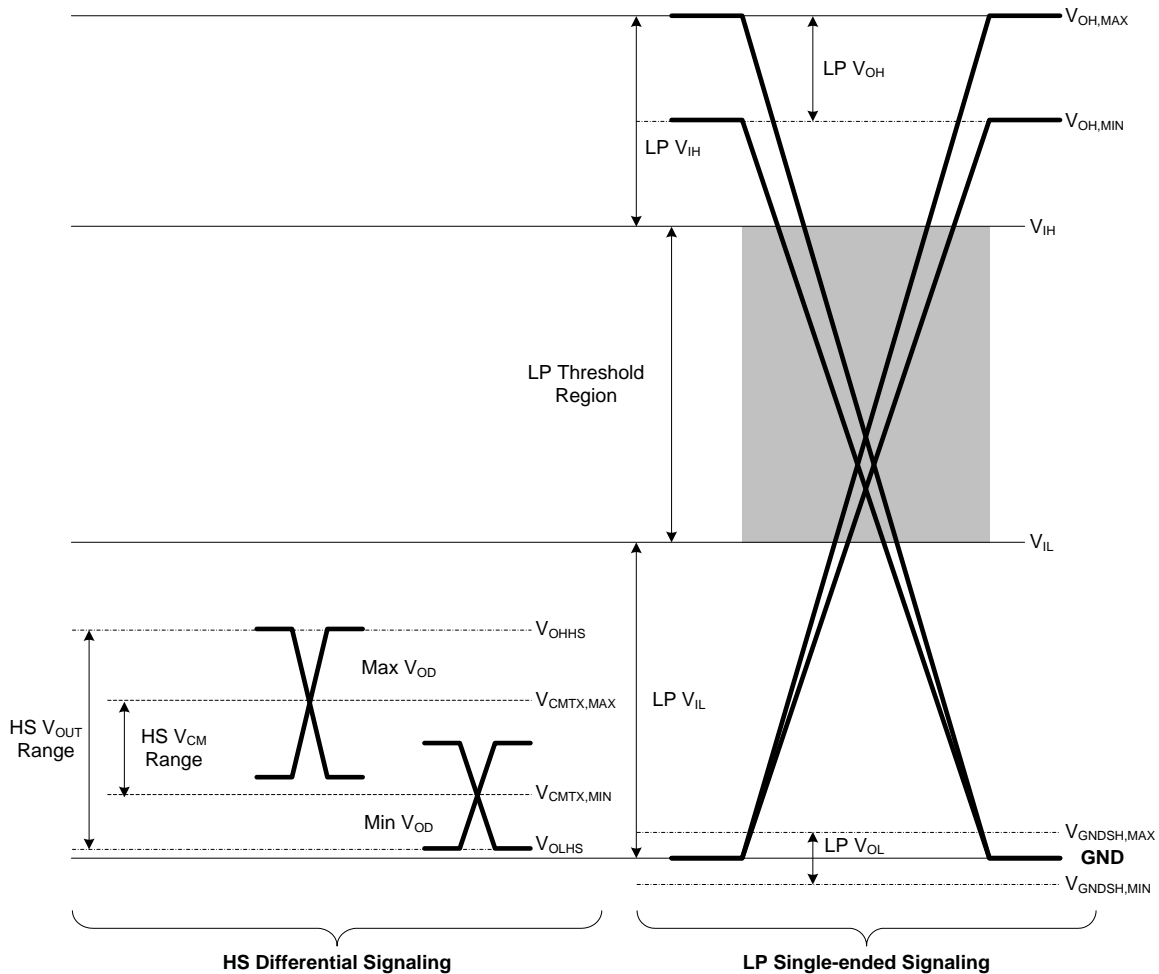
Figure 39 Electrical Functions of a Fully Featured D-PHY Transceiver

877 The HS transmitter and HS receiver are used for the transmission of the HS data and clock signals. The HS
 878 transmitter and receiver utilize low-voltage differential signaling for signal transmission. The HS receiver
 879 contains a switchable parallel termination.

880 The LP transmitter and LP receiver serve as a low power signaling mechanism. The LP transmitter is a
 881 push-pull driver and the LP receiver is an un-terminated, single-ended receiver.

882 The signal levels are different for differential HS mode and single-ended LP mode. Figure 40 shows both
 883 the HS and LP signal levels on the left and right sides, respectively. The HS signaling levels are below the
 884 LP low-level input threshold such that LP receiver always detects low on HS signals.

885 All absolute voltage levels are relative to the ground voltage at the transmit side.



886

Figure 40 D-PHY Signaling Levels

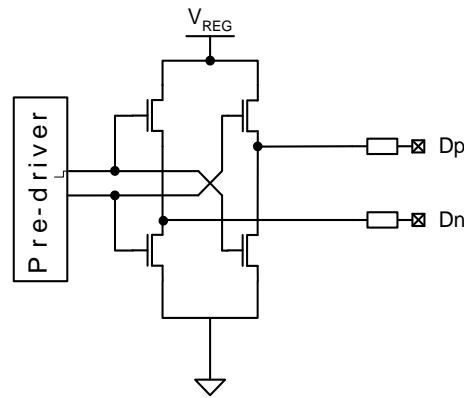
887 A Lane switches between Low-Power and High-Speed mode during normal operation. Bidirectional Lanes
 888 can also switch communication direction. The change of operating mode or direction requires enabling and
 889 disabling of certain electrical functions. These enable and disable events shall not cause glitches on the
 890 Lines that would result in a detection of an incorrect signal level. Therefore, all mode and direction changes
 891 shall be smooth to always ensure a proper detection of the Line signals.

9.1 Driver Characteristics

9.1.1 High-Speed Transmitter

892 A HS differential signal driven on the Dp and Dn pins is generated by a differential output driver. For
 893 reference, Dp is considered as the positive side and Dn as the negative side. The Lane state is called
 894 Differential-1 (HS-1) when the potential on Dp is higher than the potential of Dn. The Lane state is called
 895 Differential-0 (HS-0), when the potential on Dp is lower than the potential of Dn. Figure 41 shows an
 896 example implementation of a HS transmitter.

897 Note, this section uses Dp and Dn to reference the pins of a Lane Module regardless of whether the pins
 898 belong to a Clock Lane Module or a Data Lane Module.



899

Figure 41 Example HS Transmitter

900 The differential output voltage V_{OD} is defined as the difference of the voltages V_{DP} and V_{DN} at the Dp and
901 Dn pins, respectively.

902
$$V_{OD} = V_{DP} - V_{DN}$$

903 The output voltages V_{DP} and V_{DN} at the Dp and Dn pins shall not exceed the High-Speed output high
904 voltage V_{OHHS} . V_{OLHS} is the High-Speed output, low voltage on Dp and Dn and is determined by V_{OD} and
905 V_{CMTX} . The High-Speed V_{OUT} is bounded by the minimum value of V_{OLHS} and the maximum value of
906 V_{OHHS} .

907 The common-mode voltage V_{CMTX} is defined as the arithmetic mean value of the voltages at the Dp and Dn
908 pins:

909
$$V_{CMTX} = \frac{V_{DP} + V_{DN}}{2}$$

910 V_{OD} and V_{CMTX} are graphically shown in Figure 42 for ideal HS signals. Figure 43 shows single-ended HS
911 signals with the possible kinds of distortion of the differential output and common-mode voltages. V_{OD} and
912 V_{CMTX} may be slightly different for driving a Differential-1 or a Differential-0 on the pins. The output
913 differential voltage mismatch ΔV_{OD} is defined as the difference of the absolute values of the differential
914 output voltage in the Differential-1 state $V_{OD(1)}$ and the differential output voltage in the Differential-0 state
915 $V_{OD(0)}$. This is expressed by:

916
$$\Delta V_{OD} = |V_{OD(1)}| - |V_{OD(0)}|$$

917 If $V_{CMTX(1)}$ and $V_{CMTX(0)}$ are the common-mode voltages for static Differential-1 and Differential-0 states
918 respectively, then the common-mode reference voltage is defined by:

919
$$V_{CMTX,REF} = \frac{V_{CMTX(1)} + V_{CMTX(0)}}{2}$$

920 The transient common-mode voltage variation is defined by:

921
$$\Delta V_{CMTX}(t) = V_{CMTX}(t) - V_{CMTX,REF}$$

922 The static common-mode voltage mismatch between the Differential-1 and Differential-0 state is given by:

923
$$\Delta V_{CMTX(1,0)} = \frac{V_{CMTX(1)} - V_{CMTX(0)}}{2}$$

924 The transmitter shall send data such that the high frequency and low frequency common-mode voltage
 925 variations do not exceed $\Delta V_{CMTX(HF)}$ and $\Delta V_{CMTX(LF)}$, respectively. An example test circuit for the
 926 measurement of V_{OD} and V_{CMTX} is shown in Figure 44.

Ideal Single-Ended High Speed Signals

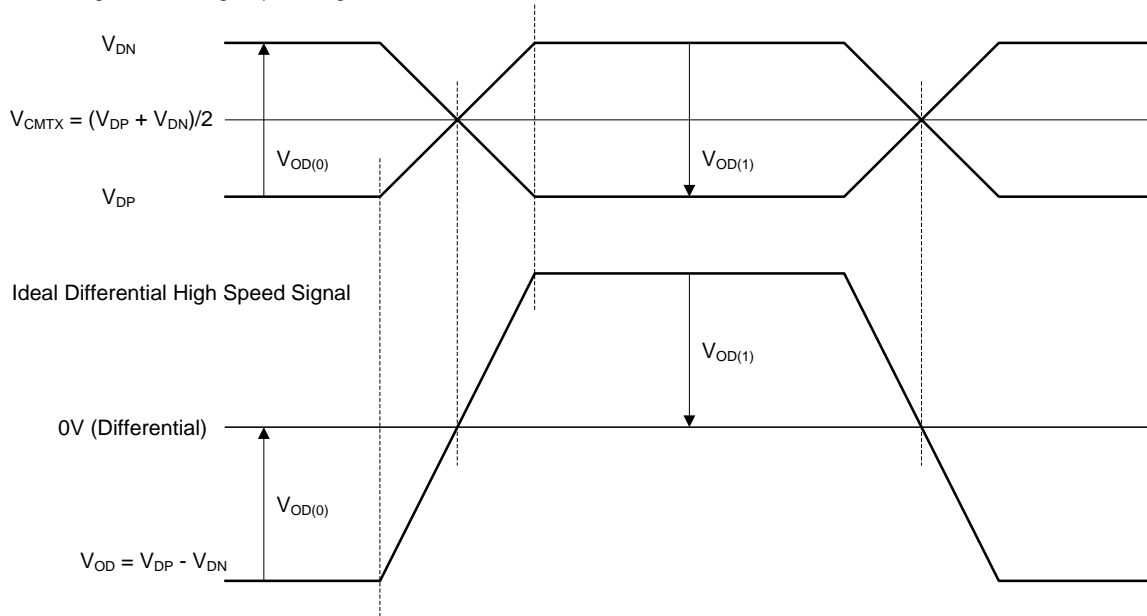
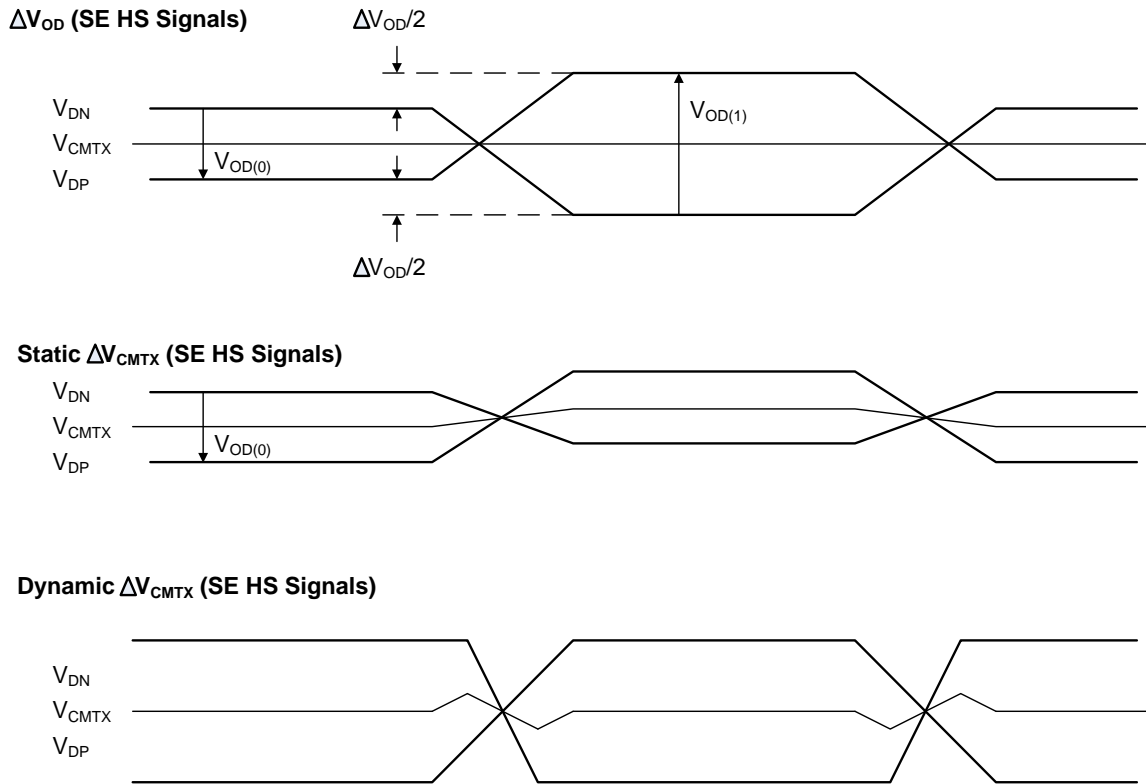
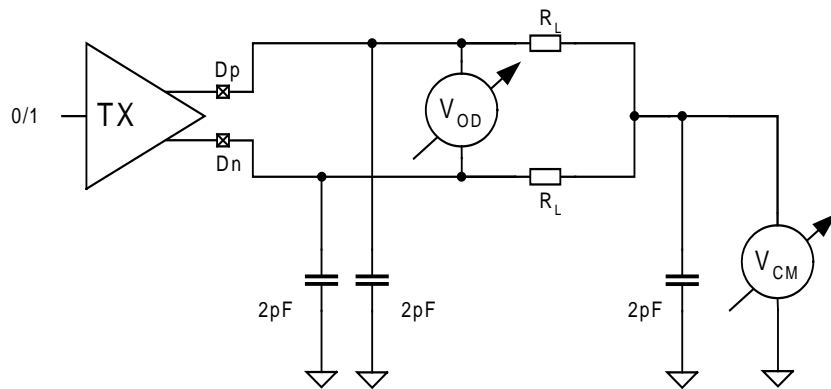


Figure 42 Ideal Single-ended and Resulting Differential HS Signals



928

Figure 43 Possible ΔV_{CMTX} and ΔV_{OD} Distortions of the Single-ended HS Signals



929

Figure 44 Example Circuit for V_{CMTX} and V_{OD} Measurements

930 The single-ended output impedance of the transmitter at both the Dp and Dn pins is denoted by Z_{OS} . ΔZ_{OS} is
 931 the mismatch of the single ended output impedances at the Dp and Dn pins, denoted by Z_{OSDP} and Z_{OSDN}
 932 respectively. This mismatch is defined as the ratio of the absolute value of the difference of Z_{OSDP} and
 933 Z_{OSDN} and the average of those impedances:

$$\Delta Z_{OS} = 2 \frac{|Z_{OSDP} - Z_{OSDN}|}{Z_{OSDP} + Z_{OSDN}}$$

934

935 The output impedance Z_{OS} and the output impedance mismatch ΔZ_{OS} shall be compliant with Table 19 for
936 both the Differential-0 and Differential-1 states for all allowed loading conditions. It is recommended that
937 implementations keep the output impedance during state transitions as close as possible to the steady state
938 value. The output impedance Z_{OS} can be determined by injecting an AC current into the Dp and Dn pins
939 and measuring the peak-to-peak voltage amplitude.

940 The rise and fall times, t_R and t_F , are defined as the transition time between 20% and 80% of the full HS
941 signal swing. The driver shall meet the t_R and t_F specifications for all allowable Z_{ID} . The specifications for
942 TX common-mode return loss and the TX differential mode return loss can be found in Section 8.

943 It is recommended that a High-Speed transmitter that is directly terminated at its pins should not generate
944 any overshoot in order to minimize EMI.

945 **Table 19 HS Transmitter DC Specifications**

Parameter	Description	Min	Nom	Max	Units	Notes
V_{CMTX}	HS transmit static common-mode voltage	150	200	250	mV	1
$ \Delta V_{CMTX(1,0)} $	V_{CMTX} mismatch when output is Differential-1 or Differential-0			5	mV	2
$ V_{OD} $	HS transmit differential voltage	140	200	270	mV	1
$ \Delta V_{OD} $	V_{OD} mismatch when output is Differential-1 or Differential-0			14	mV	2
V_{OHHS}	HS output high voltage			360	mV	1
Z_{OS}	Single ended output impedance	40	50	62.5	Ω	
ΔZ_{OS}	Single ended output impedance mismatch			10	%	

Note:

1. Value when driving into load impedance anywhere in the Z_{ID} range.
2. A transmitter should minimize ΔV_{OD} and $\Delta V_{CMTX(1,0)}$ in order to minimize radiation, and optimize signal integrity.

946 **Table 20 HS Transmitter AC Specifications**

Parameter	Description	Min	Nom	Max	Units	Notes
$\Delta V_{CMTX(HF)}$	Common-level variations above 450MHz			15	mV _{RMS}	
$\Delta V_{CMTX(LF)}$	Common-level variation between 50-450MHz			25	mV _{PEAK}	
t_R and t_F	20%-80% rise time and fall time			0.3	UI	1, 2
				0.35	UI	1, 3
		100			ps	4
				0.4	UI	5
		50			ps	6

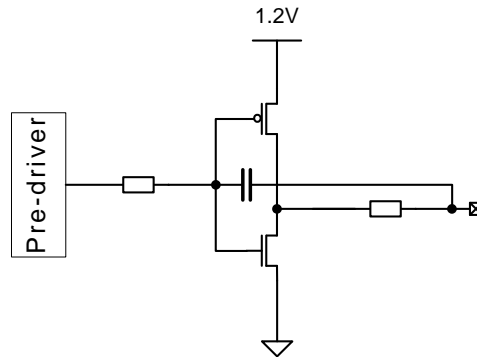
Note:

1. UI is equal to $1/(2*fh)$. See Section 8.3 for the definition of fh.
2. Applicable when supporting maximum HS bit rates ≤ 1 Gbps ($UI \geq 1$ ns).
3. Applicable when supporting maximum HS bit rates > 1 Gbps ($UI \leq 1$ ns) but less than 1.5 Gbps ($UI \Rightarrow 0.667$ ns).
4. Applicable when supporting maximum HS bit rates ≤ 1.5 Gbps. However, to avoid excessive radiation, bit rates < 1 Gbps ($UI \geq 1$ ns), should not use values below 150 ps.
5. Applicable for all HS bit rates when supporting > 1.5 Gbps.

- 6. *Applicable for all HS bit rates when supporting > 1.5 Gbps. However, to avoid excessive radiation, bit rates <= 1.5 Gbps should not use values below 100 ps and bit rates <= 1 Gbps should not use values below 150 ps.*

9.1.2 Low-Power Transmitter

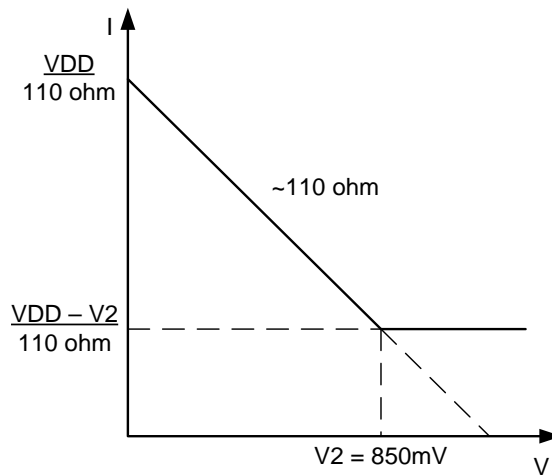
947 The Low-Power transmitter shall be a slew-rate controlled push-pull driver. It is used for driving the Lines
 948 in all Low-Power operating modes. It is therefore important that the static power consumption of a LP
 949 transmitter be as low as possible. The slew-rate of signal transitions is bounded in order to keep EMI low.
 950 An example of a LP transmitter is shown in Figure 45.



951

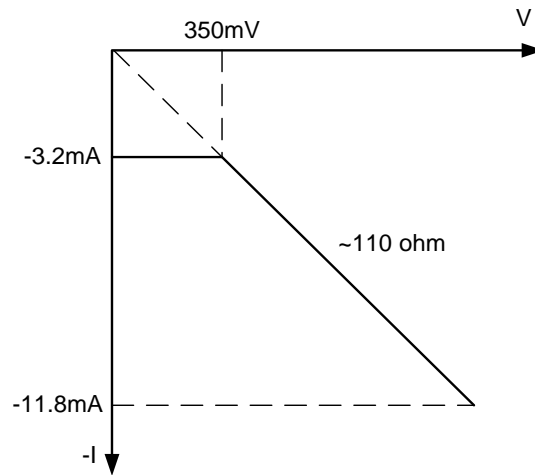
Figure 45 Example LP Transmitter

952 V_{OL} is the Thevenin output, low-level voltage in the LP transmit mode. This is the voltage at an unloaded
 953 pad pin in the low-level state. V_{OH} is the Thevenin output, high-level voltage in the high-level state, when
 954 the pad pin is not loaded. The LP transmitter shall not drive the pad pin potential statically beyond the
 955 maximum value of V_{OH} . The pull-up and pull-down output impedances of LP transmitters shall be as
 956 described in Figure 46 and Figure 47, respectively. The circuit for measuring V_{OL} and V_{OH} is shown in
 957 Figure 48.



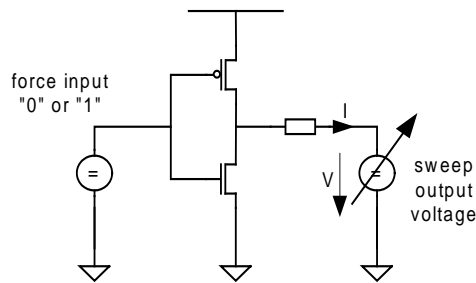
958

Figure 46 V-I Characteristic for LP Transmitter Driving Logic High



959

Figure 47 V-I Characteristic for LP Transmitter Driving Logic Low



960

Figure 48 LP Transmitter V-I Characteristic Measurement Setup

961 The impedance Z_{OLP} is defined by:

$$Z_{OLP} = \left| \frac{V_{THEVENIN} - V_{PIN}}{I_{OUT}} \right|$$

962

963 The times T_{RLP} and T_{FLP} are the 15%-85% rise and fall times, respectively, of the output signal voltage,
 964 when the LP transmitter is driving a capacitive load C_{LOAD} . The 15%-85% levels are relative to the fully
 965 settled V_{OH} and V_{OL} voltages. The slew rate $\delta V/\delta t_{SR}$ is the derivative of the LP transmitter output signal
 966 voltage over time. The LP transmitter output signal transitions shall meet the maximum and minimum slew
 967 rate specifications as shown in Table 22. The intention of specifying a maximum slew rate value is to limit
 968 EMI.

969

Table 21 LP Transmitter DC Specifications

Parameter	Description	Min	Nom	Max	Units	Notes
V_{OH}	Thevenin output high level	1.1	1.2	1.3	V	1
		0.95		1.3	V	2
V_{OL}	Thevenin output low level	-50		50	mV	
Z_{OLP}	Output impedance of LP transmitter	110			Ω	3,4

Note:

1. Applicable when the supported data rate ≤ 1.5 Gbps.
2. Applicable when the supported data rate > 1.5 Gbps.
3. See Figure 46 and Figure 47.
4. Though no maximum value for Z_{OLP} is specified, the LP transmitter output impedance shall ensure the T_{RLP}/T_{FLP} specification is met.

970

Table 22 LP Transmitter AC Specifications

Parameter	Description		Min	Nom	Max	Units	Notes
T_{RLP}/T_{FLP}	15%-85% rise time and fall time				25	ns	1
T_{REOT}	30%-85% rise time and fall time				35	ns	5, 6
$T_{LP-PULSE-TX}$	Pulse width of the LP exclusive-OR clock	First LP exclusive-OR clock pulse after Stop state or last pulse before Stop state	40			ns	4
		All other pulses	20			ns	4
$T_{LP-PER-TX}$	Period of the LP exclusive-OR clock		90			ns	
$\delta V/\delta t_{SR}$	Slew rate @ $C_{LOAD} = 0pF$				500	mV/ns	1, 3, 7, 8
	Slew rate @ $C_{LOAD} = 5pF$				300	mV/ns	1, 3, 7, 8
	Slew rate @ $C_{LOAD} = 20pF$				250	mV/ns	1, 3, 7, 8
	Slew rate @ $C_{LOAD} = 70pF$				150	mV/ns	1, 3, 7, 8
	Slew rate @ $C_{LOAD} = 0$ to $70pF$ (Falling Edge Only)		30			mV/ns	1, 2, 3, 12
			25			mV/ns	1, 3, 13, 16
	Slew rate @ $C_{LOAD} = 0$ to $70pF$ (Rising Edge Only)		30			mV/ns	1, 3, 9, 12
			25			mV/ns	1, 3, 13, 15
Slew rate @ $C_{LOAD} = 0$ to $70pF$ (Rising Edge Only)		$30 - 0.075 * (V_{O,INST} - 700)$			mV/ns	1, 3, 10, 11, 12	
		$25 - 0.0625 * (V_{O,INST} - 550)$			mV/ns	1, 3, 10, 14, 13	
C_{LOAD}	Load capacitance		0		70	pF	1

Note:

1. C_{LOAD} includes the low-frequency equivalent transmission line capacitance. The capacitance of TX and RX are assumed to always be $< 10pF$. The distributed line capacitance can be up to $50pF$ for a transmission line with $2ns$ delay.
2. When the output voltage is between 400 mV and 930 mV.
3. Measured as average across any 50 mV segment of the output signal transition.

4. This parameter value can be lower than T_{LPX} due to differences in rise vs. fall signal slopes and trip levels and mismatches between Dp and Dn LP transmitters. Any LP exclusive-OR pulse observed during HS EoT (transition from HS level to LP-11) is glitch behavior as described in Section 9.2.2.
5. The rise-time of T_{REOT} starts from the HS common-level at the moment the differential amplitude drops below 70mV, due to stopping the differential drive.
6. With an additional load capacitance C_{CM} between 0 and 60 pF on the termination center tap at RX side of the Lane
7. This value represents a corner point in a piece-wise linear curve.
8. When the output voltage is in the range specified by $V_{PIN(absmax)}$.
9. When the output voltage is between 400 mV and 700 mV.
10. Where $V_{O,INST}$ is the instantaneous output voltage, V_{DP} or V_{DN} , in millivolts.
11. When the output voltage is between 700 mV and 930 mV.
12. Applicable when the supported data rate ≤ 1.5 Gbps.
13. Applicable when the supported data rate > 1.5 Gbps.
14. When the output voltage is between 550 mV and 790 mV
15. When the output voltage is between 400 mV and 550 mV
16. When the output voltage is between 400 mV and 790 mV

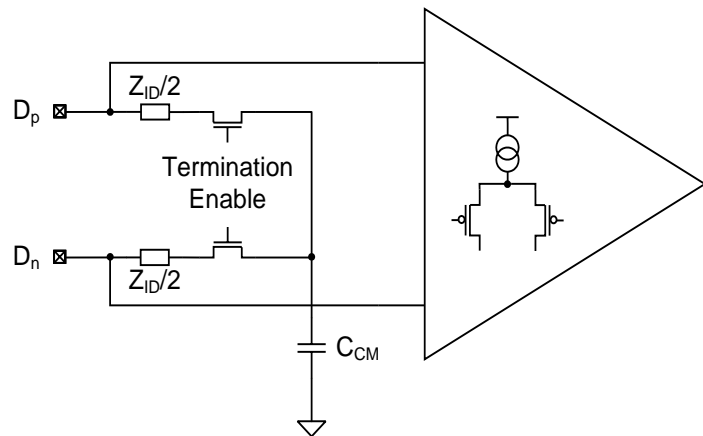
971 There are minimum requirements on the duration of each LP state. To determine the duration of the LP
 972 state, the Dp and Dn signal lines are each compared to a common trip-level. The result of these
 973 comparisons is then exclusive-ORed to produce a single pulse train. The output of this “exclusive-OR
 974 clock” can then be used to find the minimum pulse width output of an LP transmitter.

975 Using a common trip-level in the range $[V_{IL,MAX} + V_{OL,MIN}, V_{IH,MIN} + V_{OL,MAX}]$, the exclusive-OR clock
 976 shall not contain pulses shorter than $T_{LP-PULSE-TX}$.

9.2 Receiver Characteristics

9.2.1 High-Speed Receiver

977 The HS receiver is a differential line receiver. It contains a switchable parallel input termination, Z_{ID} ,
 978 between the positive input pin Dp and the negative input pin Dn. A simplified diagram of an example
 979 implementation using a PMOS input stage is shown in Figure 49.



980

Figure 49 HS Receiver Implementation Example

981 The differential input high and low threshold voltages of the HS receiver are denoted by V_{IDTH} and V_{IDTL} ,
 982 respectively. V_{ILHS} and V_{IHHS} are the single-ended, input low and input high voltages, respectively.
 983 $V_{CMRX(DC)}$ is the differential input common-mode voltage. The HS receiver shall be able to detect
 984 differential signals at its Dp and Dn input signal pins when both signal voltages, V_{DP} and V_{DN} , are within
 985 the common-mode voltage range and if the voltage difference of V_{DP} and V_{DN} exceeds either V_{IDTH} or
 986 V_{IDTL} . The High-Speed receiver shall receive High-Speed data correctly while rejecting common-mode
 987 interference $\Delta V_{CMRX(HF)}$ and $\Delta V_{CMRX(LF)}$.

988 During operation of the HS receiver, termination impedance Z_{ID} is required between the Dp and Dn pins of
 989 the HS receiver. Z_{ID} shall be disabled when the module is not in the HS receive mode. When transitioning
 990 from Low-Power Mode to HS receive mode the termination impedance shall not be enabled until the
 991 single-ended input voltages on both Dp and Dn fall below $V_{TERM-EN}$. To meet this requirement, a receiver
 992 does not need to sense the Dp and Dn lines to determine when to enable the line termination, rather the LP
 993 to HS transition timing can allow the line voltages to fall to the appropriate level before the line termination
 994 is enabled.

995 The RX common-mode return loss and the RX differential mode return loss are specified in Section 8. C_{CM}
 996 is the common-mode AC termination, which ensures a proper termination of the receiver at higher
 997 frequencies. For higher data rates, C_{CM} is needed at the termination centre tap in order to meet the common-
 998 mode reflection requirements.

999 **Table 23 HS Receiver DC Specifications**

Parameter	Description	Min	Nom	Max	Units	Note
$V_{CMRX(DC)}$	Common-mode voltage HS receive mode	70		330	mV	1,2
V_{IDTH}	Differential input high threshold			70	mV	3
				40	mV	4
V_{IDTL}	Differential input low threshold	-70			mV	3
		-40			mV	4
V_{IHHS}	Single-ended input high voltage			460	mV	1
V_{ILHS}	Single-ended input low voltage	-40			mV	1
$V_{TERM-EN}$	Single-ended threshold for HS termination enable			450	mV	
Z_{ID}	Differential input impedance	80	100	125	Ω	

Note:

1. Excluding possible additional RF interference of 100mV peak sine wave beyond 450MHz.
2. This table value includes a ground difference of 50mV between the transmitter and the receiver, the static common-mode level tolerance and variations below 450MHz
3. For devices supporting data rates ≤ 1.5 Gbps.
4. For devices supporting data rates > 1.5 Gbps.

1000

Table 24 HS Receiver AC Specifications

Parameter	Description	Min	Nom	Max	Units	Notes
$\Delta V_{CMRX(HF)}$	Common-mode interference beyond 450 MHz			100	mV	2,5
				50	mV	2,6
$\Delta V_{CMRX(LF)}$	Common-mode interference 50MHz – 450MHz	-50		50	mV	1,4,5
		-25		25	mV	1,4,6
C_{CM}	Common-mode termination			60	pF	3

Note:

1. Excluding 'static' ground shift of 50mV
2. $\Delta V_{CMRX(HF)}$ is the peak amplitude of a sine wave superimposed on the receiver inputs.
3. For higher bit rates a 14pF capacitor will be needed to meet the common-mode return loss specification.
4. Voltage difference compared to the DC average common-mode potential.
5. For devices supporting data rates ≤ 1.5 Gbps.
6. For devices supporting data rates > 1.5 Gbps.

9.2.2 Low-Power Receiver

1001 The Low-Power receiver is an un-terminated, single-ended receiver circuit. The LP receiver is used to
1002 detect the Low-Power state on each pin. For high robustness, the LP receiver shall filter out noise pulses
1003 and RF interference. It is recommended the implementer optimize the LP receiver design for low power.

1004 The input low-level voltage, V_{IL} , is the voltage at which the receiver is required to detect a low state in the
1005 input signal. A lower input voltage, $V_{IL-ULPS}$, may be used when the receiver is in the Ultra-Low Power
1006 State. V_{IL} is larger than the maximum single-ended Line voltage during HS transmission. Therefore, a LP
1007 receiver shall detect low during HS signaling.

1008 The input high-level voltage, V_{IH} , is the voltage at which the receiver is required to detect a high state in the
1009 input signal. In order to reduce noise sensitivity on the received signal, an LP receiver shall incorporate a
1010 hysteresis. The hysteresis voltage is defined as V_{HYST} .

1011 The LP receiver shall reject any input signal smaller than e_{SPIKE} . Signal pulses wider than T_{MIN-RX} shall
1012 propagate through the LP receiver.

1013 Furthermore, the LP receivers shall be tolerant of super-positioned RF interference on top of the wanted
1014 Line signals. This implies an input signal filter. The LP receiver shall meet all specifications for
1015 interference with peak amplitude V_{INT} and frequency f_{INT} . The interference shall not cause glitches or
1016 incorrect operation during signal transitions.

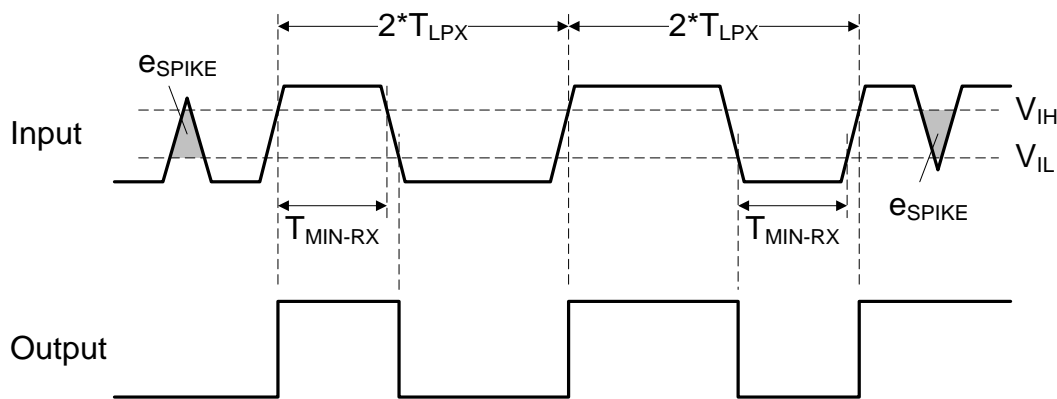


Figure 50 Input Glitch Rejection of Low-Power Receivers

Table 25 LP Receiver DC specifications

Parameter	Description	Min	Nom	Max	Units	Notes
V_{IH}	Logic 1 input voltage	880			mV	1
		740			mV	2
V_{IL}	Logic 0 input voltage, not in ULP State			550	mV	
$V_{IL-ULPS}$	Logic 0 input voltage, ULP State			300	mV	
V_{HYST}	Input hysteresis	25			mV	

Note:

1. Applicable when the supported data rate ≤ 1.5 Gbps.
2. Applicable when the supported data rate > 1.5 Gbps.

1020

Table 26 LP Receiver AC Specifications

Parameter	Description	Min	Nom	Max	Units	Notes
eSPIKE	Input pulse rejection			300	V·ps	1, 2, 3
T _{MIN-RX}	Minimum pulse width response	20			ns	4
V _{INT}	Peak interference amplitude			200	mV	
f _{INT}	Interference frequency	450			MHz	

Note:

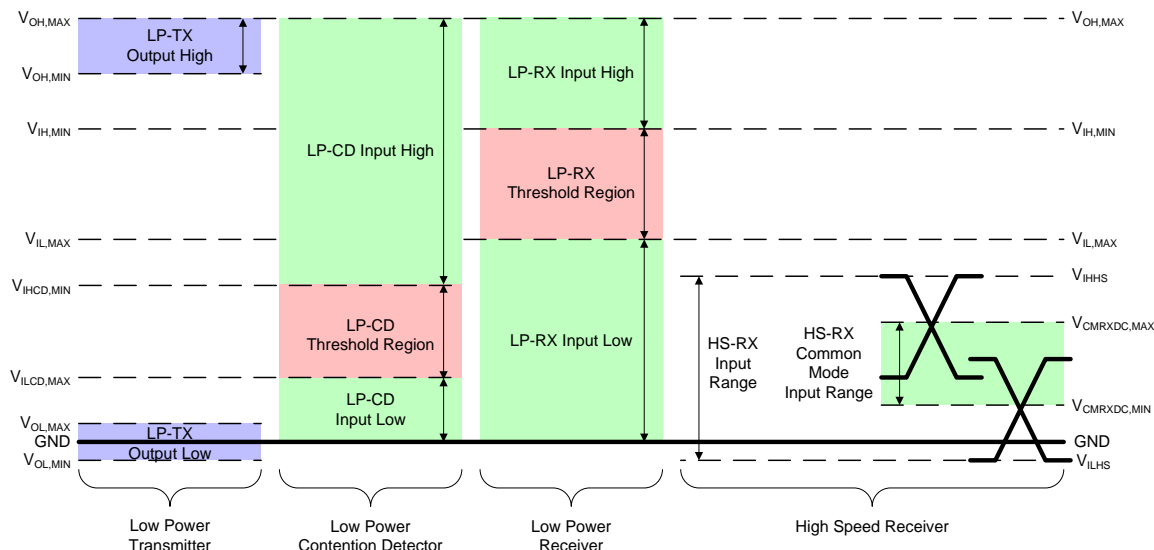
1. Time-voltage integration of a spike above V_{IL} when being in LP-0 state or below V_{IH} when being in LP-1 state. eSpike generation will ensure the spike is crossing both $V_{IL,max}$ and $V_{IH,min}$ levels.
2. An impulse less than this will not change the receiver state.
3. In addition to the required glitch rejection, implementers shall ensure rejection of known RF-interferers.
4. An input pulse greater than this shall toggle the output.

9.3 Line Contention Detection

1021 The Low-Power receiver and a separate Contention Detector (LP-CD) shall be used in a bi-directional Data
 1022 Lane to monitor the line voltage on each Low-Power signal. This is required to detect line contention as
 1023 described in Section 7.1. The Low-Power receiver shall be used to detect an LP high fault when the LP
 1024 transmitter is driving high and the pin voltage is less than V_{IL} . Refer to Table 25. The LP-CD shall be used
 1025 to detect an LP low fault when the LP transmitter is driving low and the pin voltage is greater than V_{IHCD} .
 1026 Refer to Table 27. An LP low fault shall not be detected when the pin voltage is less than V_{ILCD} .

1027 The general operation of a contention detector shall be similar to that of an LP receiver with lower
 1028 threshold voltages. Although the DC specifications differ, the AC specifications of the LP-CD are defined
 1029 to match those of the LP receiver and the LP-CD shall meet the specifications listed in Table 26 except for
 1030 T_{MIN-RX}. The LP-CD shall sufficiently filter the input signal to avoid false triggering on short events.

1031 The LP-CD threshold voltages (V_{ILCD} , V_{IHCD}) are shown along with the normal signaling voltages in Figure
 1032 51.



1033

Figure 51 Signaling and Contention Voltage Levels

1034

Table 27 Contention Detector (LP-CD) DC Specifications

Parameter	Description	Min	Nom	Max	Units	Notes
V _{IHCD}	Logic 1 contention threshold	450			mV	
V _{ILCD}	Logic 0 contention threshold			200	mV	

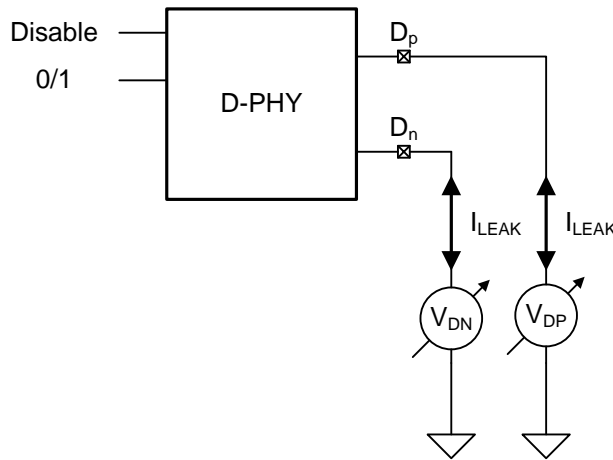
9.4 Input Characteristics

1035

No structure within the PHY may be damaged when a DC signal that is within the signal voltage range V_{PIN} is applied to a pad pin for an indefinite period of time. $V_{PIN(absmax)}$ is the maximum transient output voltage at the transmitter pin. The voltage on the transmitter's output pin shall not exceed $V_{PIN,MAX}$ for a period greater than $T_{VPIN(absmax)}$. When the PHY is in the Low-Power receive mode the pad pin leakage current shall be I_{LEAK} when the pad signal voltage is within the signal voltage range of V_{PIN} . The specification of I_{LEAK} assures interoperability of any PHY in the LP mode by restricting the maximum load current of an LP transmitter. An example test circuit for leakage current measurement is shown in Figure 52.

1042

The ground supply voltages shifts between a Master and a Slave shall be less than V_{GNDSH} .



1043

Figure 52 Pin Leakage Measurement Example Circuit

1044

Table 28 Pin Characteristic Specifications

Parameter	Description	Min	Nom	Max	Units	Note
V_{PIN}	Pin signal voltage range	-50		1350	mV	
I_{LEAK}	Pin leakage current	-10		10	μ A	1
V_{GNDSH}	Ground shift	-50		50	mV	
$V_{PIN(absmax)}$	Transient pin voltage level	-0.15		1.45	V	3
$T_{VPIN(absmax)}$	Maximum transient time above $V_{PIN(max)}$ or below $V_{PIN(min)}$			20	ns	2

Note:

1. When the pad voltage is in the signal voltage range from $V_{GNDSH,MIN}$ to $V_{OH} + V_{GNDSH,MAX}$ and the Lane Module is in LP receive mode.
2. The voltage overshoot and undershoot beyond the V_{PIN} is only allowed during a single 20ns window after any LP-0 to LP-1 transition or vice versa. For all other situations it must stay within the V_{PIN} range.
3. This value includes ground shift.

10 High-Speed Data-Clock Timing

1045 This section specifies the required timings on the High-Speed signaling interface independent of the
 1046 electrical characteristics of the signal. The PHY is a source synchronous interface in the Forward direction.
 1047 In either the Forward or Reverse signaling modes there shall be only one clock source. In the Reverse
 1048 direction, Clock is sent in the Forward direction and one of four possible edges is used to launch the data.
 1049 Data transmission may occur at any rate greater than the minimum specified data bit rate.
 1050 Figure 53 shows an example PHY configuration including the compliance measurement planes for the
 1051 specified timings. Note that the effect of signal degradation inside each package due to parasitic effects is
 1052 included in the timing budget for the transmitter and receiver and is not included in the interconnect
 1053 degradation budget. See Section 8 for details.

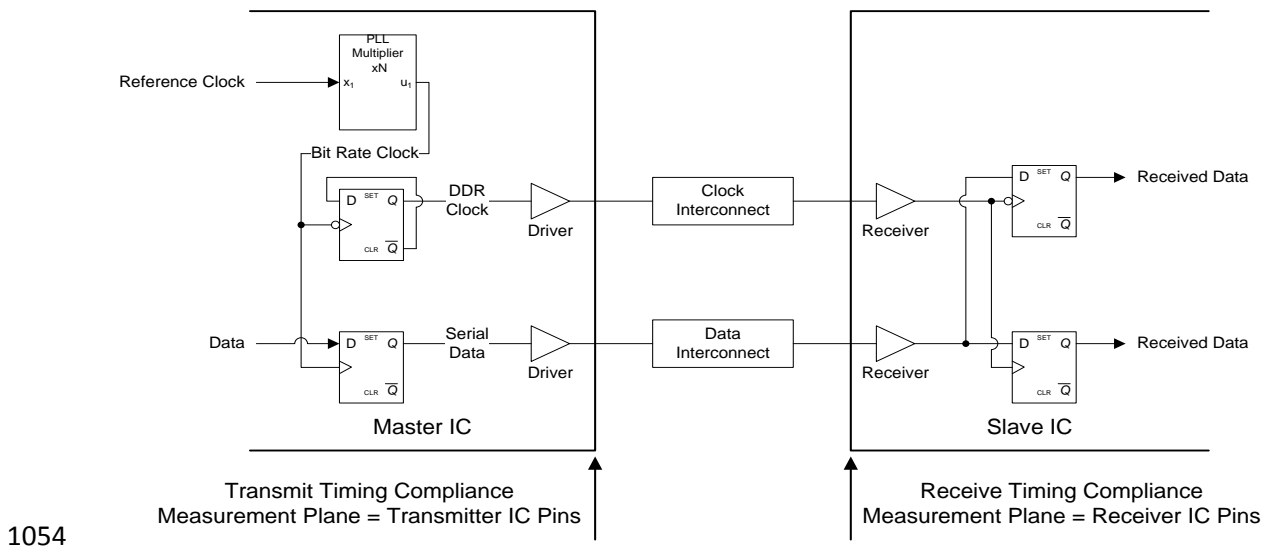


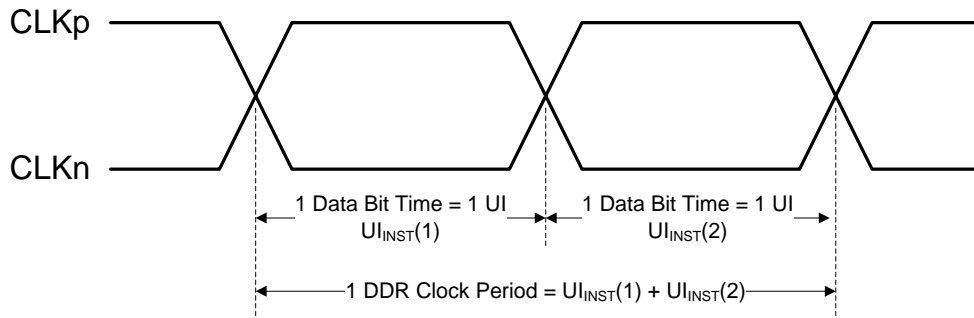
Figure 53 Conceptual D-PHY Data and Clock Timing Compliance Measurement Planes

10.1 High-Speed Clock Timing

1055 The Master side of the Link shall send a differential clock signal to the Slave side to be used for data
 1056 sampling. This signal shall be a DDR (half-rate) clock and shall have one transition per data bit time. All
 1057 timing relationships required for correct data sampling are defined relative to the clock transitions.
 1058 Therefore, implementations may use frequency spreading modulation on the clock to reduce EMI.

1059 The DDR clock signal shall maintain a quadrature phase relationship to the data signal. Data shall be
 1060 sampled on both the rising and falling edges of the Clock signal. The term “rising edge” means “rising edge
 1061 of the differential signal, i.e. CLK_p – CLK_n, and similarly for “falling edge”. Therefore, the period of the
 1062 Clock signal shall be the sum of two successive instantaneous data bit times. This relationship is shown in
 1063 Figure 54.

1064 Note that the UI indicated in Figure 54 is the instantaneous UI. Implementers shall specify a maximum data
 1065 rate and corresponding maximum clock frequency, $f_{h_{MAX}}$, for a given implementation. For a description of
 1066 $f_{h_{MAX}}$, see Section 8.3.



1067

Figure 54 DDR Clock Definition

1068 As can be seen in Figure 53, the same clock source is used to generate the DDR Clock and launch the serial data.
1069 Since the Clock and Data signals propagate together over a channel of specified skew, the Clock may
1070 be used directly to sample the Data lines in the receiver. Such a system can accommodate instantaneous
1071 variations in UI for an ongoing burst defined by ΔUI .

1072 The allowed instantaneous UI variation can cause large, instantaneous data rate variations. Therefore,
1073 devices shall accommodate these instantaneous variations with appropriate logic. It is recommended that
1074 devices accommodate these instantaneous variations using some method, such as with appropriate FIFO
1075 logic outside of the PHY, or provide an accurate clock source to the Lane Module to eliminate these
1076 instantaneous variations, or the data sink outside the PHY can be designed to be tolerant of UI variations

1077 The UI_{INST} specifications for the Clock signal are summarized in Table 29.

1078

Table 29 Clock Signal Specification

Clock Parameter	Symbol	Min	Typ	Max	Units	Notes
UI instantaneous	UI_{INST}			12.5	ns	1,2
UI variation	ΔUI	-10%		10%	UI	3
		-5%		5%	UI	4

Note:

1. This value corresponds to a minimum 80 Mbps data rate.
2. The minimum UI shall not be violated for any single bit period, i.e., any DDR half cycle within a data burst. The allowed instantaneous UI variation can cause instantaneous data rate variations. Therefore, devices should either accommodate these instantaneous variations with appropriate FIFO logic outside of the PHY or provide an accurate clock source to the Lane Module to eliminate these instantaneous variations.
3. When $UI \geq 1ns$, within a single burst.
4. When $0.667ns < UI < 1ns$, within a single burst.

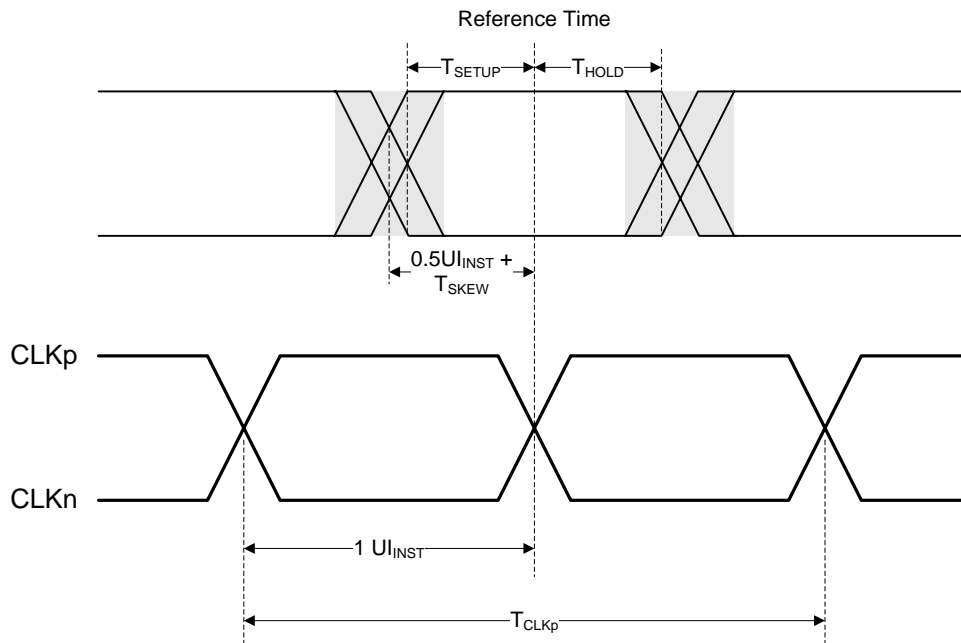
10.2 Forward High-Speed Data Transmission Timing

1079 The timing relationship of the DDR Clock differential signal to the Data differential signal is shown in
1080 Figure 55. Data is launched in a quadrature relationship to the clock such that the Clock signal edge may be
1081 used directly by the receiver to sample the received data.

1082 The transmitter shall ensure that a rising edge of the DDR clock is sent during the first payload bit of a
1083 transmission burst such that the first payload bit can be sampled by the receiver on the rising clock edge,
1084 the second bit can be sampled on the falling edge, and all following bits can be sampled on alternating
1085 rising and falling edges.

1086 All timing values are measured with respect to the actual observed crossing of the Clock differential signal.
1087 The effects due to variations in this level are included in the clock to data timing budget.

1088 Receiver input offset and threshold effects shall be accounted as part of the receiver setup and hold
1089 parameters.



1090

Figure 55 Data to Clock Timing Definitions

10.2.1 Data-Clock Timing Specifications

1091 The Data-Clock timing parameters shown in Figure 55 are specified in Table 30. Implementers shall
 1092 specify a value $UI_{INST,MIN}$ that represents the minimum instantaneous UI possible within a High-Speed data
 1093 transfer for a given implementation. Parameters in Table 30 are specified as a part of this value. The skew
 1094 specification, $T_{SKEW[TX]}$, is the allowed deviation of the data launch time to the ideal $\frac{1}{2}UI_{INST}$ displaced
 1095 quadrature clock edge. The setup and hold times, $T_{SETUP[RX]}$ and $T_{HOLD[RX]}$, respectively, describe the timing
 1096 relationships between the data and clock signals. $T_{SETUP[RX]}$ is the minimum time that data shall be present
 1097 before a rising or falling clock edge and $T_{HOLD[RX]}$ is the minimum time that data shall remain in its current
 1098 state after a rising or falling clock edge. The timing budget specifications for a receiver shall represent the
 1099 minimum variations observable at the receiver for which the receiver will operate at the maximum
 1100 specified acceptable bit error rate.

1101 For data rates above 1.5 Gbps, data to clock skew budget is partitioned in two categories, static and
 1102 dynamic. The static skew is a skew, which is calibrated out during calibration as mentioned in Section 6.12.
 1103 The second category is dynamic skew and it is the variation of maximum skew between data to clock.

1104 The intent in the timing budget is to leave $0.4*UI_{INST}$, i.e. $\pm 0.2*UI_{INST}$ for degradation contributed by the
 1105 interconnect for data rates ≤ 1 Gbps. For data rates > 1 Gbps, the interconnect budget is $0.2*UI_{INST}$, i.e.
 1106 $\pm 0.1*UI_{INST}$ for degradation contributed by the interconnect.

1107

Table 30 Data-Clock Timing Specifications

Parameter	Symbol	Units in UIinst			Operational Frequency in Gbps	
		Min	Max	Total	Min	Max
Data to Clock Skew	$T_{SKEW[TX]}$	-0.15	0.15	0.30	0.08	1.0
		-0.20	0.20	0.40	>1.0	1.5
	$T_{SKEW[TLIS]}$	-0.20	0.20		0.08	1.0
		-0.10	0.10		>1.0	1.5

Parameter	Symbol	Units in UInst			Operational Frequency in Gbps	
		Min	Max	Total	Min	Max
Data to Clock Setup Time	$T_{SETUP[RX]}$	0.15			0.08	1.0
		0.20			>1.0	1.5
Data to Clock Hold Time	$T_{HOLD[RX]}$	0.15			0.08	1.0
		0.20			>1.0	1.5
Static Data to Clock Skew (TX)	$T_{SKEW[TX]}$ static	-0.20	0.20		>1.5	
Static Data to Clock Skew (Channel)	$T_{SKEW[TLIS]}$ static	-0.10	0.10		>1.5	
Static Data to Clock Skew (RX)	$T_{SKEW[RX]}$ static	-0.20	0.20		>1.5	
Dynamic Data to Clock Skew (TX)	$T_{SKEW[TX]}$ dynamic	-0.15	0.15		>1.5	
Channel ISI	ISI		0.20		>1.5	
Dynamic Data to Clock Skew Window RX Tolerance	$T_{SETUP[RX]}+T_{HOLD[RX]}$ dynamic	0.50			>1.5	

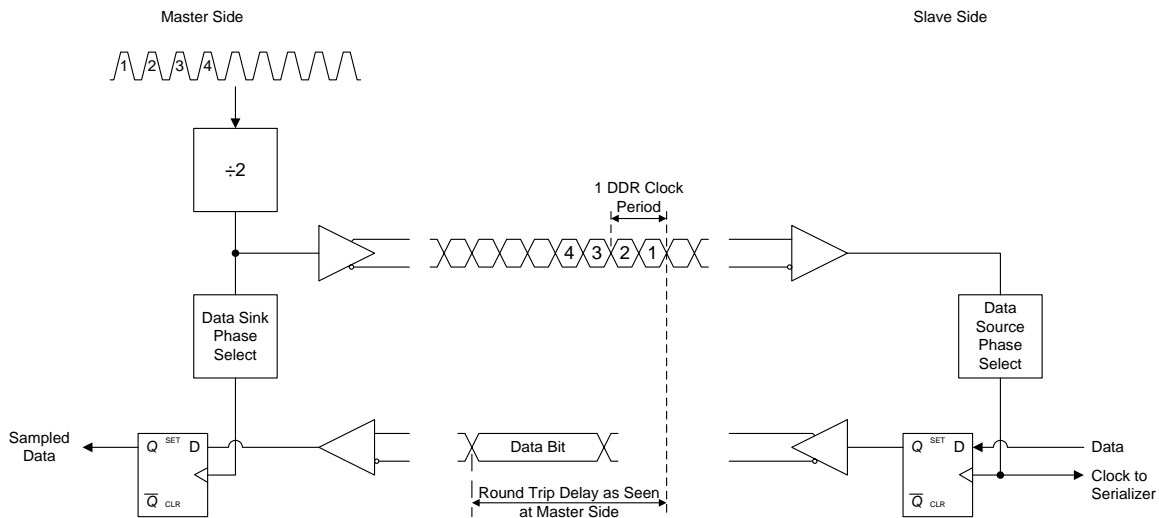
10.3 Reverse High-Speed Data Transmission Timing

1108 This section only applies to Half-Duplex Lane Modules that include Reverse High-Speed Data
1109 Transmission functionality.

1110 A Lane enters the Reverse High-Speed Data Transmission mode by means of a Link Turnaround procedure
1111 as specified in Section 6.5. Reverse Data Transmission is not source-synchronous; the Clock signal is
1112 driven by the Master side while the Data Lane is driven by the Slave side. The Slave Side transmitter shall
1113 send one data bit every two periods of the received Clock signal. Therefore, for a given Clock frequency,
1114 the Reverse direction data rate is one-fourth the Forward direction data rate. The bit period in this case is
1115 defined to be $4 \cdot U_{INST}$. U_{INST} is the value specified for the full-rate forward transmission.

1116 Note that the clock source frequency may change between transmission bursts. However, all Data Lanes
1117 shall be in a Low-Power state before changing the clock source frequency.

1118 The conceptual overview of Reverse HS Data Transmission is shown in Figure 56.



1119

Figure 56 Conceptual View of HS Data Transmission in Reverse Direction

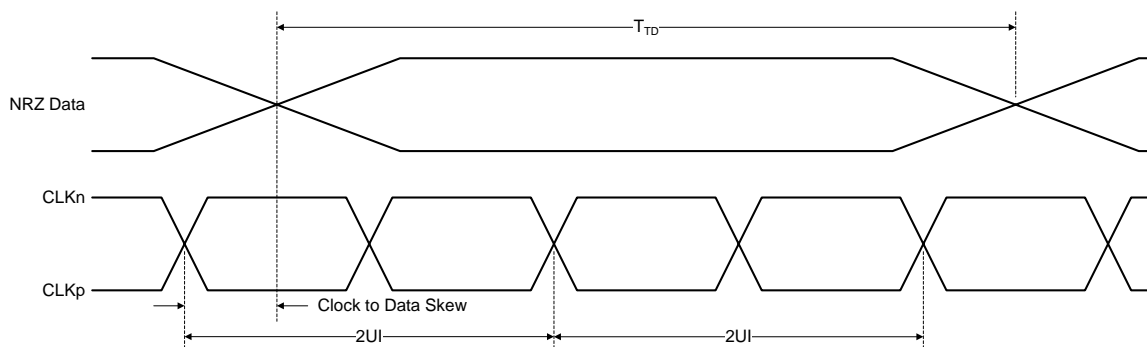
1120 There are four possible phase relationships between clock and data signals in the Reverse direction. The
 1121 Clock phase used to send data is at the discretion of the Slave side, but once chosen it shall remain fixed
 1122 throughout that data transmission burst. Signal delays in the interconnect, together with internal signal
 1123 delays in the Master and Slave Modules, cause a fixed, but unknown, phase relationship in the Master
 1124 Module between received (Reverse) Data and its own (Forward) Clock. Therefore, the Reverse traffic
 1125 arriving at the Master side may not be phase aligned with the Forward direction clock.

1126 Synchronization between Clock and Data signals is achieved with the Sync sequence sent by the Slave
 1127 during the Start of Transmission (SoT). The Master shall include sufficient functionality to correctly sample
 1128 the received data given the instantaneous UI variations of the Clock sent to the Slave.

1129 Reverse transmission by the Slave side is one-fourth of the Forward direction speed, based on the Forward
 1130 direction Clock as transmitted via the Clock Lane. This ratio makes it easy to find a suitable phase at the
 1131 Master Side for Data recovery of Reverse direction traffic.

1132 The known transitions of the received Sync sequence shall be used to select an appropriate phase of the
 1133 clock signal for data sampling. Thus, there is no need to specify the round trip delay between the source of
 1134 the clock and the receiver of the data.

1135 The timing of the Reverse transmission as seen at the Slave side is shown in Figure 57.



1136

Figure 57 Reverse High-Speed Data Transmission Timing at Slave Side

11 Regulatory Requirements

- 1137 All MIPI D-PHY based devices should be designed to meet the applicable regulatory requirements.

Annex A Logical PHY-Protocol Interface Description (informative)

1138 The PHY Protocol Interface (PPI) is used to make a connection between the PHY Lane Modules and the
1139 higher protocol layers of a communication stack. The interface described here is intended to be generic and
1140 application independent.

1141 This annex is informative only. Conformance to the D-PHY specification does not depend on any portion of
1142 the PPI defined herein. Because of that, this annex avoids normative language and does not use words like
1143 “shall” and “should.” Instead, present tense language has been used to describe the PPI, utilizing words like
1144 “is” and “does.” The reader may find it helpful to consider this annex to be a description of an example
1145 implementation, rather than a specification. The signaling interface described in this annex, The PHY
1146 Protocol Interface (PPI) , is optional. However, if a module includes the PPI Interface, it shall implement it
1147 as described in this annex.

1148 This PPI is optimized for controlling a D-PHY and transmitting and receiving parallel data. The interface
1149 described here is defined as an on-chip connection, and does not attempt to minimize signal count or define
1150 timing parameters or voltage levels for the PPI signals.

A.1 Signal Description

1151 Table 31 defines the signals used in the PPI. For a PHY with multiple Data Lanes, a set of PPI signals is
1152 used for each Lane. Each signal has been assigned into one of six categories: High-Speed transmit signals,
1153 High-Speed receive signals, Escape mode transmit signals, Escape mode receive signals, control signals,
1154 and error signals. Bi-directional High-Speed Data Lanes with support for bi-directional Escape mode
1155 include nearly all of the signals listed in the table. Unidirectional Lanes or Clock Lanes include only a
1156 subset of the signals. The direction of each signal is listed as “I” or “O”. Signals with the direction “I” are
1157 PHY inputs, driven from the Protocol. Signals with the direction “O” are PHY outputs, driven to the
1158 Protocol. For this logical interface, most clocks are described as being generated outside the PHY, although
1159 any specific PHY may implement the clock circuit differently.

1160 The “Categories” column in Table 31 indicates for which Lane Module types each signal applies. The
1161 category names are described in Table 1 and are summarized here for convenience. Each category is
1162 described using a four-letter acronym, defined as <Side, HS-capabilities, Escape-Forward, Escape-
1163 Reverse>. The first letter, Side, can be M (Master) or S (Slave). The second letter, High-Speed capabilities,
1164 can be F (Forward data), R (Reverse and Forward data), or C (Clock). The third and fourth letters indicate
1165 Escape mode capability in the Forward and Reverse directions, respectively. For Data Lanes, the third letter
1166 can be A (All) or E (Events – Triggers and ULPS only), while the fourth letter can be A (All, including
1167 LPDT), E (Events, triggers and ULPS only), Y (Any but not None: so A or E) or N (None). For a Data
1168 Lane, any of the four identification letters can be replaced by an X, to indicate that each of the available
1169 options is appropriate. For a Clock Lane, only the first letter can be X, while the other three letters are
1170 always CNN.

1171

Table 31 PPI Signals

Symbol	Dir	Categories	Description
High-Speed Transmit Signals			
TxDDRCIkHS-I	I	MXXX MCNN	Data Lane High-Speed Transmit DDR Clock. This signal is used to transmit High-Speed data bits over the Lane Interconnect. All Data Lanes use the same TxDDRCIkHS-I (in-phase) clock signal.

Symbol	Dir	Categories	Description
TxDDRCIkHS-Q	I	MCNN	Clock Lane High-Speed Transmit DDR Clock. This signal is used to generate the High-Speed clock signal for the Lane Interconnect. The TxDDRCIkHS-Q (quadrature) clock signal is phase shifted from the TxDDRCIkHS-I clock signal.
TxByteClkHS	O	MXXX SRXX	High-Speed Transmit Byte Clock. This is used to synchronize PPI signals in the High-Speed transmit clock domain. It is recommended that all transmitting Data Lane Modules share one TxByteClkHS signal. The frequency of TxByteClkHS is exactly 1/8 the High-Speed bit rate.
TxDataHS[7:0]	I	MXXX SRXX	High-Speed Transmit Data. Eight bit High-Speed data to be transmitted. The signal connected to TxDataHS[0] is transmitted first. Data is captured on rising edges of TxByteClkHS.
TxRequestHS	I	MXXX SRXX MCNN	High-Speed Transmit Request and Data Valid. A low-to-high transition on TxRequestHS causes the Lane Module to initiate a Start-of-Transmission sequence. A high-to-low transition on TxRequest causes the Lane Module to initiate an End-of-Transmission sequence. For Clock Lanes, this active high signal causes the Lane Module to begin transmitting a High-Speed clock. For Data Lanes, this active high signal also indicates that the protocol is driving valid data on TxDataHS to be transmitted. The Lane Module accepts the data when both TxRequestHS and TxReadyHS are active on the same rising TxByteClkHS clock edge. The protocol always provides valid transmit data when TxRequestHS is active. Once asserted, TxRequestHS remains high until the data has been accepted, as indicated by TxReadyHS. TxRequestHS is only asserted while TxRequestEsc is low.
TxReadyHS	O	MXXX SRXX	High-Speed Transmit Ready. This active high signal indicates that TxDataHS is accepted by the Lane Module to be serially transmitted. TxReadyHS is valid on rising edges of TxByteClkHS.
TxSkewCalHS	I	MXXX	High-Speed Transmit Skew Calibration. This is an optional pin to initiate the periodic deskew burst at the transmitter. A low-to-high transition on TxSkewCalHS causes the PHY to initiate a de-skew calibration. A high-to-low transition on TxSkewCalHS causes the PHY to stop deskew pattern transmission and initiate an end-of-transmission sequence.
High-Speed Receive Signals			
RxByteClkHS	O	MRXX SXXX	High-Speed Receive Byte Clock. This is used to synchronize signals in the High-Speed receive clock domain. The RxByteClkHS is generated by dividing the received High-Speed DDR clock.

Symbol	Dir	Categories	Description
RxDataHS[7:0]	O	MRXX SXXX	High-Speed Receive Data. Eight bit High-Speed data received by the Lane Module. The signal connected to RxDataHS[0] was received first. Data is transferred on rising edges of RxByteClkHS.
RxValidHS	O	MRXX SXXX	High-Speed Receive Data Valid. This active high signal indicates that the Lane Module is driving data to the protocol on the RxDataHS output. There is no "RxReadyHS" signal, and the protocol is expected to capture RxDataHS on every rising edge of RxByteClkHS where RxValidHS is asserted. There is no provision for the protocol to slow down ("throttle") the receive data.
RxActiveHS	O	MRXX SXXX	High-Speed Reception Active. This active high signal indicates that the Lane Module is actively receiving a High-Speed transmission from the Lane interconnect.
RxSyncHS	O	MRXX SXXX	Receiver Synchronization Observed. This active high signal indicates that the Lane Module has seen an appropriate synchronization event. In a typical High-Speed transmission, RxSyncHS is high for one cycle of RxByteClkHS at the beginning of a High-Speed transmission when RxActiveHS is first asserted.
RxCkActiveHS	O	SCNN	Receiver Clock Active. This asynchronous, active high signal indicates that a Clock Lane is receiving a DDR clock signal.
RxDDRCkHS	O	SCNN	Receiver DDR Clock. This is the received DDR clock – it may be used by the protocol if required. This signal is low whenever RxCkActiveHS is low.
RxSkewCalHS	O	SXXX	High-Speed Receive Skew Calibration. This optional active high signal indicates that the high speed deskew burst is being received. RxSkewCalHS is set to the active state when the all-ones sync pattern is received, and is cleared to the inactive state when Dp and Dn transition back to the LP-11 Stop State.
Escape Mode Transmit Signals			
TxCkEsc	I	MXXX SXXY	Escape mode Transmit Clock. This clock is directly used to generate escape sequences. The period of this clock determines the phase times for Low-Power signals as defined in Section 6.6.2. It is therefore constrained by the normative part of the D-PHY specification. See Section 9. Note that this clock is used to synchronize TurnRequest and is included for any module that supports bi-directional High-Speed operation, even if that module does not support transmit or bi-directional escape mode.
TxRequestEsc	I	MXXX SXXY	Escape mode Transmit Request. This active high signal, asserted together with exactly one of TxLpdtEsc, TxUlpsEsc, or one bit of TxTriggerEsc, is used to request entry into escape mode. Once in escape mode, the Lane stays in escape mode until TxRequestEsc is de-asserted. TxRequestEsc is only asserted by the protocol while TxRequestHS is low.

Symbol	Dir	Categories	Description
TxLpdtEsc	I	MXAX SXXA	Escape mode Transmit Low-Power Data. This active high signal is asserted with TxRequestEsc to cause the Lane Module to enter Low-Power data transmission mode. The Lane Module remains in this mode until TxRequestEsc is de-asserted. TxUplsEsc and all bits of TxTriggerEsc are low when TxLpdtEsc is asserted.
TxUplsExit	I	MXXX SXXY MCNN	Transmit ULP Exit Sequence. This active high signal is asserted when ULP state is active and the protocol is ready to leave ULP state. The PHY leaves ULP state and begins driving Mark-1 after TxUplsExit is asserted. The PHY later drives the Stop state (LP-11) when TxRequestEsc is deasserted. TxUplsExit is synchronous to TxClkEsc. This signal is ignored when the Lane is not in the ULP State.
TxUplsEsc	I	MXXX SXXY	Escape mode Transmit Ultra-Low Power State. This active high signal is asserted with TxRequestEsc to cause the Lane Module to enter the Ultra-Low Power State. The Lane Module remains in this mode until TxRequestEsc is de-asserted. TxLpdtEsc and all bits of TxTriggerEsc are low when TxUplsEsc is asserted.
TxTriggerEsc[3:0]	I	MXXX SXXY	Escape mode Transmit Trigger 0-3. One of these active high signals is asserted with TxRequestEsc to cause the associated Trigger to be sent across the Lane interconnect. In the receiving Lane Module, the same bit of RxTriggerEsc is then asserted and remains asserted until the Lane interconnect returns to Stop state, which happens when TxRequestEsc is de-asserted at the transmitter. Only one bit of TxTriggerEsc is asserted at any given time, and only when TxLpdtEsc and TxUplsEsc are both low.
TxDataEsc[7:0]	I	MXAX SXXA	Escape mode Transmit Data. This is the eight bit escape mode data to be transmitted in Low-Power data transmission mode. The signal connected to TxDataEsc[0] is transmitted first. Data is captured on rising edges of TxClkEsc.
TxValidEsc	I	MXAX SXXA	Escape mode Transmit Data Valid. This active high signal indicates that the protocol is driving valid data on TxDataEsc to be transmitted. The Lane Module accepts the data when TxRequestEsc, TxValidEsc and TxReadyEsc are all active on the same rising TxClkEsc clock edge.
TxReadyEsc	O	MXAX SXXA	Escape mode Transmit Ready. This active high signal indicates that TxDataEsc is accepted by the Lane Module to be serially transmitted. TxReadyEsc is valid on rising edges of TxClkEsc.

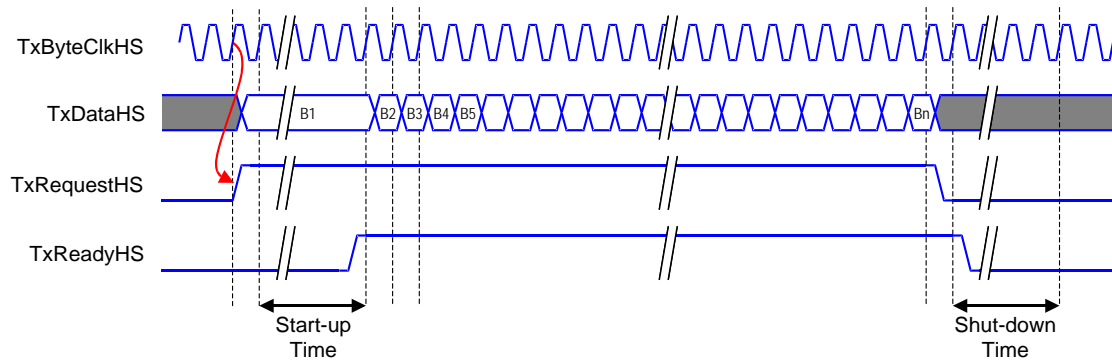
Symbol	Dir	Categories	Description
Escape Mode Receive Signals			
RxCkEsc	O	MXXY SXXX	Escape mode Receive Clock. This signal is used to transfer received data to the protocol during escape mode. This “clock” is generated from the two Low-Power signals in the Lane interconnect. Because of the asynchronous nature of Escape mode data transmission, this “clock” may not be periodic.
RxLpdtEsc	O	MXXA SXAX	Escape Low-Power Data Receive mode. This active high signal is asserted to indicate that the Lane Module is in Low-Power data receive mode. While in this mode, received data bytes are driven onto the RxDataEsc output when RxValidEsc is active. The Lane Module remains in this mode with RxLpdtEsc asserted until a Stop state is detected on the Lane interconnect.
RxUlpsEsc	O	MXXY SXXX	Escape Ultra-Low Power (Receive) mode. This active high signal is asserted to indicate that the Lane Module has entered the Ultra-Low Power State. The Lane Module remains in this mode with RxUlpsEsc asserted until a Stop state is detected on the Lane interconnect.
RxTriggerEsc[3:0]	O	MXXY SXXX	Escape mode Receive Trigger 0-3. These active high signals indicate that a trigger event has been received. The asserted RxTriggerEsc signal remains active until a Stop state is detected on the Lane interconnect.
RxDataEsc[7:0]	O	MXXA SXAX	Escape mode Receive Data. This is the eight-bit escape mode Low-Power data received by the Lane Module. The signal connected to RxDataEsc[0] was received first. Data is transferred on rising edges of RxCkEsc.
RxValidEsc	O	MXXA SXAX	Escape mode Receive Data Valid. This active high signal indicates that the Lane Module is driving valid data to the protocol on the RxDataEsc output. There is no “RxReadyEsc” signal, and the protocol is expected to capture RxDataEsc on every rising edge of RxCkEsc where RxValidEsc is asserted. There is no provision for the protocol to slow down (“throttle”) the receive data.
Control Signals			
TurnRequest	I	XRXX XFXY	Turn Around Request. This active high signal is used to indicate that the protocol desires to turn the Lane around, allowing the other side to begin transmission. TurnRequest is valid on rising edges of TxClkEsc. TurnRequest is only meaningful for a Lane Module that is currently the transmitter (Direction=0). If the Lane Module is in receive mode (Direction=1), this signal is ignored.
Direction	O	XRXX XFXY	Transmit/Receive Direction. This signal is used to indicate the current direction of the Lane interconnect. When Direction=0, the Lane is in transmit mode (0=Output). When Direction=1, the Lane is in receive mode (1=Input).

Symbol	Dir	Categories	Description
TurnDisable	I	XRXX XFXY	Disable Turn-around. This signal is used to prevent a (bi-directional) Lane from going into transmit mode – even if it observes a turn-around request on the Lane interconnect. This is useful to prevent a potential “lock-up” situation when a unidirectional Lane Module is connected to a bi-directional Lane Module.
ForceRxmode	I	MRXX MXXY SXXX	Force Lane Module Into Receive mode / Wait for Stop state. This signal allows the protocol to initialize a Lane Module, or force a bi-directional Lane Module, into receive mode. This signal is used during initialization or to resolve a contention situation. When this signal is high, the Lane Module immediately transitions into receive control mode and waits for a Stop state to appear on the Lane interconnect. When used for initialization, this signal should be released, i.e. driven low, only when the Dp & Dn inputs are in Stop state for a time T_{INIT} , or longer.
ForceTxStopmode	I	MXXX SRXX SXXY	Force Lane Module Into Transmit mode / Generate Stop state. This signal allows the protocol to force a Lane Module into transmit mode and Stop state during initialization or following an error situation, e.g. expired time out. When this signal is high, the Lane Module immediately transitions into transmit mode and the module state machine is forced into the Stop state.
Stopstate	O	XXXX XCNN	Lane is in Stop state. This active high signal indicates that the Lane Module, regardless of whether the Lane Module is a transmitter or a receiver, is currently in Stop state. Note that this signal is asynchronous to any clock in the PPI interface. Also, the protocol may use this signal to indirectly determine if the PHY line levels are in the LP-11 state.
Enable	I	XXXX XCNN	Enable Lane Module. This active high signal forces the Lane Module out of “shutdown”. All line drivers, receivers, terminators, and contention detectors are turned off when Enable is low. Furthermore, while Enable is low, all other PPI inputs are ignored and all PPI outputs are driven to the default inactive state. Enable is a level sensitive signal and does not depend on any clock.
TxUlpClk	I	MCNN	Transmit Ultra-Low Power State on Clock Lane. This active high signal is asserted to cause a Clock Lane Module to enter the Ultra-Low Power State. The Lane Module remains in this mode until TxUlpClk is de-asserted.
RxUlpClkNot	O	SCNN	Receive Ultra-Low Power State on Clock Lane. This active low signal is asserted to indicate that the Clock Lane Module has entered the Ultra-Low Power State. The Lane Module remains in this mode with RxUlpClkNot asserted until a Stop state is detected on the Lane Interconnect.

Symbol	Dir	Categories	Description
UlpActiveNot	O	XXXX XCNN	<p>ULP State (not) Active.</p> <p>This active low signal is asserted to indicate that the Lane is in ULP state.</p> <p>For a transmitter, this signal is asserted some time after TxUlpEsc and TxRequestEsc (TxUlpClk for a Clock Lane) are asserted. The transmitting PHY continues to supply TxClkEsc until UlpActiveNot is asserted. In order to leave ULP state, the transmitter first drives TxUlpExit high, then waits for UlpActiveNot to become high (inactive). At that point, the transmitting PHY is active and has started transmitting a Mark-1 on the Lines. The protocol waits for a time Twakeup and then drives TxRequestEsc (TxUlpClk) inactive to return the Lane to Stop state.</p> <p>For a receiver, this signal indicates that the Lane is in ULP state. At the beginning of ULP state, UlpActiveNot is asserted together with RxUlpEsc, or RxUlpClkNot for a Clock Lane. At the end of the ULP state, this signal becomes inactive to indicate that the Mark-1 state has been observed. Later, after a period of time Twakeup, the RxUlpEsc (or RxUlpClkNot) signal is deasserted.</p>
Error Signals			
ErrSotHS	O	MRXX SXXX	<p>Start-of-Transmission (SoT) Error.</p> <p>If the High-Speed SoT leader sequence is corrupted, but in such a way that proper synchronization can still be achieved, this active high signal is asserted for one cycle of RxByteClkHS. This is considered to be a "soft error" in the leader sequence and confidence in the payload data is reduced.</p>
ErrSotSyncHS	O	MRXX SXXX	<p>Start-of-Transmission Synchronization Error.</p> <p>If the High-Speed SoT leader sequence is corrupted in a way that proper synchronization cannot be expected, this active high signal is asserted for one cycle of RxByteClkHS.</p>
ErrEsc	O	MXXY SXXX	<p>Escape Entry Error.</p> <p>If an unrecognized escape entry command is received, this active high signal is asserted and remains asserted until the next change in line state.</p>
ErrSyncEsc	O	MXXA SXAX	<p>Low-Power Data Transmission Synchronization Error.</p> <p>If the number of bits received during a Low-Power data transmission is not a multiple of eight when the transmission ends, this active high signal is asserted and remains asserted until the next change in line state.</p>
ErrControl	O	MXXY SXXX	<p>Control Error.</p> <p>This active high signal is asserted when an incorrect line state sequence is detected. For example, if a turn-around request or escape mode request is immediately followed by a Stop state instead of the required Bridge state, this signal is asserted and remains asserted until the next change in line state.</p>
ErrContentionLP0	O	MXXX SXXY	<p>LP0 Contention Error.</p> <p>This active high signal is asserted when the Lane Module detects a contention situation on a line while trying to drive the line low.</p>
ErrContentionLP1	O	MXXX SXXY	<p>LP1 Contention Error.</p> <p>This active high signal is asserted when the Lane Module detects a contention situation on a line while trying to drive the line high.</p>

A.2 High-Speed Transmit from the Master Side

1172 Figure 58 shows an example of a High-Speed transmission on the Master side. While TxRequestHS is low,
1173 the Lane Module ignores the value of TxDataHS. To begin transmission, the protocol drives TxDataHS
1174 with the first byte of data and asserts TxRequestHS. This data byte is accepted by the PHY on the first
1175 rising edge of TxByteClkHS with TxReadyHS also asserted. At this point, the protocol logic drives the next
1176 data byte onto TxDataHS. After every rising clock cycle with TxReadyHS active, the protocol supplies a
1177 new valid data byte or ends the transmission. After the last data byte has been transferred to the Lane
1178 Module, TxRequestHS is driven low to cause the Lane Module to stop the transmission and enter Stop
1179 state. The minimum number of bytes transmitted could be as small as one.



1180

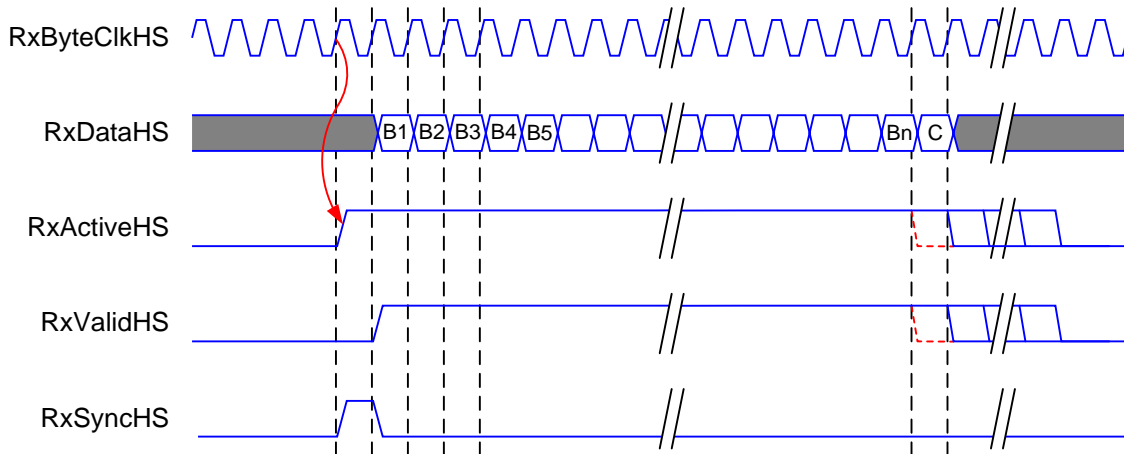
Figure 58 Example High-Speed Transmission from the Master Side

A.3 High-Speed Receive at the Slave Side

1181 Figure 59 shows an example of a High-Speed reception at the Slave side. The RxActiveHS signal indicates
1182 that a receive operation is occurring. A normal reception starts with a pulse on RxSyncHS followed by
1183 valid receive data on subsequent cycles of RxByteClkHS. Note that the protocol is prepared to receive all
1184 of the data. There is no method for the receiving protocol to pause or slow data reception.

1185 If EoT Processing is performed inside the PHY, the RxActiveHS and RxValidHS signals transition low
1186 following the last valid data byte, Bn. See Figure 59.

1187 If EoT processing is not performed in the PHY, one or more additional bytes are presented after the last
1188 valid data byte. The first of these additional bytes, shown as byte “C” in Figure 59, is all ones or all zeros.
1189 Subsequent bytes may or may not be present, and can have any value. For a PHY that does not perform
1190 EoT processing, the RxActiveHS and RxValidHS signals transition low simultaneously some time after
1191 byte “C” is received. Once these signals have transitioned low, they remain low until the next High-Speed
1192 data reception begins.

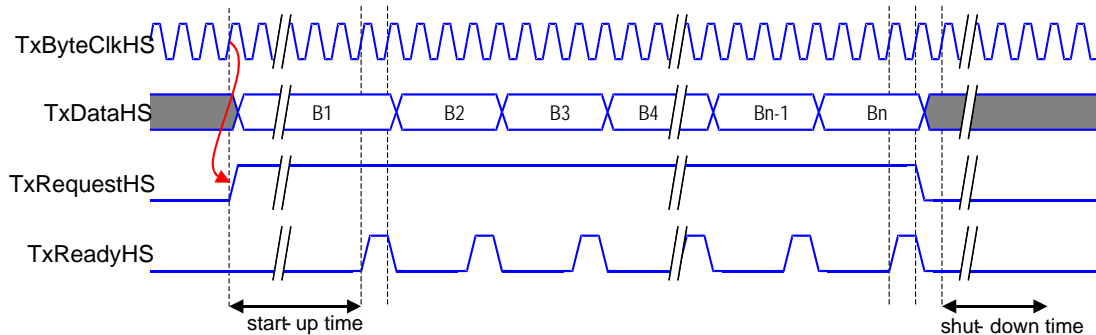


1193

Figure 59 Example High-Speed Receive at the Slave Side

A.4 High-Speed Transmit from the Slave Side

1194 A Slave can only transmit at one-fourth the bandwidth of a Master. Because of this, the TxReadyHS signal
 1195 is not constant high for a transmitting slave. Otherwise, the transmission is very much like that seen at the
 1196 PPI interface of a transmitting Master-side Lane Module. Figure 60 shows an example of transmitting from
 1197 the Slave side.

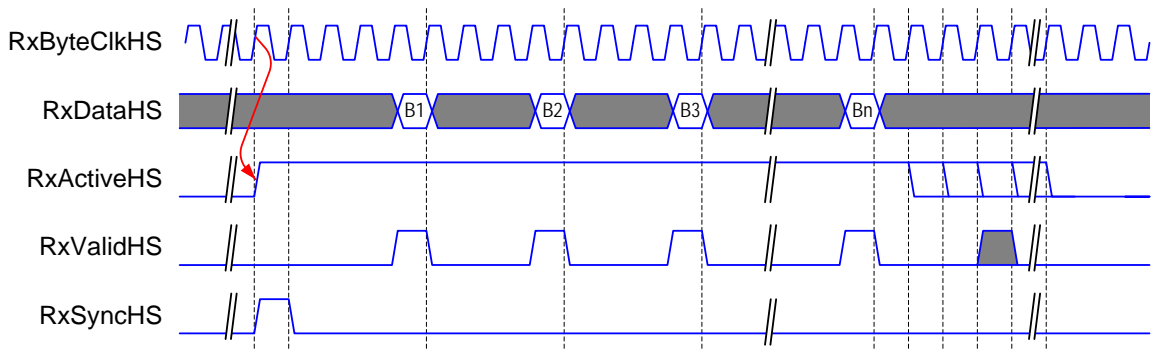


1198

Figure 60 Example High-Speed Transmit from the Slave Side

A.5 High-Speed Receive at the Master Side

1199 Because a Slave is restricted to transmitting at one-fourth the bandwidth of a Master, the RxValidHS signal
 1200 is only asserted one out of every four cycles of RxByteClkHS during a High-Speed receive operation at the
 1201 Master side. An example of this is shown in Figure 61. Note that, depending on the bit rate, there may be
 1202 one or more extra pulses on RxValidHS after the last valid byte, Bn, is received.

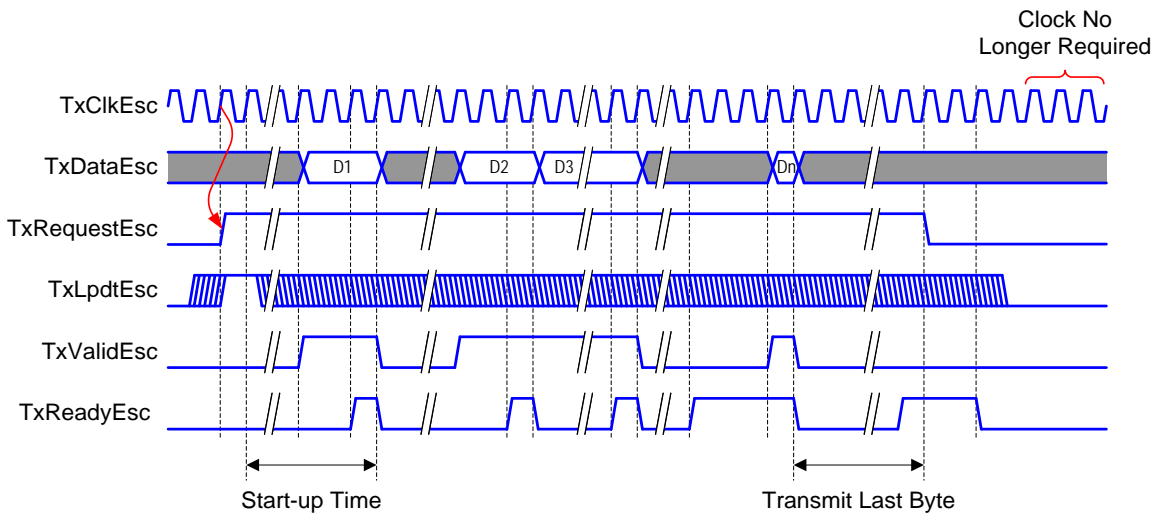


1203

Figure 61 Example High-Speed Receive at the Master Side

A.6 Low-Power Data Transmission

1204 For Low-Power data transmission the TxClkEsc is used instead of TxDDRClkHS-I/Q and TxByteClkHS.
 1205 Furthermore, while the High-Speed interface signal TxRequestHS serves as both a transmit request and a
 1206 data valid signal, on the Low-Power interface two separate signals are used. The Protocol directs the Data
 1207 Lane to enter Low-Power data transmission Escape mode by asserting TxRequestEsc with TxLpdtEsc high.
 1208 The Low-Power transmit data is transferred on the TxDataEsc lines when TxValidEsc and TxReadyEsc are
 1209 both active at a rising edge of TxClkEsc. The byte is transmitted in the time after the TxDataEsc is accepted
 1210 by the Lane Module (TxValidEsc = TxReadyEsc = high) and therefore the TxClkEsc continues running for
 1211 some minimum time after the last byte is transmitted. The Protocol knows the byte transmission is finished
 1212 when TxReadyEsc is asserted. After the last byte has been transmitted, the protocol de-asserts
 1213 TxRequestEsc to end the Low-Power data transmission. This causes TxReadyEsc to return low, after which
 1214 the TxClkEsc clock is no longer needed. Whenever TxRequestEsc transitions from high-to-low, it always
 1215 remains in the low state for a minimum of two TxClkEsc clock cycles. Figure 62 shows an example Low-
 1216 Power data transmission operation.



1217

Figure 62 Low-Power Data Transmission

A.7 Low-Power Data Reception

1218 Figure 63 shows an example Low-Power data reception. In this example, a Low-Power escape “clock” is
 1219 generated from the Lane Interconnect by the logical exclusive-OR of the Dp and Dn lines. This “clock” is

1220 used within the Lane Module to capture the transmitted data. In this example, the “clock” is also used to
 1221 generate RxClkEsc.
 1222 The signal RxLpdtEsc is asserted when the escape entry command is detected and stays high until the Lane
 1223 returns to Stop state, indicating that the transmission has finished. It is important to note that because of the
 1224 asynchronous nature of Escape mode transmission, the RxClkEsc signal can stop at anytime in either the
 1225 high or low state. This is most likely to happen just after a byte has been received, but it could happen at
 1226 other times as well.

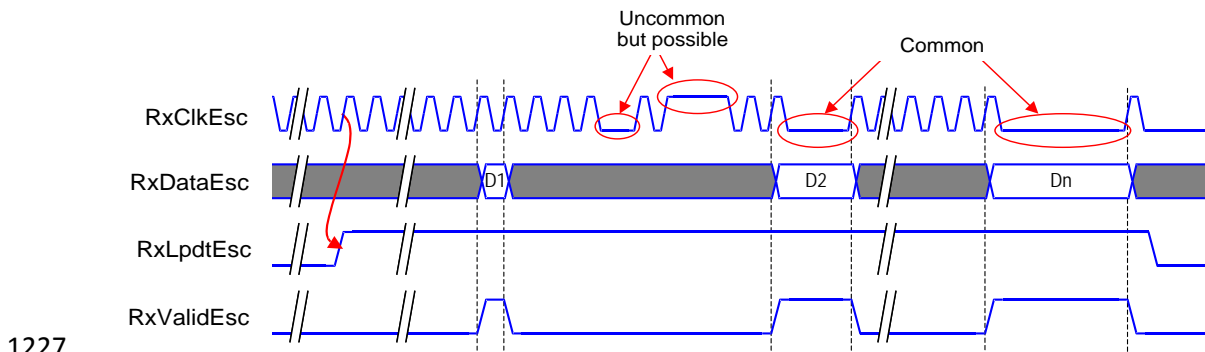


Figure 63 Example Low-Power Data Reception

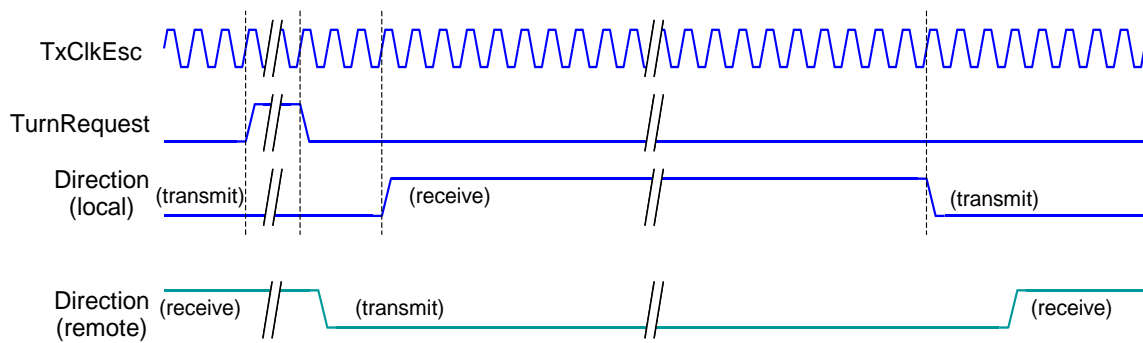
A.8 Turn-around

1228 If the Master side and Slave side Lane Modules are both bi-directional, it is possible to turn around the
 1229 Link for High-Speed and/or Escape mode signaling. As explained in Section 6.5, which side is allowed to
 1230 transmit is determined by passing a “token” back and forth. That is, the side currently transmitting passes
 1231 the token to the receiving side. If the receiving side acknowledges the turn-around request, as indicated by
 1232 driving the appropriate line state, the direction is switched.

1233 Figure 64 shows an example of two turn-around events. At the beginning, the local side is the transmitter,
 1234 as shown by Direction=0. When the protocol on this side wishes to turn the Lane around (i.e. give the token
 1235 to the other side), it asserts TurnRequest for at least one cycle of TxClkEsc. This initiates the turn-around
 1236 procedure. The remote side acknowledges the turn-around request by driving the appropriate states on the
 1237 Lines. When this happens, the local Direction signal changes from transmit (0) to receive (1).

1238 Later in the example of Figure 64, the remote side initiates a turn-around request, passing the token back to
 1239 the local side. When this happens, the local Direction signal changes back to transmit (0). Note that there is
 1240 no prescribed way for a receiver to request access to the Link. The current transmitter is in control of the
 1241 Link direction and decides when to turn the Link around, passing control to the receiver.

1242 If the remote side does not acknowledge the turn-around request, the Direction signal does not change.

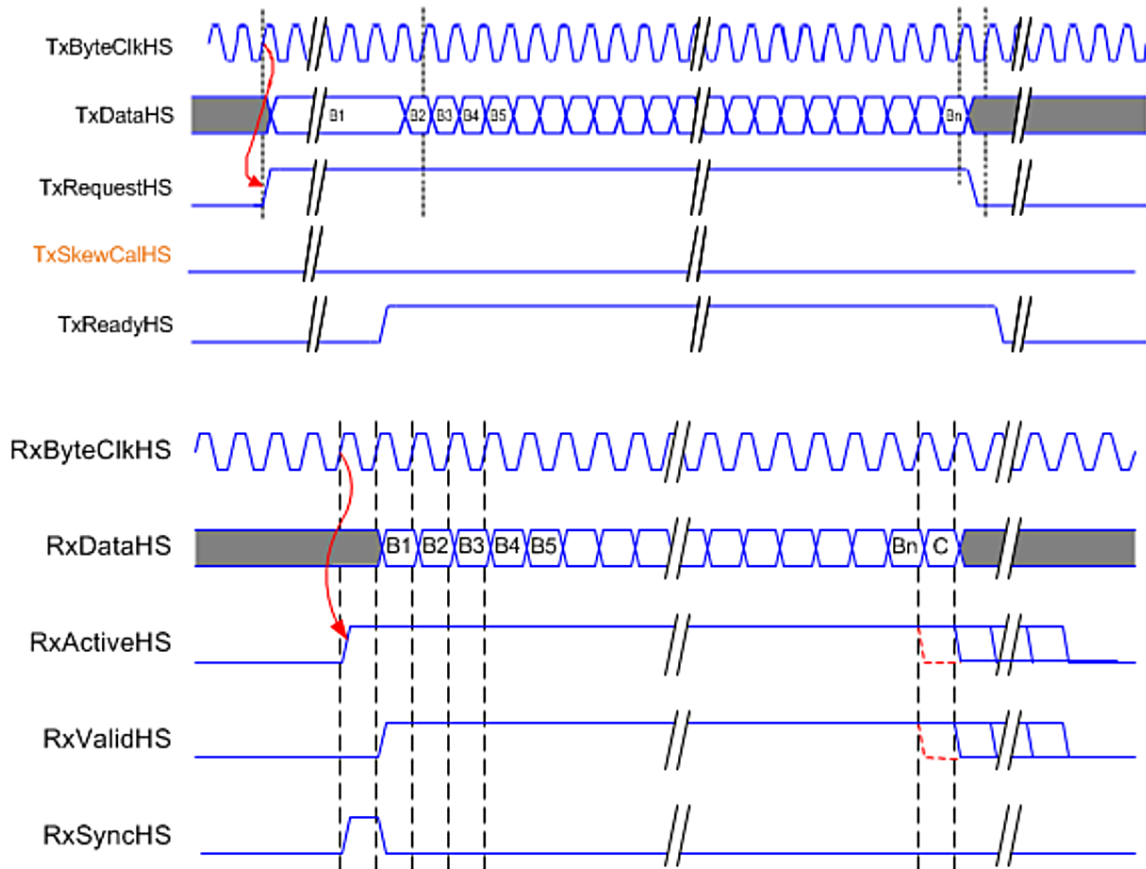


1243
1244

Figure 64 Example Turn-around Actions Transmit-to-Receive and Back to Transmit

A.9 Calibration

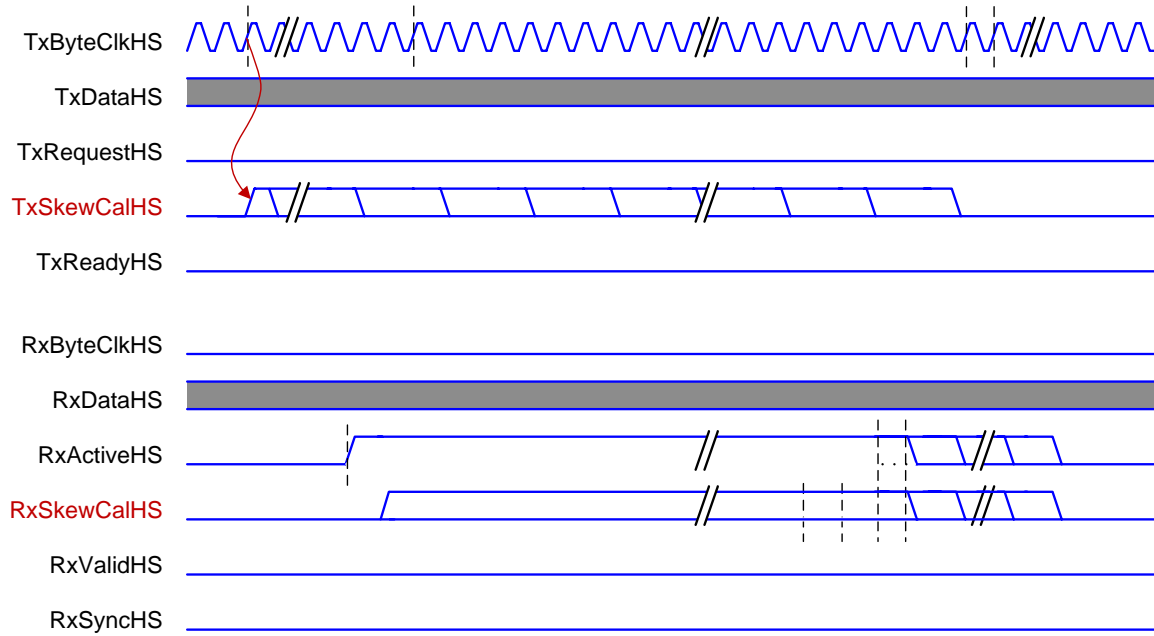
1245 Initiation of periodic deskew calibration from the transmitter can be done using the TxSkewCalHS pin on
1246 the PPI interface. This is an optional signal pin, and periodic deskew is an optional feature. Receiver
1247 deskew can be by-passable using the receiver configuration control. Figure 65 shows the PPI signal outputs
1248 as they operate during high-speed data transmission in normal mode.



1249

Figure 65 Periodic Skew Calibration - PPI Signal in Normal Mode

1250 Figure 66 shows the PPI signal outputs as they operate during high-speed data transmission during skew calibration.
 1251 PPI outputs such as TxReadyHS, RxActiveHS, RxValidHS, and RxSyncHS are held to 1_B
 1252 during skew calibration.



1253

Figure 66 Periodic Skew Calibration - PPI Signal during Skew Calibration

Annex B Interconnect Design Guidelines (informative)

1254 This appendix contains design guidelines in order to meet the interconnect requirements as specified in
1255 Section 8.

B.1 Practical Distances

1256 The maximum Lane flight time is defined at two nanoseconds. Assuming less than 100ps wiring delay
1257 within the RX-TX modules each, the physical distance that can be bridged with external interconnect is
1258 around $54\text{cm}/\sqrt{\epsilon}$. For most practical PCB and flex materials this corresponds to maximum distances around
1259 25-30 cm.

B.2 RF Frequency Bands: Interference

1260 On one side of the Lane there are the RF interference frequencies, which disturb the signals of the Lane.
1261 Most likely the dominant interferers are the transmit band frequencies of wireless interconnect standards.
1262 On the other side there are the frequencies for which generated EMI by the Lane should be as low as
1263 possible because very weak signals in these bands must be received by the radio IC. Some important
1264 frequency bands are:

1265 Transmit Bands

- 1266 • GSM 850 (824-849 MHz)
- 1267 • GSM 900 (880-915 MHz)
- 1268 • GSM DCS (1710-1785 MHz)
- 1269 • GSM PCS (1850-1910 MHz)
- 1270 • WCDMA (1920-1980 MHz)
- 1271 • FLASH-OFDM, GSM (450 MHz)

1272 Receive Bands:

- 1273 • GSM 850 (869-894 MHz)
- 1274 • GSM 900 (925-960 MHz)
- 1275 • GSM DCS (1805-1880 MHz)
- 1276 • GSM PCS (1930-1990 MHz)
- 1277 • WCDMA (2110-2170 MHz)
- 1278 • GPS (1574-1577 MHz)

1279 It is important to identify the lowest interference frequency with significant impact, as this sets ' f_{INTMIN} '.
1280 For this specification, $f_{\text{INT,MIN}}$ is decided to be 450 MHz, because this frequency will most likely be used as
1281 the new WCDMA band in the USA in the future.

B.3 Transmission Line Design

1282 In most cases the transmission lines will either be designed as striplines and/or micro-striplines. The
1283 coupling between neighboring lines within a pair is small if the distance between them is $>2x$ the dielectric
1284 thickness. For the separation of multiple pairs it is highly recommended to interleave the pairs with a
1285 ground or supply line in order to reduce coupling.

B.4 Reference Layer

1286 In order to achieve good signal integrity and low EMI it is recommended that either a ground plane or a
1287 ground signal is in close proximity of any signal line.

B.5 Printed-Circuit Board

1288 For boards with a large number of conductor layers the dielectric spacing between layers may become so
1289 small that it would be hard to meet the characteristic impedance requirements. In those cases a micro-
1290 stripline in the top or bottom layers may be a better solution.

B.6 Flex-foils

1291 Either two conductor layers or a reasonable connected cover layer makes it much easier to meet the
1292 specifications

B.7 Series Resistance

1293 The DC series resistance of the interconnect should be less than 5 Ohms in order to meet the specifications.
1294 It is strongly recommended to keep the resistance in the ground connection below 0.2 Ohm. Furthermore, it
1295 is recommended that the DC ground shift be less than 50mV, which may require an even lower value if a
1296 large current is flowing through this ground. The lower this ground series resistance value can be made, the
1297 better it is for reliability and robustness.

B.8 Connectors

1298 Connectors usually cause some impedance discontinuity. It is important to carefully minimize these
1299 discontinuities by design, especially with respect to the through-connection of the reference layer. Although
1300 connectors are typically rather small in size, the wrong choice can mess-up signals completely. Please note
1301 that the contact resistance of connectors is part of the total series resistance budget and should therefore be
1302 sufficiently low.

Annex C 8b9b Line Coding for D-PHY (normative)

1303 Raw data transmission without constraining the data set does not allow in-band control signaling (control
1304 symbols inserted into the data stream) during transmission. Line coding conditions the possible bit
1305 sequences on the wires and provides reserved codes to include additional control features. Useful additional
1306 features may be, for example, idle symbols, specific-event identifiers, sync patterns, and protocol markers.
1307 Comma codes, bit sequences that do not appear anywhere in the data stream (in the absence of bit errors)
1308 unless these are intentionally transmitted, provide synchronization features and are very useful to increase
1309 robustness.
1310 Furthermore, a line-coding scheme that guarantees a minimum edge density improves the signaling quality
1311 and enables skew calibration in the PHY.
1312 Figure 67 shows how the line coding sub-layer fits into the standard hierarchy. The line coding can be
1313 considered as a separate sub-layer on top of the basic D-PHY. Optimizations by merging layers are allowed
1314 if the resulting solution complies with the PHY specification. These optimization choices are left to
1315 implementers.

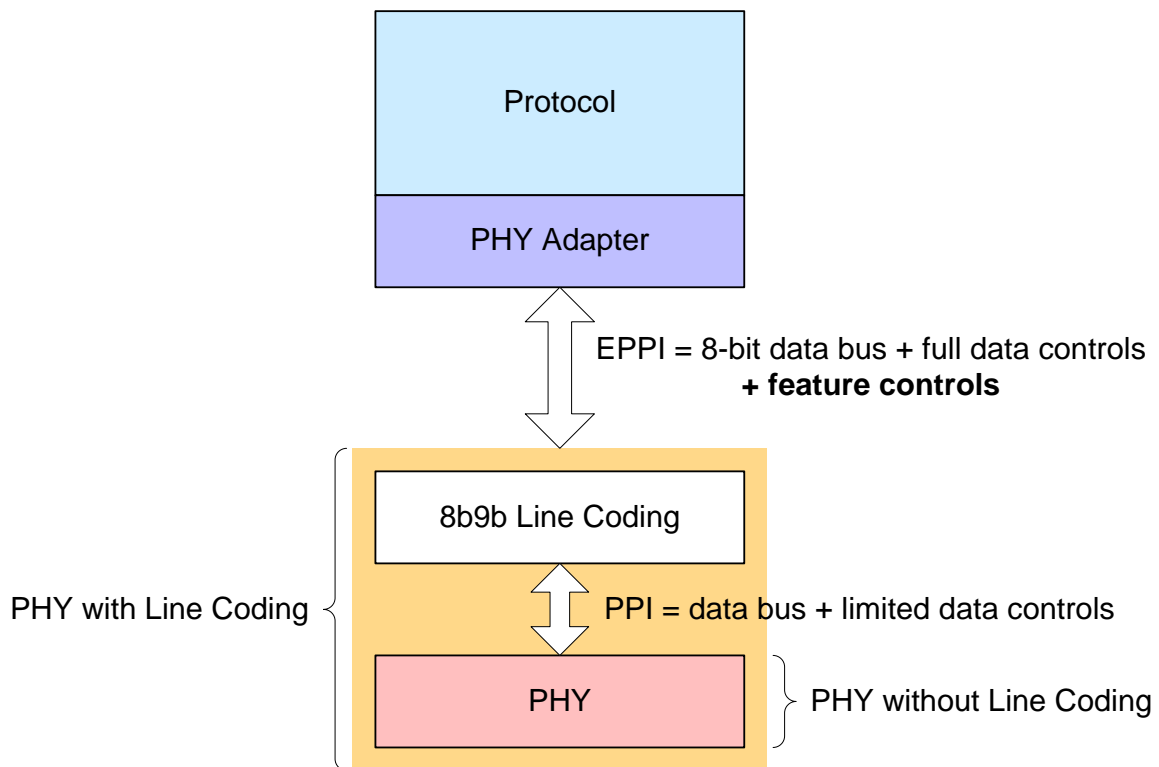


Figure 67 Line Coding Layer

1318 Note that the line coding sub-layer is optional. Protocols may exploit only the baseline PHY without line
1319 coding. This feature is provided for compatibility with existing protocols. However, in case a protocol
1320 decides to use line coding, it shall be implemented as described in this annex.
1321 The PHY-protocol interface above the line coding sub-layer (EPPI) is very similar to the PPI. Some
1322 additional signals enable a more functional and flexible control of the PHY with Line Coding. For details of
1323 the EPPI see Section C.5.

C.1 Line Coding Features

1324 The 8b9b line coding scheme provides features to both the PHY and protocol layers.

C.1.1 Enabled Features for the Protocol

- 1325 • Comma code marker for special protocol features
- 1326 • Word synchronization/resynchronization during transmission bursts
- 1327 • Automatic idling support; no need for TX to always provide valid data during transmission
- 1328 • Possibility for future PHY compatible PHY-Protocol Interface (PPI)

C.1.2 Enabled Features for the PHY

- 1329 • On-the-fly word resynchronization
- 1330 • Simplification of EoT signaling
- 1331 • Reduced latency
- 1332 • Automatic idle symbol insertion and removal in absence of data
- 1333 • Skew calibration in the RX possible

C.2 Coding Scheme

1334 This section describes the details of the coding scheme.

C.2.1 8b9b Coding Properties

1335 The 8b9b coding has the following properties:

- 1336 • All code words are nine bits long. Data is encoded byte-wise into 9-bit words, which corresponds
1337 to a 12.5% coding overhead.
- 1338 • Sixteen regular exception codes, i.e. code words that do not appear as regular data words, but
1339 require word sync for reliable recognition, are available.
- 1340 • Six unique exception codes, i.e. code words that do not appear within any sliding window except
1341 when that code word is transmitted, are available.
- 1342 • Guaranteed minimum edge density of at least two polarity transitions per word. Therefore, each
1343 word contains at least two ones and two zeros.
- 1344 • Simple logical functions for encoding and decoding
- 1345 • Run length is limited to a maximum of seven bits. Data codes have a maximum run length of five
1346 bits, unique exception codes have run lengths of six or seven bits.

C.2.2 Data Codes: Basic Code Set

1347 Assume the following notation for the input data word and the coded data word:

- 1348 • 8-bit data byte: $[B_1 B_2 B_3 X_1 X_2 Q_1 Q_2 Q_3]$
- 1349 • 9-bit code word: $[B_1 X_1 Y_1 Y_2 B_2 B_3 Y_3 Y_4 X_2]$

1350 The 256 data codes are denoted by D_{xxx} , where xxx is the value of the corresponding 8-bit data byte.

1351 The 8-bit data byte shall be the input for the encoding, and result of the decoding, function. There can be
1352 any arbitrary bijective 8b-to-8b logical transformation function between real source data bytes from the
1353 protocol and the input data bytes for encoding, as long as the inverse function is present at the receiver side.
1354 If such a function is used, it shall be defined in the protocol specification.

1355 The bits $\{B_1, B_2, B_3, X_1, X_2\}$ appear directly in the code words as can be seen in the code word structure.

1356 $\{Q_1, Q_2, Q_3\}$ are the remaining three bits in the data byte, which are encoded into $\{Y_1, Y_2, Y_3, Y_4\}$ using
1357 $\{X_1, X_2\}$. The decoding of $\{Y_1, Y_2, Y_3, Y_4\}$ into $\{Q_1, Q_2, Q_3\}$ does not require $\{X_1, X_2\}$.

1358 The relation between Q_i, X_i and Y_i is shown in Table 32.

1359

Table 32 Encoding Table for 8b9b Line Coding of Data Words

8-bit Data Byte							9-bit Code Word, Y bits					
B ₁	B ₂	B ₃	X ₁	X ₂	Q ₁	Q ₂	Q ₃	Y ₁	Y ₂	Y ₃	Y ₄	
x	x	x	x	1	1	1	0	0	1	0	0	
				0						1	1	
				x	0	1	0			0	1	0
					1	0	0			0	1	0
x	x	x	x	1	1	1	1	1	0	0	0	
				0						1	1	
				x	0	1	1			0	1	
					1	0	1			1	0	
x	x	x	x	0	0	0	0	1	1	0	1	
				1						0	0	
				0	0	0	1			1	1	0
					1	0	0			1	0	0

Note:

x = don't care

1360 The logical relation for encoding between {Q₁, Q₂, Q₃, X₁, X₂} and {Y₁, Y₂, Y₃, Y₄} is given by the
1361 following equations:

1362 $Y_1 = (\sim Q_1 \& \sim Q_2 \& \sim X_1) \mid (Q_1 \& Q_3) \mid (Q_2 \& Q_3)$

1363 $Y_2 = (\sim Q_1 \& \sim Q_2 \& \sim X_1) \mid (Q_1 \& \sim Q_3) \mid (Q_2 \& \sim Q_3)$

1364 $Y_3 = (Q_1 \& \sim Q_2) \mid (Q_1 \& Q_2 \& \sim X_2) \mid (\sim Q_2 \& Q_3)$

1365 $Y_4 = (\sim Q_1 \& Q_2) \mid (Q_1 \& Q_2 \& \sim X_2) \mid (\sim Q_1 \& \sim Q_3)$

1366 The logical relation for decoding between {Y₁, Y₂, Y₃, Y₄} and {Q₁, Q₂, Q₃} is:

1367 $Q_1 = (Y_1 \wedge Y_2) \& \sim(\sim Y_3 \& Y_4)$

1368 $Q_2 = (Y_1 \wedge Y_2) \& \sim(Y_3 \& \sim Y_4)$

1369 $Q_3 = (Y_1 \& \sim Y_2) \mid (Y_1 \& Y_2 \& Y_3) \mid (\sim Y_1 \& \sim Y_2 \& Y_3)$

1370 $= (Y_1 \& \sim Y_2) \mid (\sim(Y_1 \wedge Y_2) \& Y_3)$

1371 These logical functions show that the encoding and decoding can be implemented with a few dozen logic
1372 gates and therefore do not require additional hardware such as a lookup table or storage of history data.

C.2.3 Comma Codes: Unique Exception Codes

1373 Unique means that these codes are uniquely identifiable in the data stream because these sequences do not
1374 occur in any encoding or across word boundaries, assuming no bits are corrupted. The data-encoding
1375 scheme described in Section C.2.2 enables a very simple run-length limit based unique exception code
1376 mechanism.

1377 There are four code sequences available, called Type A Comma codes, with a run length of six bits, and two
1378 code sequences, called Type B Comma codes, with a run length of seven bits. Currently, four Comma codes
1379 are sufficient to cover the required features and therefore only Type A Comma codes are used. Type B
1380 Comma codes are reserved for future use.

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Table 33 Comma Codes

Type	Run Length, bits	Code Name	Comma code	Feature
Type A	6	C600	0 1111 1100	Protocol
		C611	1 0000 0011	EoT
		C610	1 0000 0010	Idle/Sync 1
		C601	0 1111 1101	Idle/Sync 2
Type B	7	C701	1 0000 0001	Reserved 1
		C710	0 1111 1110	Reserved 2

C.2.4 Control Codes: Regular Exception Codes

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The normal data set does not use all codes with a maximum run-length of five bits. There are two combinations of the $\{X_i, Y_i\}$ bits that do not appear in any data code word that are available as regular exception codes. Since Comma Codes are defined to have a run-length of six or seven bits, this gives three freely usable bits per code word and results in $2^3=8$ different Regular Exception Codes. The syntax of the Regular Exception Code words is given in Table 34, where the bits B_1 , B_2 and B_3 can have any binary value.

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Table 34 Regular Exception Code Structure

	X_1	Y_1	Y_2		Y_3	Y_4	Y_2	Code Name	
B_1	0	1	1	B_2	B_3	0	0	1	C410-C417
B_1	1	0	0	B_2	B_3	1	1	0	C400-C407

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These code words are not unique sequences like the Comma codes described in Table 33, but can only be used as exception codes if word sync is already accomplished. These codes are currently reserved and not yet allocated to any function.

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C.2.5 Complete Coding Scheme

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The complete code table can be found in Table 36.

C.3 Operation with the D-PHY

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The line coding impacts the payload of transmission bursts. Section C.3.1 described the generic issues for both HS and LP transmission. Section C.3.2 and Section C.3.3 describe specific details for HS and LP transmission, respectively.

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C.3.1 Payload: Data and Control

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The payload of a HS or LP transmission burst consists of concatenated serialized 9-bit symbols, representing both data and control information.

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C.3.1.1 Idle/Sync Comma Symbols

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Idle/Sync Comma code words can be present as symbols within the payload of a transmission burst. These symbols are inserted either on specific request of the protocol, or autonomously when there is a transmission request but there is no valid data available either at the beginning, or anywhere, during transmission. The Idle pattern in the latter case is an alternating C601 and C610 sequence, until there is valid data available to transmit, or transmission has ended. Idle periods may begin with either of the two prescribed Idle symbols. The RX-side PHY shall remove Idle/Sync symbols from the stream and flag these events to the protocol.

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C.3.1.2 Protocol Marker Comma Symbol

1405 Comma symbol C600 (Protocol Marker) is allocated for use by protocols on top of the D-PHY. This
1406 symbol shall be inserted in the stream on request of the TX-side protocol and flagged by the receiving PHY
1407 to the RX-side protocol.

C.3.1.3 EoT Marker

1408 Comma symbol C611 is allocated as the EoT Marker symbol.

C.3.2 Details for HS Transmission

C.3.2.1 SoT

1409 The SoT procedure remains the same as the raw data D-PHY SoT. See Section 6.4.2. The SoT sequence
1410 itself is NOT encoded, but can be easily recognized.

1411 The first bit of the first transmitted code symbol of a burst shall be aligned with the rising edge of the DDR
1412 clock.

C.3.2.2 HS Transmission Payload

1413 The transmitted burst shall consist of concatenated serialized 9-bit symbols as described in Section C.3.1.

1414 The TX-side PHY can idle by sending the Idle sequences as described in Section C.3.1.1

C.3.2.3 EoT

1415 The TX-side PHY shall insert an EoT marker symbol at the moment the request for HS transmission is
1416 withdrawn. The transmitter can pad additional bits after this EoT-Marker symbol before actually switching
1417 to LP mode (EoT sequence).

1418 The RX-side PHY shall remove the EoT-Marker symbol and any additional bits appearing after it. Note that
1419 with line coding, EoT-processing by backtracking on LP-11 detection to avoid (unreliable) non-payload bits
1420 on the PPI is no longer required as the EoT marker symbol notifies the RX-side PHY before the End-of-
1421 Transmission.

C.3.3 Details for LP Transmission

C.3.3.1 SoT

1422 The start of LP transmission is identical to basic D-PHY operation.

C.3.3.2 LP Transmission Payload

1423 The transmitted burst shall consist of concatenated serialized 9-bit symbols as described in Section C.3.1.

1424 During LPDT, the TX-side PHY can idle in two ways: either it can send the Idle sequences as described in
1425 Section C.3.1.1 and implicitly provide a clock signal to the RX-side PHY, or it can pause the transmission
1426 by keeping the Lines at LP-00 (Space) for a certain period of time between bits, which interrupts the clock
1427 on the RX side, but minimizes power consumption.

C.3.3.3 EoT

1428 The TX-side PHY shall insert an EoT marker symbol at the moment the request for LP transmission is
1429 withdrawn. The TX-side PHY can pad additional (spaced-one-hot) bits after the EoT-Marker symbol before
1430 actually ending the transmission by switching via Mark to Stop state (End of LPDT procedure).

1431 The RX-side PHY shall remove the EoT-marker symbol and any additional bits appearing after it.

C.4 Error Signaling

1432 The usage of a line code scheme enables the detection of many signaling errors. These errors include:

- 1433 • Non-existing code words
- 1434 • Non-aligned Comma symbols
- 1435 • EoT detection without detection of EoT-Marker

1436 Detection and flagging of errors is not required, but may help the protocol to recover faster from an error
1437 situation.

C.5 Extended PPI

1438 The interface to the protocol shall be extended with functional handles (TX) and flags (RX) to manage the
1439 usage of Comma symbols. Whenever necessary, the transmitting PHY can hold the data delivery from the
1440 protocol to the TX PHY with the TxReadyHS or TxReadyEsc signal. This is already provided for in the
1441 current PPI.

1442 The PPI shall be extended with a TX Valid signal for HS data transmission, TxValidHS. Encoded operation
1443 allows for Idling of the Link when there is no new valid data. If the transmitter is ready and the provided
1444 data is not valid, an Idle symbol shall be inserted into the stream. Note, contrary to the basic PHY PPI, the
1445 Valid signals for a coded PHY can be actively used to manage the data on both TX and RX sides. This
1446 arrangement provides more flexibility to the PHY and Protocol layers. For LPDT, this Valid signaling
1447 already exists in the PPI. Addition of TxValidHS signal eliminates the constraint in the PPI description for
1448 TxRequestHS that the “protocol always provides valid data”.

1449 On the RX side, errors may be flagged to the protocol in case unexpected sequences are observed. Although
1450 many different errors are detectable, it is not required that all these errors flags be implemented. The
1451 number of error flags implemented depends on the cost/benefit trade-off to be made by the implementer.
1452 These error features do not impact compliance of the D-PHY. The signals are mentioned here for
1453 informative purposes only.

1454 All control signals shall remain synchronous to the TxByteClk, or RxByteClk. The control signal clock
1455 frequency shall be equal to or greater than 1/9 of the serial bit rate.

1456 Table 35 lists the additional signals for the PPI on top of the coding sub-layer (EPPI).

1457 **Table 35 Additional Signals for (Functional) PPI**

Symbol	Dir	Categories	Description
TxProMarkerEsc	I	MXAX (SXXX)	Functional handle to insert a Protocol-marker symbol in the serial stream for LPDT. Active HIGH signal
TxProMarkerHS	I	MXXX (SRXX)	Functional handle to insert a Protocol-marker symbol in the serial stream for HS transmission. Active HIGH signal
TxValidHS	I	MXXX (SRXX)	Functional handle for the protocol to hold on providing data to the PHY without ending the HS transmission. In the case of a continued transmission request without Valid data, the PHY coding layer inserts Idle symbols. Active HIGH signal
RxAlignErrorEsc	O	SXAX (MXXA)	Flag to indicate that a Comma code has been observed in the LPDT stream that was not aligned with the assumed word boundary. Active HIGH signal (optional)

Symbol	Dir	Categories	Description
RxAlignErrorHS	O	SXXX (MRXX)	Flag to indicate that a Comma code has been observed during HS reception that was not aligned with the assumed word boundary. Active HIGH signal (optional)
RxBadSymbolEsc	O	SXAX (MXXA)	Flag to indicate that a non-existing symbol was received using LPDT. Active HIGH signal (optional)
RxBadSymbolHS	O	SXXX (MRXX)	Flag to indicate that a non-existing symbol was received in HS mode. Active HIGH signal (optional)
RxEoTErrorEsc	O	SXAX (MXXA)	Flag to indicate that at EoT, after LP transmission, a transition to LP-11 has been detected without being preceded by an EoT-marker symbol. Active HIGH signal (optional)
RxEoTErrorHS	O	SXXX (MRXX)	Flag to indicate that at EoT, after HS transmission, a transition to LP-11 has been detected without being preceded by an EoT-marker symbol. Active HIGH signal (optional)
RxIdleEsc	O	SXAX (MXXA)	Indication flag that Idle patterns are observed at the Lines during LPDT. Active HIGH signal (optional)
RxIdleHS	O	SXXX (MRXX)	Indication flag that Idle patterns are observed at the Lines in HS mode. Active HIGH signal (optional)
RxProMarkerEsc	O	SXAX (MXXA)	Functional flag to know that a Protocol-marker symbol occurred in the serial stream using LPDT. This is communicated to the protocol synchronous with the data, exactly at the position where it occurred. Therefore, the interface either shows a flag plus non-valid data or no-flag with valid data. Active HIGH signal
RxProMarkerHS	O	SXXX (MRXX)	Functional flag to know that a Protocol-marker symbol occurred in the serial stream for HS mode. This is communicated to the protocol synchronous with the ByteClk, exactly at the position where it occurred. Therefore, the interface either shows a flag plus non-valid data or no-flag with valid data. Active HIGH signal

C.6 Complete Code Set

1458 Table 36 contains the complete code set.

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Table 36 Code Set (8b9b Line Coding)

Name	Type	8-bit Data Byte								9-bit Symbol								
		B ₁	B ₂	B ₃	X ₁	X ₂	Q ₁	Q ₂	Q ₃	B ₁	X ₁	Y ₁	Y ₂	B ₂	B ₃	Y ₃	Y ₄	X ₂
D000	Data	0	0	0	0	0	0	0	0	0	0	1	1	0	0	0	1	0
D001	Data	0	0	0	0	0	0	0	1	0	0	1	1	0	0	1	0	0
D002	Data	0	0	0	0	0	0	1	0	0	0	0	1	0	0	0	1	0
D003	Data	0	0	0	0	0	0	1	1	0	0	1	0	0	0	0	1	0

Name	Type	8-bit Data Byte								9-bit Symbol								
		B ₁	B ₂	B ₃	X ₁	X ₂	Q ₁	Q ₂	Q ₃	B ₁	X ₁	Y ₁	Y ₂	B ₂	B ₃	Y ₃	Y ₄	X ₂
D004	Data	0	0	0	0	0	1	0	0	0	0	0	1	0	0	1	0	0
D005	Data	0	0	0	0	0	1	0	1	0	0	1	0	0	0	1	0	0
D006	Data	0	0	0	0	0	1	1	0	0	0	0	1	0	0	1	1	0
D007	Data	0	0	0	0	0	1	1	1	0	0	1	0	0	0	1	1	0
D008	Data	0	0	0	0	1	0	0	0	0	0	1	1	0	0	0	1	1
D009	Data	0	0	0	0	1	0	0	1	0	0	1	1	0	0	1	0	1
D010	Data	0	0	0	0	1	0	1	0	0	0	0	1	0	0	0	1	1
D011	Data	0	0	0	0	1	0	1	1	0	0	1	0	0	0	0	1	1
D012	Data	0	0	0	0	1	1	0	0	0	0	0	1	0	0	1	0	1
D013	Data	0	0	0	0	1	1	0	1	0	0	1	0	0	0	1	0	1
D014	Data	0	0	0	0	1	1	1	0	0	0	0	1	0	0	0	0	1
D015	Data	0	0	0	0	1	1	1	1	0	0	1	0	0	0	0	0	1
D016	Data	0	0	0	1	0	0	0	0	0	1	0	0	0	0	0	1	0
D017	Data	0	0	0	1	0	0	0	1	0	1	0	0	0	0	1	0	0
D018	Data	0	0	0	1	0	0	1	0	0	1	0	1	0	0	0	1	0
D019	Data	0	0	0	1	0	0	1	1	0	1	1	0	0	0	0	1	0
D020	Data	0	0	0	1	0	1	0	0	0	1	0	1	0	0	1	0	0
D021	Data	0	0	0	1	0	1	0	1	0	1	1	0	0	0	1	0	0
D022	Data	0	0	0	1	0	1	1	0	0	1	0	1	0	0	1	1	0
D023	Data	0	0	0	1	0	1	1	1	0	1	1	0	0	0	1	1	0
D024	Data	0	0	0	1	1	0	0	0	0	1	0	0	0	0	0	1	1
D025	Data	0	0	0	1	1	0	0	1	0	1	0	0	0	0	1	0	1
D026	Data	0	0	0	1	1	0	1	0	0	1	0	1	0	0	0	1	1
D027	Data	0	0	0	1	1	0	1	1	0	1	1	0	0	0	0	1	1
D028	Data	0	0	0	1	1	1	0	0	0	1	0	1	0	0	1	0	1
D029	Data	0	0	0	1	1	1	0	1	0	1	1	0	0	0	1	0	1
D030	Data	0	0	0	1	1	1	1	0	0	1	0	1	0	0	0	0	1
D031	Data	0	0	0	1	1	1	1	1	0	1	1	0	0	0	0	0	1
D032	Data	0	0	1	0	0	0	0	0	0	0	1	1	0	1	0	1	0
D033	Data	0	0	1	0	0	0	0	1	0	0	1	1	0	1	1	0	0
D034	Data	0	0	1	0	0	0	1	0	0	0	0	1	0	1	0	1	0
D035	Data	0	0	1	0	0	0	1	1	0	0	1	0	0	1	0	1	0
D036	Data	0	0	1	0	0	1	0	0	0	0	0	1	0	1	1	0	0
D037	Data	0	0	1	0	0	1	0	1	0	0	1	0	0	1	1	0	0
D038	Data	0	0	1	0	0	1	1	0	0	0	0	1	0	1	1	1	0
D039	Data	0	0	1	0	0	1	1	1	0	0	1	0	0	1	1	1	0
D040	Data	0	0	1	0	1	0	0	0	0	0	1	1	0	1	0	1	1
D041	Data	0	0	1	0	1	0	0	1	0	0	1	1	0	1	1	0	1

Name	Type	8-bit Data Byte								9-bit Symbol								
		B ₁	B ₂	B ₃	X ₁	X ₂	Q ₁	Q ₂	Q ₃	B ₁	X ₁	Y ₁	Y ₂	B ₂	B ₃	Y ₃	Y ₄	X ₂
D042	Data	0	0	1	0	1	0	1	0	0	0	0	1	0	1	0	1	1
D043	Data	0	0	1	0	1	0	1	1	0	0	1	0	0	1	0	1	1
D044	Data	0	0	1	0	1	1	0	0	0	0	0	1	0	1	1	0	1
D045	Data	0	0	1	0	1	1	0	1	0	0	1	0	0	1	1	0	1
D046	Data	0	0	1	0	1	1	1	0	0	0	0	1	0	1	0	0	1
D047	Data	0	0	1	0	1	1	1	1	0	0	1	0	0	1	0	0	1
D048	Data	0	0	1	1	0	0	0	0	0	1	0	0	0	1	0	1	0
D049	Data	0	0	1	1	0	0	0	1	0	1	0	0	0	1	1	0	0
D050	Data	0	0	1	1	0	0	1	0	0	1	0	1	0	1	0	1	0
D051	Data	0	0	1	1	0	0	1	1	0	1	1	0	0	1	0	1	0
D052	Data	0	0	1	1	0	1	0	0	0	1	0	1	0	1	1	0	0
D053	Data	0	0	1	1	0	1	0	1	0	1	1	0	0	1	1	0	0
D054	Data	0	0	1	1	0	1	1	0	0	1	0	1	0	1	1	1	0
D055	Data	0	0	1	1	0	1	1	1	0	1	1	0	0	1	1	1	0
D056	Data	0	0	1	1	1	0	0	0	0	1	0	0	0	1	0	1	1
D057	Data	0	0	1	1	1	0	0	1	0	1	0	0	0	1	1	0	1
D058	Data	0	0	1	1	1	0	1	0	0	1	0	1	0	1	0	1	1
D059	Data	0	0	1	1	1	0	1	1	0	1	1	0	0	1	0	1	1
D060	Data	0	0	1	1	1	1	0	0	0	1	0	1	0	1	1	0	1
D061	Data	0	0	1	1	1	1	0	1	0	1	1	0	0	1	1	0	1
D062	Data	0	0	1	1	1	1	1	0	0	1	0	1	0	1	0	0	1
D063	Data	0	0	1	1	1	1	1	1	0	1	1	0	0	1	0	0	1
D064	Data	0	1	0	0	0	0	0	0	0	0	1	1	1	0	0	1	0
D065	Data	0	1	0	0	0	0	0	1	0	0	1	1	1	0	1	0	0
D066	Data	0	1	0	0	0	0	1	0	0	0	0	1	1	0	0	1	0
D067	Data	0	1	0	0	0	0	1	1	0	0	1	0	1	0	0	1	0
D068	Data	0	1	0	0	0	1	0	0	0	0	0	1	1	0	1	0	0
D069	Data	0	1	0	0	0	1	0	1	0	0	1	0	1	0	1	0	0
D070	Data	0	1	0	0	0	1	1	0	0	0	0	1	1	0	1	1	0
D071	Data	0	1	0	0	0	1	1	1	0	0	1	0	1	0	1	1	0
D072	Data	0	1	0	0	1	0	0	0	0	0	1	1	1	0	0	1	1
D073	Data	0	1	0	0	1	0	0	1	0	0	1	1	1	0	1	0	1
D074	Data	0	1	0	0	1	0	1	0	0	0	0	1	1	0	0	1	1
D075	Data	0	1	0	0	1	0	1	1	0	0	1	0	1	0	0	1	1
D076	Data	0	1	0	0	1	1	0	0	0	0	0	1	1	0	1	0	1
D077	Data	0	1	0	0	1	1	0	1	0	0	1	0	1	0	1	0	1
D078	Data	0	1	0	0	1	1	1	0	0	0	0	1	1	0	0	0	1
D079	Data	0	1	0	0	1	1	1	1	0	0	1	0	1	0	0	0	1

Name	Type	8-bit Data Byte							9-bit Symbol									
		B ₁	B ₂	B ₃	X ₁	X ₂	Q ₁	Q ₂	Q ₃	B ₁	X ₁	Y ₁	Y ₂	B ₂	B ₃	Y ₃	Y ₄	X ₂
D080	Data	0	1	0	1	0	0	0	0	0	1	0	0	1	0	0	1	0
D081	Data	0	1	0	1	0	0	0	1	0	1	0	0	1	0	1	0	0
D082	Data	0	1	0	1	0	0	1	0	0	1	0	1	1	0	0	1	0
D083	Data	0	1	0	1	0	0	1	1	0	1	1	0	1	0	0	1	0
D084	Data	0	1	0	1	0	1	0	0	0	1	0	1	1	0	1	0	0
D085	Data	0	1	0	1	0	1	0	1	0	1	1	0	1	0	1	0	0
D086	Data	0	1	0	1	0	1	1	0	0	1	0	1	1	0	1	1	0
D087	Data	0	1	0	1	0	1	1	1	0	1	1	0	1	0	1	1	0
D088	Data	0	1	0	1	1	0	0	0	0	1	0	0	1	0	0	1	1
D089	Data	0	1	0	1	1	0	0	1	0	1	0	0	1	0	1	0	1
D090	Data	0	1	0	1	1	0	1	0	0	1	0	1	1	0	0	1	1
D091	Data	0	1	0	1	1	0	1	1	0	1	1	0	1	0	0	1	1
D092	Data	0	1	0	1	1	1	0	0	0	1	0	1	1	0	1	0	1
D093	Data	0	1	0	1	1	1	0	1	0	1	1	0	1	0	1	0	1
D094	Data	0	1	0	1	1	1	1	0	0	1	0	1	1	0	0	0	1
D095	Data	0	1	0	1	1	1	1	1	0	1	1	0	1	0	0	0	1
D096	Data	0	1	1	0	0	0	0	0	0	0	1	1	1	1	0	1	0
D097	Data	0	1	1	0	0	0	0	1	0	0	1	1	1	1	1	0	0
D098	Data	0	1	1	0	0	0	1	0	0	0	0	1	1	1	0	1	0
D099	Data	0	1	1	0	0	0	1	1	0	0	1	0	1	1	0	1	0
D100	Data	0	1	1	0	0	1	0	0	0	0	0	1	1	1	1	0	0
D101	Data	0	1	1	0	0	1	0	1	0	0	1	0	1	1	1	0	0
D102	Data	0	1	1	0	0	1	1	0	0	0	0	1	1	1	1	1	0
D103	Data	0	1	1	0	0	1	1	1	0	0	1	0	1	1	1	1	0
D104	Data	0	1	1	0	1	0	0	0	0	0	1	1	1	1	0	1	1
D105	Data	0	1	1	0	1	0	0	1	0	0	1	1	1	1	1	0	1
D106	Data	0	1	1	0	1	0	1	0	0	0	0	1	1	1	0	1	1
D107	Data	0	1	1	0	1	0	1	1	0	0	1	0	1	1	0	1	1
D108	Data	0	1	1	0	1	1	0	0	0	0	0	1	1	1	1	0	1
D109	Data	0	1	1	0	1	1	0	1	0	0	1	0	1	1	1	0	1
D110	Data	0	1	1	0	1	1	1	0	0	0	0	1	1	1	0	0	1
D111	Data	0	1	1	0	1	1	1	1	0	0	1	0	1	1	0	0	1
D112	Data	0	1	1	1	0	0	0	0	0	1	0	0	1	1	0	1	0
D113	Data	0	1	1	1	0	0	0	1	0	1	0	0	1	1	1	0	0
D114	Data	0	1	1	1	0	0	1	0	0	1	0	1	1	1	0	1	0
D115	Data	0	1	1	1	0	0	1	1	0	1	1	0	1	1	0	1	0
D116	Data	0	1	1	1	0	1	0	0	0	1	0	1	1	1	1	0	0
D117	Data	0	1	1	1	0	1	0	1	0	1	1	0	1	1	1	0	0

Name	Type	8-bit Data Byte								9-bit Symbol								
		B ₁	B ₂	B ₃	X ₁	X ₂	Q ₁	Q ₂	Q ₃	B ₁	X ₁	Y ₁	Y ₂	B ₂	B ₃	Y ₃	Y ₄	X ₂
D118	Data	0	1	1	1	0	1	1	0	0	1	0	1	1	1	1	1	0
D119	Data	0	1	1	1	0	1	1	1	0	1	1	0	1	1	1	1	0
D120	Data	0	1	1	1	1	0	0	0	0	1	0	0	1	1	0	1	1
D121	Data	0	1	1	1	1	0	0	1	0	1	0	0	1	1	1	0	1
D122	Data	0	1	1	1	1	0	1	0	0	1	0	1	1	1	0	1	1
D123	Data	0	1	1	1	1	0	1	1	0	1	1	0	1	1	0	1	1
D124	Data	0	1	1	1	1	1	0	0	0	1	0	1	1	1	1	0	1
D125	Data	0	1	1	1	1	1	0	1	0	1	1	0	1	1	1	0	1
D126	Data	0	1	1	1	1	1	1	0	0	1	0	1	1	1	0	0	1
D127	Data	0	1	1	1	1	1	1	1	0	1	1	0	1	1	0	0	1
D128	Data	1	0	0	0	0	0	0	0	1	0	1	1	0	0	0	1	0
D129	Data	1	0	0	0	0	0	0	1	1	0	1	1	0	0	1	0	0
D130	Data	1	0	0	0	0	0	1	0	1	0	0	1	0	0	0	1	0
D131	Data	1	0	0	0	0	0	1	1	1	0	1	0	0	0	0	1	0
D132	Data	1	0	0	0	0	1	0	0	1	0	0	1	0	0	1	0	0
D133	Data	1	0	0	0	0	1	0	1	1	0	1	0	0	0	1	0	0
D134	Data	1	0	0	0	0	1	1	0	1	0	0	1	0	0	1	1	0
D135	Data	1	0	0	0	0	1	1	1	1	0	1	0	0	0	1	1	0
D136	Data	1	0	0	0	1	0	0	0	1	0	1	1	0	0	0	1	1
D137	Data	1	0	0	0	1	0	0	1	1	0	1	1	0	0	1	0	1
D138	Data	1	0	0	0	1	0	1	0	1	0	0	1	0	0	0	1	1
D139	Data	1	0	0	0	1	0	1	1	1	0	1	0	0	0	0	1	1
D140	Data	1	0	0	0	1	1	0	0	1	0	0	1	0	0	1	0	1
D141	Data	1	0	0	0	1	1	0	1	1	0	1	0	0	0	1	0	1
D142	Data	1	0	0	0	1	1	1	0	1	0	0	1	0	0	0	0	1
D143	Data	1	0	0	0	1	1	1	1	1	0	1	0	0	0	0	0	1
D144	Data	1	0	0	1	0	0	0	0	1	1	0	0	0	0	0	1	0
D145	Data	1	0	0	1	0	0	0	1	1	1	0	0	0	0	1	0	0
D146	Data	1	0	0	1	0	0	1	0	1	1	0	1	0	0	0	1	0
D147	Data	1	0	0	1	0	0	1	1	1	1	0	0	0	0	0	1	0
D148	Data	1	0	0	1	0	1	0	0	1	1	0	1	0	0	1	0	0
D149	Data	1	0	0	1	0	1	0	1	1	1	1	0	0	0	1	0	0
D150	Data	1	0	0	1	0	1	1	0	1	1	0	1	0	0	1	1	0
D151	Data	1	0	0	1	0	1	1	1	1	1	1	0	0	0	1	1	0
D152	Data	1	0	0	1	1	0	0	0	1	1	0	0	0	0	0	1	1
D153	Data	1	0	0	1	1	0	0	1	1	1	0	0	0	0	1	0	1
D154	Data	1	0	0	1	1	0	1	0	1	1	0	1	0	0	0	1	1
D155	Data	1	0	0	1	1	0	1	1	1	1	1	0	0	0	0	1	1

Name	Type	8-bit Data Byte								9-bit Symbol								
		B ₁	B ₂	B ₃	X ₁	X ₂	Q ₁	Q ₂	Q ₃	B ₁	X ₁	Y ₁	Y ₂	B ₂	B ₃	Y ₃	Y ₄	X ₂
D156	Data	1	0	0	1	1	1	0	0	1	1	0	1	0	0	1	0	1
D157	Data	1	0	0	1	1	1	0	1	1	1	1	0	0	0	1	0	1
D158	Data	1	0	0	1	1	1	1	0	1	1	0	1	0	0	0	0	1
D159	Data	1	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	1
D160	Data	1	0	1	0	0	0	0	0	1	0	1	1	0	1	0	1	0
D161	Data	1	0	1	0	0	0	0	1	1	0	1	1	0	1	1	0	0
D162	Data	1	0	1	0	0	0	1	0	1	0	0	1	0	1	0	1	0
D163	Data	1	0	1	0	0	0	1	1	1	0	1	0	0	1	0	1	0
D164	Data	1	0	1	0	0	1	0	0	1	0	0	1	0	1	1	0	0
D165	Data	1	0	1	0	0	1	0	1	1	0	1	0	0	1	1	0	0
D166	Data	1	0	1	0	0	1	1	0	1	0	0	1	0	1	1	1	0
D167	Data	1	0	1	0	0	1	1	1	1	0	1	0	0	1	1	1	0
D168	Data	1	0	1	0	1	0	0	0	1	0	1	1	0	1	0	1	1
D169	Data	1	0	1	0	1	0	0	1	1	0	1	1	0	1	1	0	1
D170	Data	1	0	1	0	1	0	1	0	1	0	0	1	0	1	0	1	1
D171	Data	1	0	1	0	1	0	1	1	1	0	1	0	0	1	0	1	1
D172	Data	1	0	1	0	1	1	0	0	1	0	0	1	0	1	1	0	1
D173	Data	1	0	1	0	1	1	0	1	1	0	1	0	0	1	1	0	1
D174	Data	1	0	1	0	1	1	1	0	1	0	0	1	0	1	0	0	1
D175	Data	1	0	1	0	1	1	1	1	1	0	1	0	0	1	0	0	1
D176	Data	1	0	1	1	0	0	0	0	1	1	0	0	0	1	0	1	0
D177	Data	1	0	1	1	0	0	0	1	1	1	0	0	0	1	1	0	0
D178	Data	1	0	1	1	0	0	1	0	1	1	0	1	0	1	0	1	0
D179	Data	1	0	1	1	0	0	1	1	1	1	1	0	0	1	0	1	0
D180	Data	1	0	1	1	0	1	0	0	1	1	0	1	0	1	1	0	0
D181	Data	1	0	1	1	0	1	0	1	1	1	1	0	0	1	1	0	0
D182	Data	1	0	1	1	0	1	1	0	1	1	0	1	0	1	1	1	0
D183	Data	1	0	1	1	0	1	1	1	1	1	1	0	0	1	1	1	0
D184	Data	1	0	1	1	1	0	0	0	1	1	0	0	0	1	0	1	1
D185	Data	1	0	1	1	1	0	0	1	1	1	0	0	0	1	1	0	1
D186	Data	1	0	1	1	1	0	1	0	1	1	0	1	0	1	0	1	1
D187	Data	1	0	1	1	1	0	1	1	1	1	1	0	0	1	0	1	1
D188	Data	1	0	1	1	1	1	0	0	1	1	0	1	0	1	1	0	1
D189	Data	1	0	1	1	1	1	0	1	1	1	1	0	0	1	1	0	1
D190	Data	1	0	1	1	1	1	1	0	1	1	0	1	0	1	0	0	1
D191	Data	1	0	1	1	1	1	1	1	1	1	1	0	0	1	0	0	1
D192	Data	1	1	0	0	0	0	0	0	1	0	1	1	1	0	0	1	0
D193	Data	1	1	0	0	0	0	0	1	1	0	1	1	1	0	1	0	0

Name	Type	8-bit Data Byte								9-bit Symbol								
		B ₁	B ₂	B ₃	X ₁	X ₂	Q ₁	Q ₂	Q ₃	B ₁	X ₁	Y ₁	Y ₂	B ₂	B ₃	Y ₃	Y ₄	X ₂
D194	Data	1	1	0	0	0	0	1	0	1	0	0	1	1	0	0	1	0
D195	Data	1	1	0	0	0	0	1	1	1	0	1	0	1	0	0	1	0
D196	Data	1	1	0	0	0	1	0	0	1	0	0	1	1	0	1	0	0
D197	Data	1	1	0	0	0	1	0	1	1	0	1	0	1	0	1	0	0
D198	Data	1	1	0	0	0	1	1	0	1	0	0	1	1	0	1	1	0
D199	Data	1	1	0	0	0	1	1	1	1	0	1	0	1	0	1	1	0
D200	Data	1	1	0	0	1	0	0	0	1	0	1	1	1	0	0	1	1
D201	Data	1	1	0	0	1	0	0	1	1	0	1	1	1	0	1	0	1
D202	Data	1	1	0	0	1	0	1	0	1	0	0	1	1	0	0	1	1
D203	Data	1	1	0	0	1	0	1	1	1	0	1	0	1	0	0	1	1
D204	Data	1	1	0	0	1	1	0	0	1	0	0	1	1	0	1	0	1
D205	Data	1	1	0	0	1	1	0	1	1	0	1	0	1	0	1	0	1
D206	Data	1	1	0	0	1	1	1	0	1	0	0	1	1	0	0	0	1
D207	Data	1	1	0	0	1	1	1	1	1	0	1	0	1	0	0	0	1
D208	Data	1	1	0	1	0	0	0	0	1	1	0	0	1	0	0	1	0
D209	Data	1	1	0	1	0	0	0	1	1	1	0	0	1	0	1	0	0
D210	Data	1	1	0	1	0	0	1	0	1	1	0	1	1	0	0	1	0
D211	Data	1	1	0	1	0	0	1	1	1	1	1	0	1	0	0	1	0
D212	Data	1	1	0	1	0	1	0	0	1	1	0	1	1	0	1	0	0
D213	Data	1	1	0	1	0	1	0	1	1	1	1	0	1	0	1	0	0
D214	Data	1	1	0	1	0	1	1	0	1	1	0	1	1	0	1	1	0
D215	Data	1	1	0	1	0	1	1	1	1	1	1	0	1	0	1	1	0
D216	Data	1	1	0	1	1	0	0	0	1	1	0	0	1	0	0	1	1
D217	Data	1	1	0	1	1	0	0	1	1	1	0	0	1	0	1	0	1
D218	Data	1	1	0	1	1	0	1	0	1	1	0	1	1	0	0	1	1
D219	Data	1	1	0	1	1	0	1	1	1	1	1	0	1	0	0	1	1
D220	Data	1	1	0	1	1	1	0	0	1	1	0	1	1	0	1	0	1
D221	Data	1	1	0	1	1	1	0	1	1	1	1	0	1	0	1	0	1
D222	Data	1	1	0	1	1	1	1	0	1	1	0	1	1	0	0	0	1
D223	Data	1	1	0	1	1	1	1	1	1	1	1	0	1	0	0	0	1
D224	Data	1	1	1	0	0	0	0	0	1	0	1	1	1	1	0	1	0
D225	Data	1	1	1	0	0	0	0	1	1	0	1	1	1	1	1	0	0
D226	Data	1	1	1	0	0	0	1	0	1	0	0	1	1	1	0	1	0
D227	Data	1	1	1	0	0	0	1	1	1	0	1	0	1	1	0	1	0
D228	Data	1	1	1	0	0	1	0	0	1	0	0	1	1	1	1	0	0
D229	Data	1	1	1	0	0	1	0	1	1	0	1	0	1	1	1	0	0
D230	Data	1	1	1	0	0	1	1	0	1	0	0	1	1	1	1	1	0
D231	Data	1	1	1	0	0	1	1	1	1	0	1	0	1	1	1	1	0

Name	Type	8-bit Data Byte								9-bit Symbol								
		B ₁	B ₂	B ₃	X ₁	X ₂	Q ₁	Q ₂	Q ₃	B ₁	X ₁	Y ₁	Y ₂	B ₂	B ₃	Y ₃	Y ₄	X ₂
D232	Data	1	1	1	0	1	0	0	0	1	0	1	1	1	1	0	1	1
D233	Data	1	1	1	0	1	0	0	1	1	0	1	1	1	1	1	0	1
D234	Data	1	1	1	0	1	0	1	0	1	0	0	1	1	1	0	1	1
D235	Data	1	1	1	0	1	0	1	1	1	0	1	0	1	1	0	1	1
D236	Data	1	1	1	0	1	1	0	0	1	0	0	1	1	1	1	0	1
D237	Data	1	1	1	0	1	1	0	1	1	0	1	0	1	1	1	0	1
D238	Data	1	1	1	0	1	1	1	0	1	0	0	1	1	1	0	0	1
D239	Data	1	1	1	0	1	1	1	1	1	0	1	0	1	1	0	0	1
D240	Data	1	1	1	1	0	0	0	0	1	1	0	0	1	1	0	1	0
D241	Data	1	1	1	1	0	0	0	1	1	1	0	0	1	1	1	0	0
D242	Data	1	1	1	1	0	0	1	0	1	1	0	1	1	1	0	1	0
D243	Data	1	1	1	1	0	0	1	1	1	1	1	0	1	1	0	1	0
D244	Data	1	1	1	1	0	1	0	0	1	1	0	1	1	1	1	0	0
D245	Data	1	1	1	1	0	1	0	1	1	1	1	0	1	1	1	0	0
D246	Data	1	1	1	1	0	1	1	0	1	1	0	1	1	1	1	1	0
D247	Data	1	1	1	1	0	1	1	1	1	1	1	0	1	1	1	1	0
D248	Data	1	1	1	1	1	0	0	0	1	1	0	0	1	1	0	1	1
D249	Data	1	1	1	1	1	0	0	1	1	1	0	0	1	1	1	0	1
D250	Data	1	1	1	1	1	0	1	0	1	1	0	1	1	1	0	1	1
D251	Data	1	1	1	1	1	0	1	1	1	1	1	0	1	1	0	1	1
D252	Data	1	1	1	1	1	1	0	0	1	1	0	1	1	1	1	0	1
D253	Data	1	1	1	1	1	1	0	1	1	1	1	0	1	1	1	0	1
D254	Data	1	1	1	1	1	1	1	0	1	1	0	1	1	1	0	0	1
D255	Data	1	1	1	1	1	1	1	1	1	1	1	0	1	1	0	0	1
C400	Rsvd	Does not represent data								0	1	0	0	0	0	1	1	0
C401	Rsvd	Does not represent data								0	1	0	0	0	1	1	1	0
C402	Rsvd	Does not represent data								0	1	0	0	1	0	1	1	0
C403	Rsvd	Does not represent data								0	1	0	0	1	1	1	1	0
C404	Rsvd	Does not represent data								1	1	0	0	0	0	1	1	0
C405	Rsvd	Does not represent data								1	1	0	0	0	1	1	1	0
C406	Rsvd	Does not represent data								1	1	0	0	1	0	1	1	0
C407	Rsvd	Does not represent data								1	1	0	0	1	1	1	1	0
C410	Rsvd	Does not represent data								0	0	1	1	0	0	0	0	1
C411	Rsvd	Does not represent data								0	0	1	1	0	1	0	0	1
C412	Rsvd	Does not represent data								0	0	1	1	1	0	0	0	1
C413	Rsvd	Does not represent data								0	0	1	1	1	1	0	0	1
C414	Rsvd	Does not represent data								1	0	1	1	0	0	0	0	1
C415	Rsvd	Does not represent data								1	0	1	1	0	1	0	0	1

Name	Type	8-bit Data Byte							9-bit Symbol								
		B ₁	B ₂	B ₃	X ₁	X ₂	Q ₁	Q ₂	Q ₃	B ₁	X ₁	Y ₁	Y ₂	B ₂	B ₃	Y ₃	Y ₄
C416	Rsvd	Does not represent data							1	0	1	1	1	0	0	0	1
C417	Rsvd	Does not represent data							1	0	1	1	1	1	0	0	1
C600	Protocol	Does not represent data							0	1	1	1	1	1	1	0	0
C611	EoT	Does not represent data							1	0	0	0	0	0	0	1	1
C601	Idle/Sync1	Does not represent data							0	1	1	1	1	1	1	0	1
C610	Idle/Sync2	Does not represent data							1	0	0	0	0	0	0	1	0
C701	Reserved	Does not represent data							1	0	0	0	0	0	0	0	1
C710	Rsvd	Does not represent data							0	1	1	1	1	1	1	1	0

Note:

Rsvd = Reserved